

封面格式

行政院及所屬各機關出國報告
(出國類別：考察)

寬頻無線通訊系統發展五年計劃國外公差報告

服務機關：國防部中山科學研究院
出國人職稱：簡聘技正、薦聘技士、

姓名：李清源、李適貴

出國地區：日本
出國期間：910731~910809
報告日期：911031

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co9>01671

CSIPW-91E-H0011

國外公差報告

報 告 資 料 頁			
1. 報告編號： CSIPW-91E-H0011	2. 出國類別： 考察	3. 完成日期： 91年10月31日	4. 總頁數： 17頁(不含附頁資料)
<p>5. 報告名稱：</p> <p>『寬頻無線通訊系統發展五年計劃』國外公差報告</p>			
6. 核准文號	人令文號	九一銓鑑字第〇〇四一八八號國防部令	
	部令文號		
7. 經 費	新台幣：新台幣貳拾肆萬貳仟伍佰零肆元整		
8. 出(返)國日期	自 91 年 07 月 31 日至 91 年 08 月 09 日		
9. 公 差 地 點	日本		
10. 公 差 機 構	ANRITSU 公司、TOSHIBA 公司、TDK 公司、KEISO 公司、UHT 公司、KYOCERA 公司、Panasonic 公司、		
11. 附 記			

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系統識別號：C09201671

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行政院及所屬各機關出國報告提要

出國報告名稱：寬頻無線通訊系統發展五年計劃國外公差報告

頁數__ 含附件：是 否

出國計畫主辦機關/聯絡人/電話

出國人員姓名/服務機關/單位/職稱/電話

國防部中山科學研究院電子系統所元件組，簡聘技正李清源、

薦聘技士李適貴

電話號碼:03-4712201 轉 355638

出國類別：1 考察 2 進修 3 研究 4 實習 5 其他

出國期間：910731~910809 出國地區：日本、

報告日期： 911031

分類號/目

關鍵詞：寬頻無線通訊系統、微波放大器、LTCC

內容摘要：

為執行經濟部委託之科專「寬頻無線通訊系統發展五年計劃」，解決寬頻分碼擷取(W-CDMA)通訊系統微波射頻收發模組次系統整合及關鍵微波組件如基地台、用戶台無線通訊製程縮裝整合技術、構裝、可靠度及易測性等技術問題。

由於本單位負責分項為寬頻無線通訊系統中之微波射頻收發模組次系統，整個任務包括基地臺台及用戶端所有射頻收發系統之開發、及量產技術先期研究。整個計劃對本組而言為一包含策略、技術、管理及資源整合之重要任務。為期有效吸取他人豐富經驗以為我方避險求勝，派員赴日本參訪 ANRITSU、TOSHIBA、TDK、KEISO、UHT、KYOCERA、Panasonic 等七家公司，研討微波放大器單晶元件設計、構裝，基地台及用戶台微波射頻收發模組自動測試技術並蒐集寬頻分碼擷取(W-CDMA) 通訊系統相關之技術資料、瞭解市場現況及 3GPP 技術發展趨勢。期能使研發試產順遂，達成經濟部科專案任務。

本文電子檔已上傳至出國報告資訊網 (<http://report.gsn.gov.tw>)

壹、出國目的及緣由

為執行經濟部委託之科專「寬頻無線通訊系統發展五年計劃」，解決寬頻分碼擷取(W-CDMA)通訊系統微波射頻收發模組次系統整合及關鍵微波組件如基地台、用戶台無線通訊製程縮裝整合技術、構裝、可靠度及易測性等技術問題。

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貳、公差心得

(1) 參訪 Anritsu Company 專業量測儀器公司微波儀器部門之目的，在於該公司與 Agilent 同質性極高，藉實地參訪之機會期能進一步瞭解並評估其產品技術能量，尋覓一同等技術能量之儀器製造公司，為寬頻無線通訊微波系統生產量測自動化開闢另一管道，期能透過市場機制降低研發、生產成本。該公司在改組前原為 Wiltron Instrument Inc. 專長為微波量測儀器製造，在國內透過代理商銷售，十多年前本單位對其產品性能及服務品質頗有微詞，後來該公司與日本專業光通訊傳播系統公司 ANRITSU 合併，加強產品行銷及技術服務工作，來台建立分公司並加強各項業務推展。由於該公司重返我國市場，對吾等來訪極為重視，安排本單位與各項專題相關工程技術部門負責人員進行研討。該公司看準近年來無線通訊市場蓬勃發展，向我方介紹展示最新之 W-CDMA BS Test System 量測系統，該系統能精準的量測出 W-CDMA 解調後的資料正確性，對本組執行此科專計畫有很大的幫助。此外，該公司也展示 110GHz Broadband VNA，該系統能量到 110GHz，on-wafer 的測量方法對本組在建立元件模型將會有所幫助。

(2) 參訪日本 TOSHIBA 公司，該公司具有完整的 CDMA 產品，也很早就投入 W-CDMA 技術的研發，對於整個系統的整合是很有經驗的，這次參訪該公司與其

研討有關通訊系統整合相關技術問題，特別是有關鎖相迴路(PLL)的問題，該公司也向我方展示一顆針對 W-CDMA 所生產的關鎖相迴路模組，相信經過這次與該公司研討時經驗的交流，本組無線通訊系統整合的能量會有所提升。

(3) 參訪日本 TDK 公司，該公司為專業微波系統與零組件製造公司，赴該公司觀摩其先進微波混成線路製程技術、微波系統構裝技術並討論無線通訊被動元件發展趨勢及因應開發之製程技術，該公司所研發的技術與本單位極為類似，若能與其技術交流，有具先進電子特性研究及微波領域應用及設計能量加以協助，配合目前我國產業環境及在世界科技產業分工地位，應可創造新的契機，確立我國為先進高頻無線製造中心之地位。

(4) 參訪日本 KEISO 公司，討論有關儀器氣體偵測器的相關問題，該公司有研發一套無線傳輸資料，氣體偵測器所發生的任何問題都會馬上回傳。本組有許多的儀器必須用到氣體，故氣體流量控制相當重要，此外，有關氣體洩漏的偵測關係到工作同仁的安全，該公司對此有很專精的研究，所以與此公司討論有關儀器氣體偵測器之規格。

(5) 參訪日本 UHT 公司，討論 LTCC 製程相關問題並討論先前跟該公司所購買的儀器後續維修及升級問題。LTCC 可用於高頻元件的封裝以及微波系統的整

合，它具有損耗低、價格低、體積小…等優點，尤其適合高頻封裝及系統整合，因高頻時接腳的寄生電容、電感對微波元件特性的影響很大。此外，LTCC 可以向上整合，所以體積可有效縮小。這次與該公司討論 LTCC 製程上的相關問題，可幫助本組縮短建立該項能量的時程。

(6) 參訪日本 KYOCERA 公司，該公司所生產的手機在日本有很高的市場佔有率，在系統整合尤其是基頻方面有很多的經驗，此行討論在系統整合時基頻所遭遇到的問題。另外，該公司也發展出 LTCC 高頻封裝技術，並投入研發 LTCC 相關技術及其在系統整合的可行性，此一目標與本組相同，若能與其合作對本組提升 LTCC 相關技術有很大的幫助。

(7) 參訪日本 Panasonic 公司，該公司很早就著手開發第三代通訊訊系統 W-CDMA 功率元件，該公司在放大器設計之研究開發有相當成效及能量，其研發方向、產品內容與本組極為接近，本組採自行開發微波積體電路晶片組(RFIC Chip set)方式，並選用適合功率元件且高良率之異質介面二極電晶體(HBT)製程，有鑑於傳統 GaAs MESFET (砷化鎵金屬氧化物場效電晶體)製程穩定性問題，該公司亦採用新開發之異質二極電晶體(HBT)製程。因高功率放大器需要三大技術：(1) 功率晶體、(2)元件模型及(3)設計組裝能力，在這三者中本組皆較 Panasonic 落後，故本組若要發展放大器，宜借重外來經驗輔助：運用本組新建

立之負載牽引量測系統(Load Pull System)直接取得設計資料，再培養組裝、測試能量，行有餘力再漸漸培養對晶體與元件模型的理解，如此才能使本組以最短時間達到市場技術水準。該公司具有成熟晶片微波積體電路設計能力，主要目標為自行開發寬頻 CDMA 升頻、降頻轉換器模組。其產品應用範圍含蓋有線、無線通訊及光電通訊領域；目前通訊產品定位於 CDMA 無線通訊功率元件。再者，該公司也開發第三代通訊訊系統 WCDMA 功率元件，以因應寬頻無線通訊系統規格需求，此一目標正與本計劃不謀而和，可做為本單位未來發展之借鏡，以提升本單位系統整合之技術能量。

參、效益分析

隨著 W-CDMA 的最終規範即將完成，具有語音和數據功能的無線上網手機也將面世，但要使這類產品真正實現商用化，還有許多的問題等待解決。藉由與各大廠專家進行面對面特定議題研討、資訊交流及實際觀摩其公司在解決寬頻無線通訊微波系統各項元件、次系統問題採取之方法，幫助本單位提升解決寬頻分碼擷取(W-CDMA)微波收發系統研發時排除障礙之能力；透過實驗室及生產線參觀考察，有助於本單位製程能力及量測技術之提升。正有助於解決本單位目前所遭遇到之技術瓶頸。除此之外蒐集最新通訊規範發展動態、市場狀況及最新材料、設計及製程技術資料，可奠定相關技術知識，作為往後科技專案建案之目標方向及執行計畫之重要參考。

此行目的係為尋找國外資源，解決寬頻無線通訊系統發展及無線關鍵零組件如微波放大器單晶元件設計、構裝，基地台及用戶台微波射頻收發模組自動測試技術。另外也收集 LTCC 用於無線通訊縮裝及高頻元件封裝相關資料，藉由面對面討論、交流深入問題核心，避免受困於技術瓶頸而時程延誤，同時也激發我們對於解決問題的新的思考模式。參觀了各廠商的研發、生產及量測設備和技術，其中有不少地方值得參考、學習改進。在整個參訪過程，我們也發現我們本身的優缺點。如能參酌他們的經驗，運用其可提供的資源，對解決計畫執行的確大有幫助。各參訪公司的技術、經營導向也值得本組參考用以確立未來發展方向與經營模式。

肆、國外工作日程表 填表人：李道貴

項 次	時 間	地 點	交往接觸人士及機關(外文名及譯名)				洽談內容記要	備 考
			姓 名	國 籍	性 別	地 址		
1.	910731	ANRITSU	Jacky Tseng	中華民國	男	5-10-27, Minamiazabu, Minato-ku, Tokyo, 106-8570 Japan	參訪公司，研討寬頻分碼擷取微波系統設計整合，規範設計製造及微波精密測試技術等議題。	
2.	910801	TOSHIBA	Makoto Furukawa	日本	男	1-1 shibaaura 1 chome Minato-ku, Tokyo, 105-01 Japan	觀摩先進微波電路製程與設計技術，研討無線通訊製程縮裝整合與微波精密測試技術。	
3	910802	TDK	Tang Jianfeng	日本	男	13-1 Nihonbashi 1-chome, Chuo ku, Tokyo 103-8272, Japan	觀摩其先進微波混成線路製程技術、微波系統構裝技術並討論無線通訊被動元件發展趨勢及因應開發之製程技術。	
4.	910805	KEISO	Kanji Furukawa	日本	男	Shiba Toho Bidg, 1-7-24, shibako en Minato-ku, Tokyo, Japan 105-8558	討論本組儀器所需之氣體流量控制器、氣體偵測器等相關規格。	
5	910806	UHT	Chew Siou Teck ANG Kian Sen	日本	男	470-0162 446-268 Shimokagamida, Haruki, Togo-T, aicki-gun, aichi, Japan	討論本組所購LTCC製程相關儀器後續的服務問題並研討LTCC相關製程技術。	

6	910807	Kyocera	Yasuhiro Satake	日本	男	1-2-28	Tamatsukuri, Chuo-ku Osaka 540-8585, Japan	討論在系統整合時基頻所遭遇到的問題。另外，該公司也發展出LTCC高頻封裝技術，並投入研發LTCC相關技術及其在系統整合的可行性。
7	910808	Panasonic	ANG Kian Sen	日本	男	1-30	Shiba-Daimon 1-chome, Minato-ku Tokyo 105-8586 Japan	研討放大器設計之研究並討論開發寬頻 CDMA 升頻、降頻轉換器模組相關問題。
說明 1. 填寫內容力求詳實，生活中一般瑣碎事務請勿填寫。2. 回國後一個月內送交計畫處彙辦。								

伍、社交活動

由於工作日程短暫，行程安排密集並未從其他事社交活動。只有在假日時搭日本地鐵到東京附近走走，所到之處市容整潔乾淨，城市景觀優美，交通便利，地鐵四通八達，顯見其都市計劃之完善。日本人民生活方式、環境建築與飲食文化都和臺灣相當接近，所以雖身處異鄉卻不感到隻身在外的感覺。

陸、建議事項

一、各公司在無線通訊系統的縮裝開始採用 LTCC 的技術，可以把一些被動元件整合在一起，具有低損耗、體積小、花費小的好處。另外，對於高頻元件封裝的解決方案也有越來越多的公司採用 LTCC 的技術，故建議本組加強建立 LTCC 生產技術之能量（含微波連接介面、微小化包裝、高密度線路、新材料運用及組裝技術等），使本組從設計、研發、生產、組裝技術提升以提供各式先進微波線路需求。

二、與各公司資深工程師討論收穫豐富，建議本單位可經常舉辦專題討論，請單位內資深或績優工程師與同仁分享工作心得及技術經驗，提升組內人員技術水準。亦可邀院外相關研究機構、學校或公司舉辦技術研討，除可相互切磋外亦藉以增進對相關產業技術能力的瞭解。

柒、附件

附件:ANRITSU

UE Test Standard

Conformance Test System

The following four systems make the Conformance Test System possible

TRX Test System

TS 34.121 clause 5 Measurement of a Transmit Performance

TS 34.121 clause 6 Measurement of a Receive Performance

Performance Test System

TS 34.121 clause 7 Performance under Fading Condition

RRM Test System

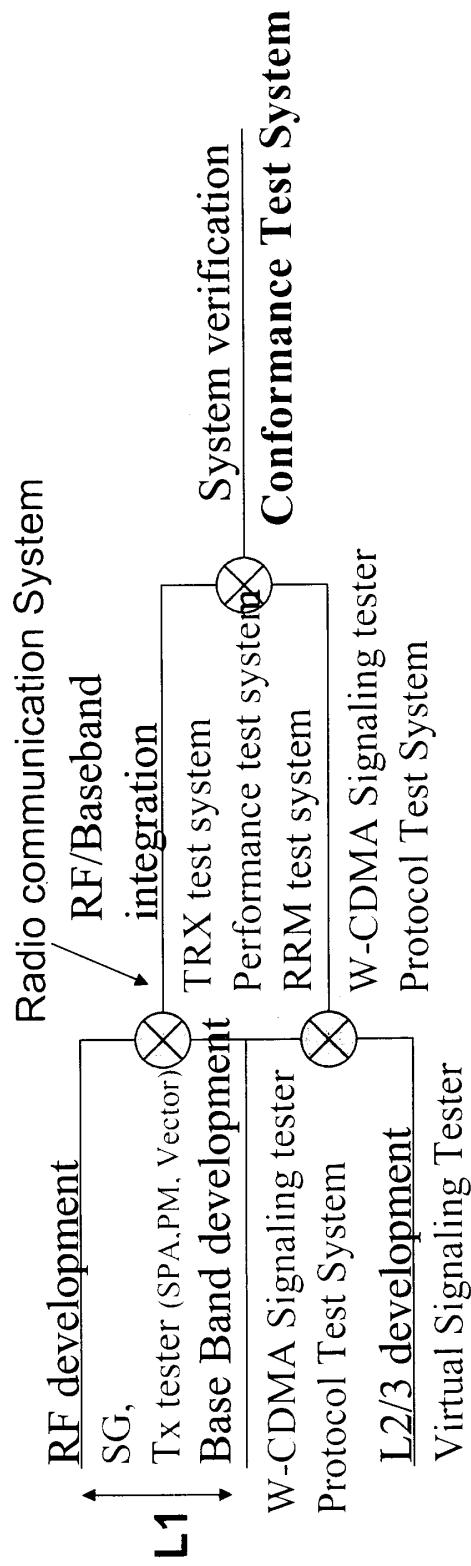
TS 34.121 clause 8 The Test of RRM Function

Protocol Test System

TS 34.123 The Test of Protocol Function

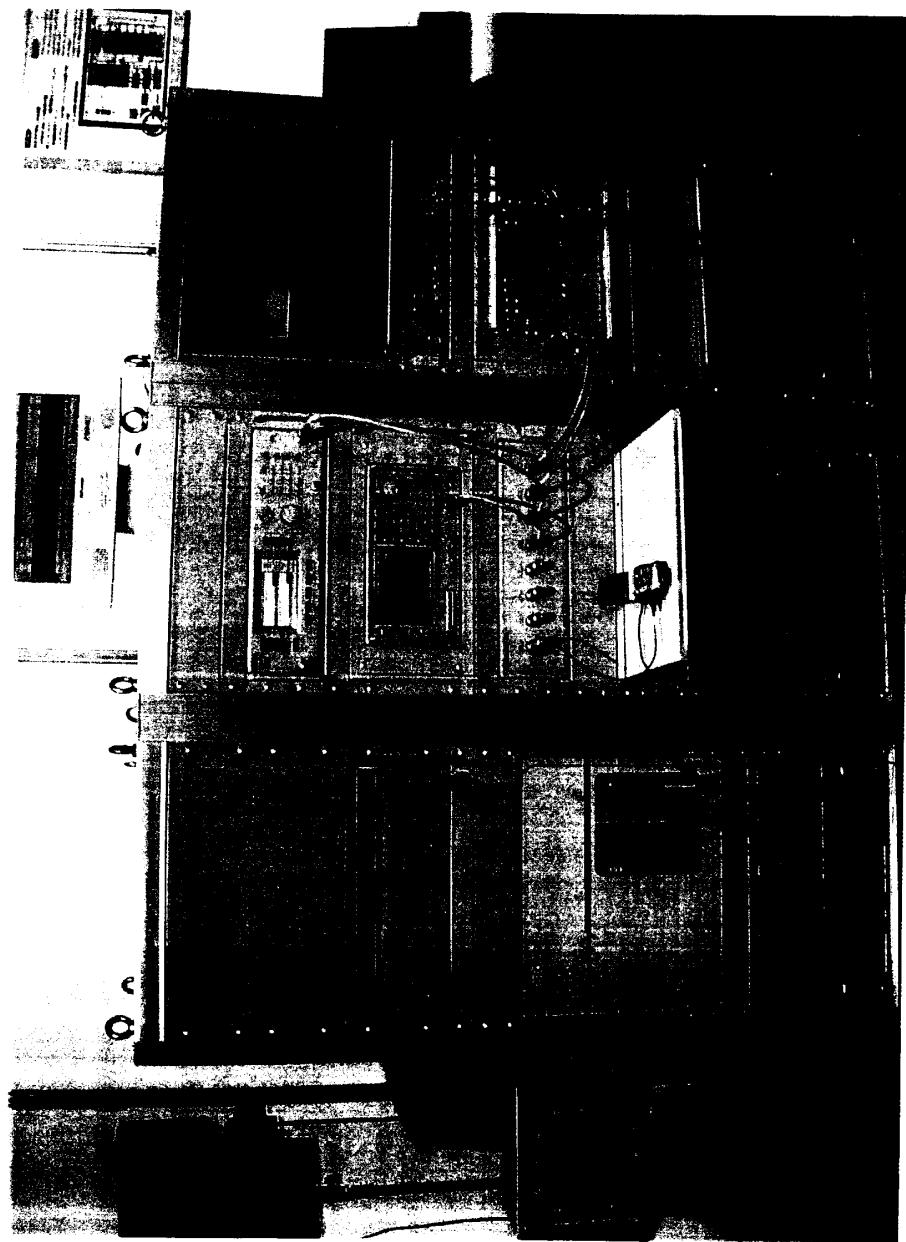
UE Development Cycle

- Support parallel development streams to speed time to market



Common building blocks allow systems to be re-used and upgraded

TRX/Performance Test System



3GPP コンフォーマンス試験対応システム

3GPP conformance test support system

W-CDMA TRX//I/Wormant System ME7873A

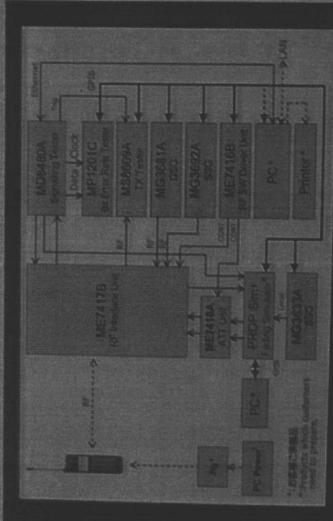
W-CDMA TRX/Performance Test System ME7873A

3GPP TS34.121 5.5GHz, 6.5GHz, 7.8GHz、7.9GHz/ワームアンテナ試験装置でテスト可能。

The best system which can perform auto measurement for 3GPP TS34.121 Chap.5 Transmitter Characteristics, Chap.6 Receiver Characteristics and Chap.7 Performance Requirements.

Features

- Completely conforming to 3GPP standards
- Auto testing is available conforming to world standard
- Supporting UE test with Call processing and External control
- Test with Call processing or test with external control is also available
- Supporting total protocol sequence test
- Originator / terminator test is available with Signaling Tester



BS Test Standard

Conformance Test System

The following four systems make the Conformance Test System possible

TX Test System

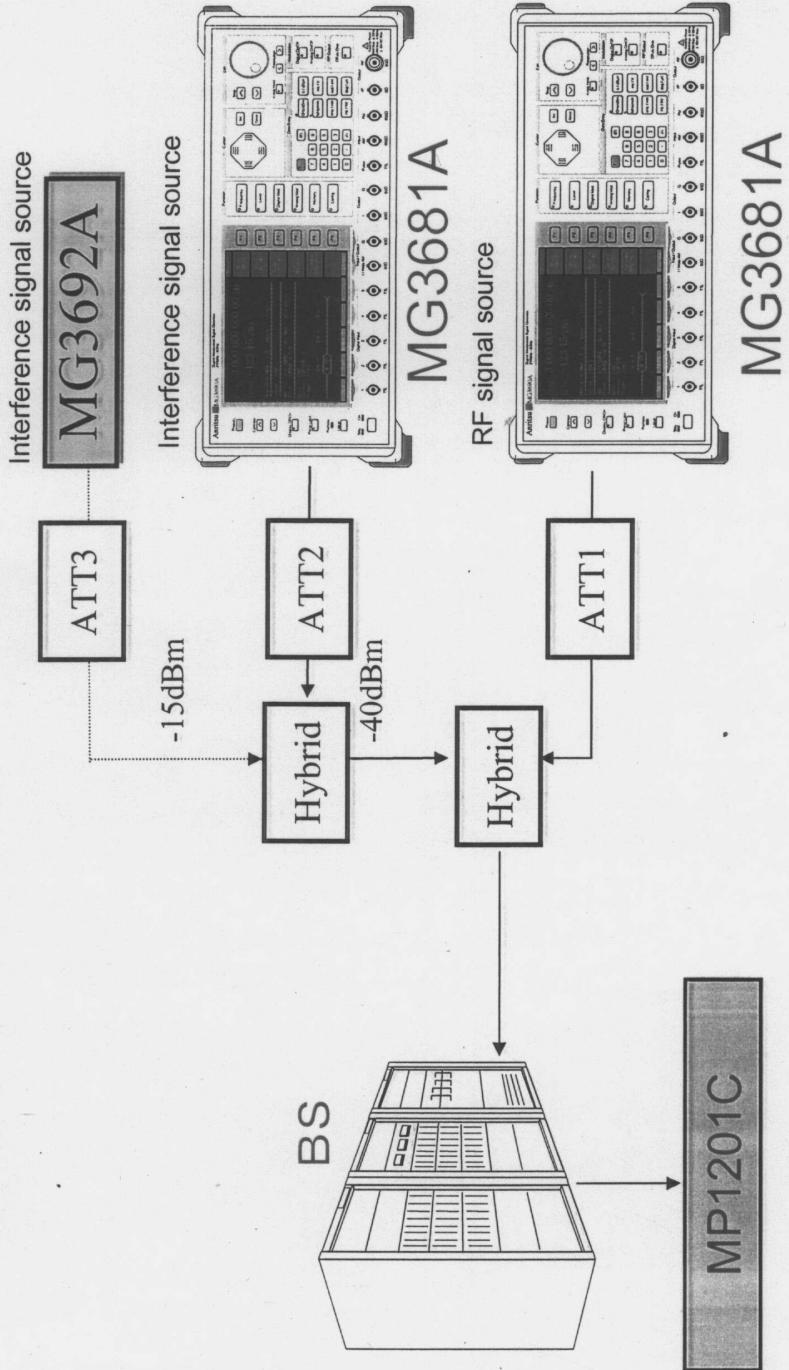
- TS 25.141 clause 6 Measurement of a Transmit Performance**
- TS 25.141 clause 7 Measurement of a Receive Performance**

Performance Test System

- TS 25.141 clause 8 Performance under Fading Condition**

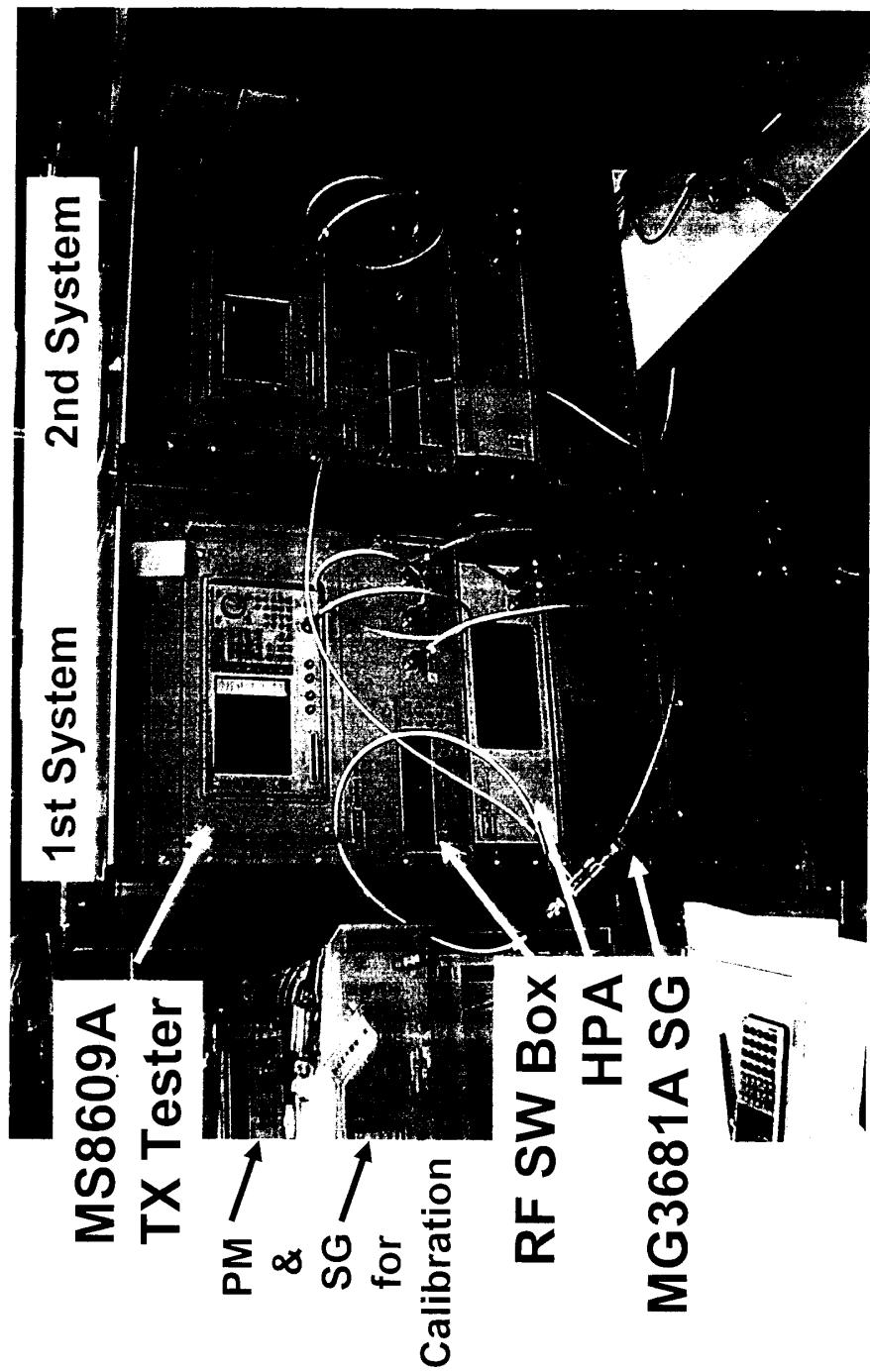
BS Conformance Test System

7.6 Intermodulation characteristics



W-CDMA BS Test System

(also a part of UE Test System for Type Approval)



110GHz Broadband VNA



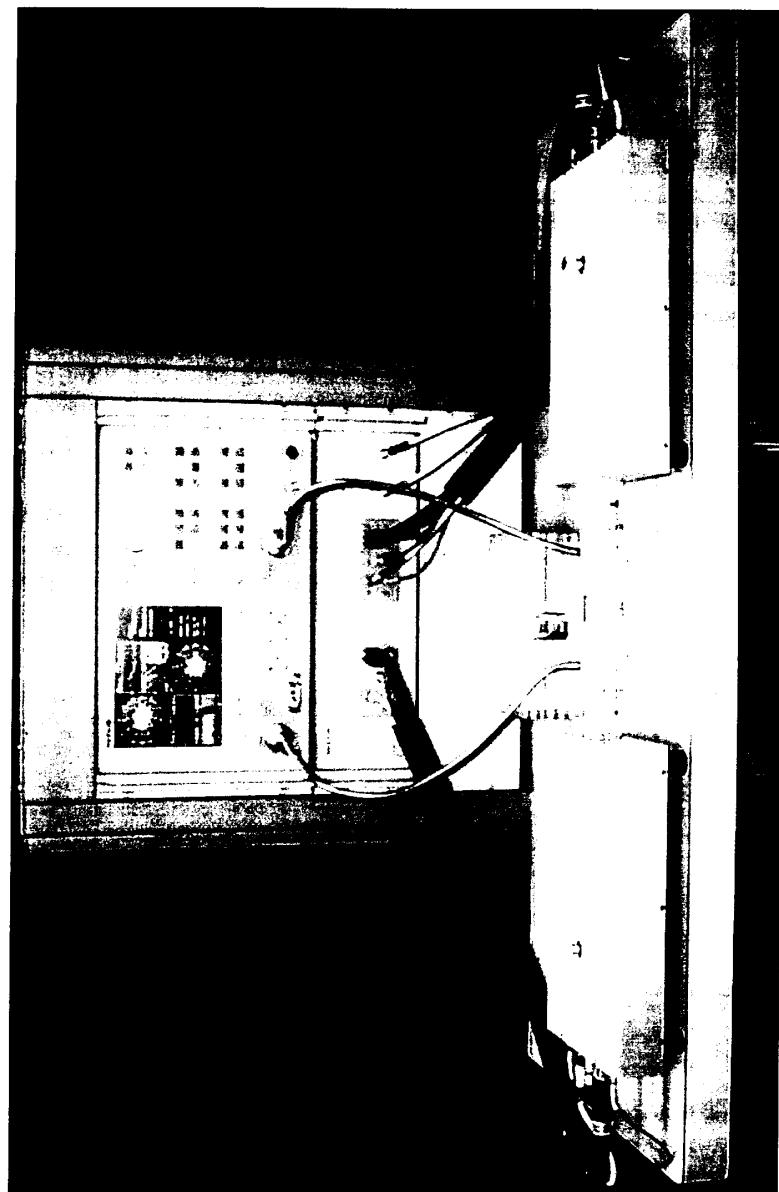
Broadband VNA

- Continuous sweep from 40 MHz to 110 GHz
- Integrated rack system with coaxial (1 mm) test ports
 - 65 GHz VNA
 - Two 65-110 GHz transmission/reflection modules for complete 4 S parameters test.
 - Broadband test set
- Two multiplexing couplers: V(f) and WR10 in, W1(f) out
- Two CW synthesized sources
- Device characterization and modeling
- Upgrade from any VNA to 110GHz VNA

Key Features

- Test set flexibility - run coax or waveguide band independently
- Upgrade path from 65 GHz VNA
- Small size of mmW modules simplifies integration with on-wafer probe system
- Fast broadband frequency sweep
- High dynamic range
- Enhanced serviceability
- Cost effective measurement solution

110GHz VNA (W1 Coax)



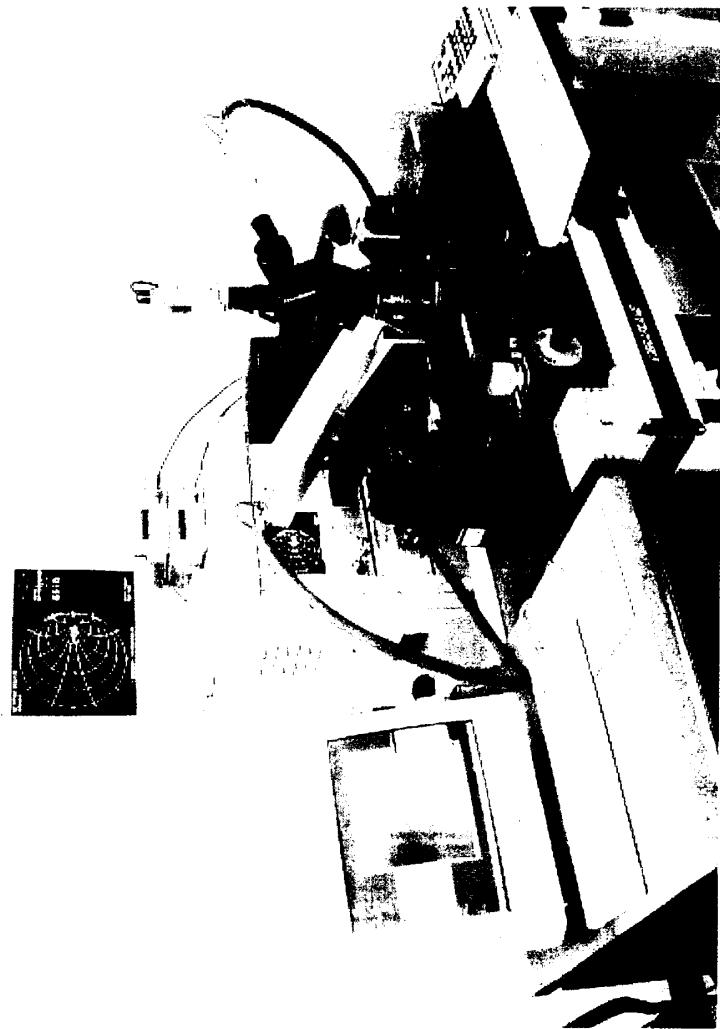
Complete On-Wafer Test Solution

- Anritsu “Panorama 110GHz” Broadband VNA
- Karl Suss Probe System and Software
 - PM5 HF manual or PA200 HF semi-automatic system
 - PH250 HF probeheads
 - Suss ProberBench® operating system
 - SussCal® automatic calibration software
- GGB Picoprobe® Probes and Calibration Substrates
 - 110H microwave probes (GSG, GS, or SG)*
 - CS-5 or CS-8 calibration substrates
- Parameter Extraction and Device Modeling Software
 - Compatible with Agilent EEsof IC-CAP (release 5.3)

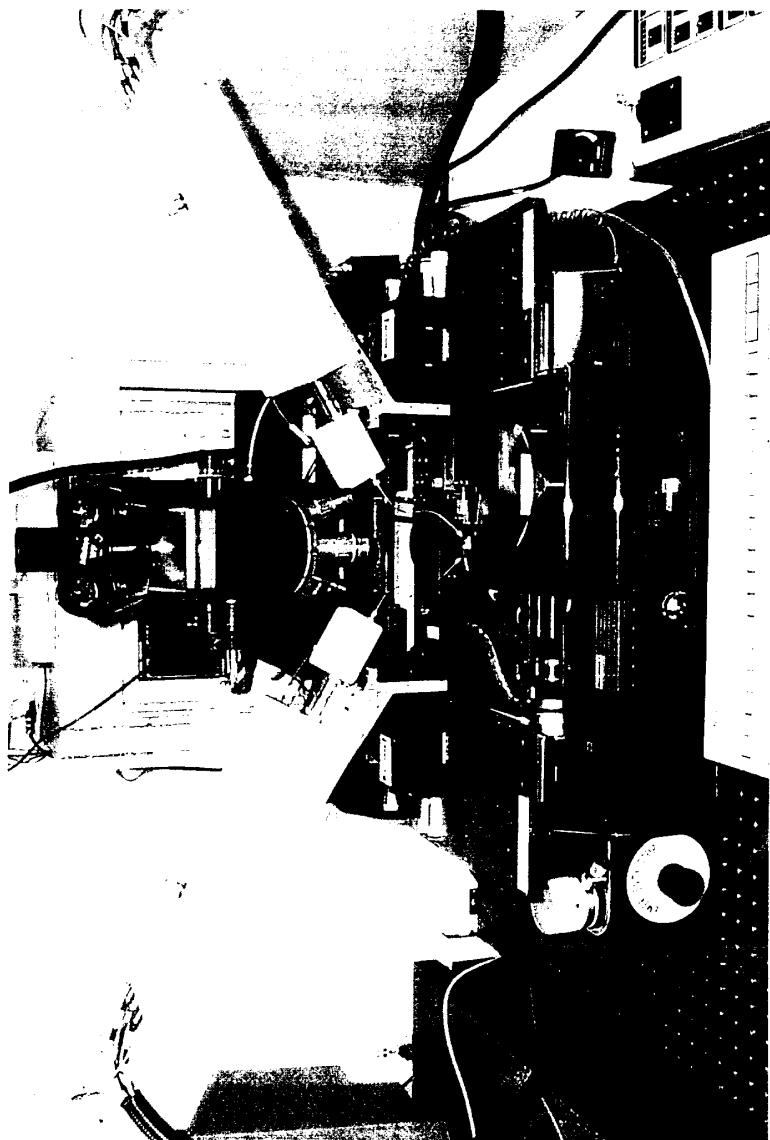


* ground-signal-ground

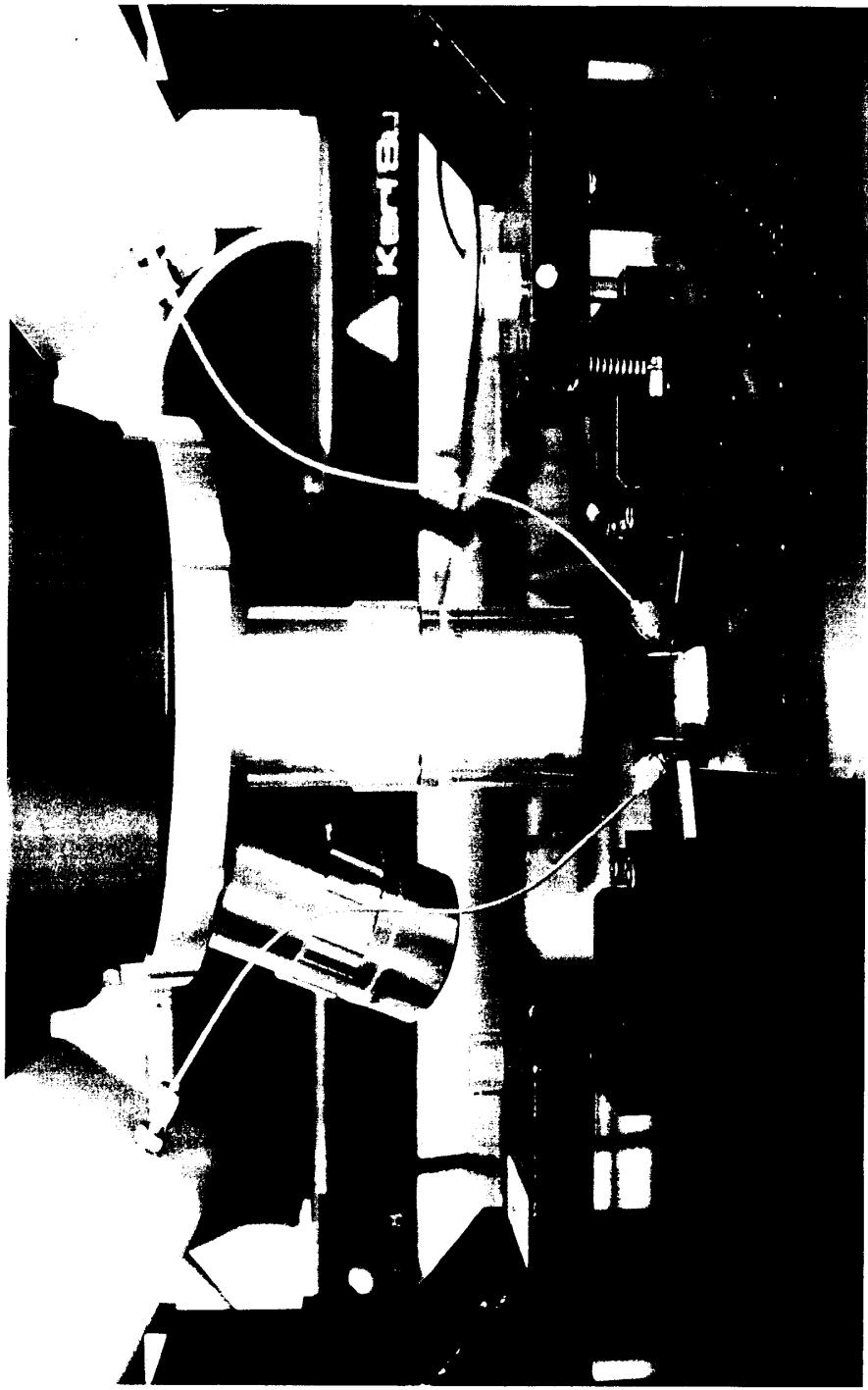
110GHz VNA (On-Wafer)



110GHz VNA (On-Wafer)



110GHz VNA (On-Wafer)



Dynamic Range

	0.04	2	20	40	50	<65	>65	75	85	100	110
Max Signal into Port 2 (dBm)	30	30	30	30	30	30	16	14	13	12	12
Port 1 Power, Typical (dBm)	-1	3	-7	-14	-10	-12	-14	-10	-11	-9	-11
Noise Floor (dBm)	-76	-103	-92	-88	-79	-67	-65	-78	-81	-78	-73
System Dynamic Range (dB)	75	106	85	74	69	55	51	68	70	69	62
Receiver Dynamic Range (dB)	106	133	122	118	109	97	81	92	94	90	85

	0.04	2	20	40	50	<65	>65	75	85	100	110
Max Signal into Port 2 (dBm)	30	30	30	30	30	30	18	17	16	16	16
Port 1 Power, Typical (dBm)	-1	3	-8	-16	-12	-14	-16	-13	-14	-13	-15
Noise Floor (dBm)	-76	-103	-91	-86	-77	-65	-63	-75	-78	-74	-69
System Dynamic Range (dB)	75	106	83	70	65	51	47	62	64	61	54
Receiver Dynamic Range (dB)	106	133	121	116	107	95	81	92	94	90	85

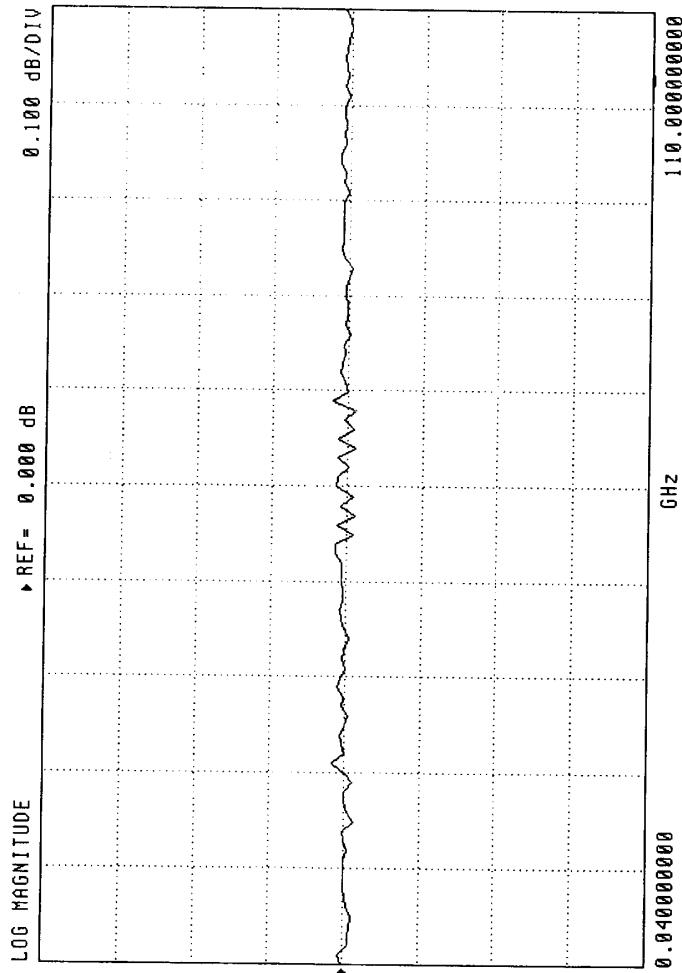
Dynamic Range

Frequency (GHz)	0.04	2	20	40	50	65
Max Signal into Port 2 (dBm)	30	30	30	30	30	30
Port 1 Power, Typical (dBm)	0	5	-2	-7	-2	-2
Noise Floor (dBm)	-77	-105	-97	-95	-87	-77
System Dynamic Range (dB)	77	110	95	86	85	75
Receiver Dynamic Range (dB)	107	135	127	125	117	107

Frequency (GHz)	65	75	85	100	110
Max Signal into Port 2 (dBm)	8	8	8	8	8
Port 1 Power, Typical (dBm)	-6	-4	-6	-5	-7
Noise Floor (dBm)	-73	-84	-86	-82	-77
System Dynamic Range (dB)	67	80	80	77	70
Receiver Dynamic Range (dB)	81	92	94	90	85

Thru Line (On-Wafer)

S21 FORWARD TRANSMISSION



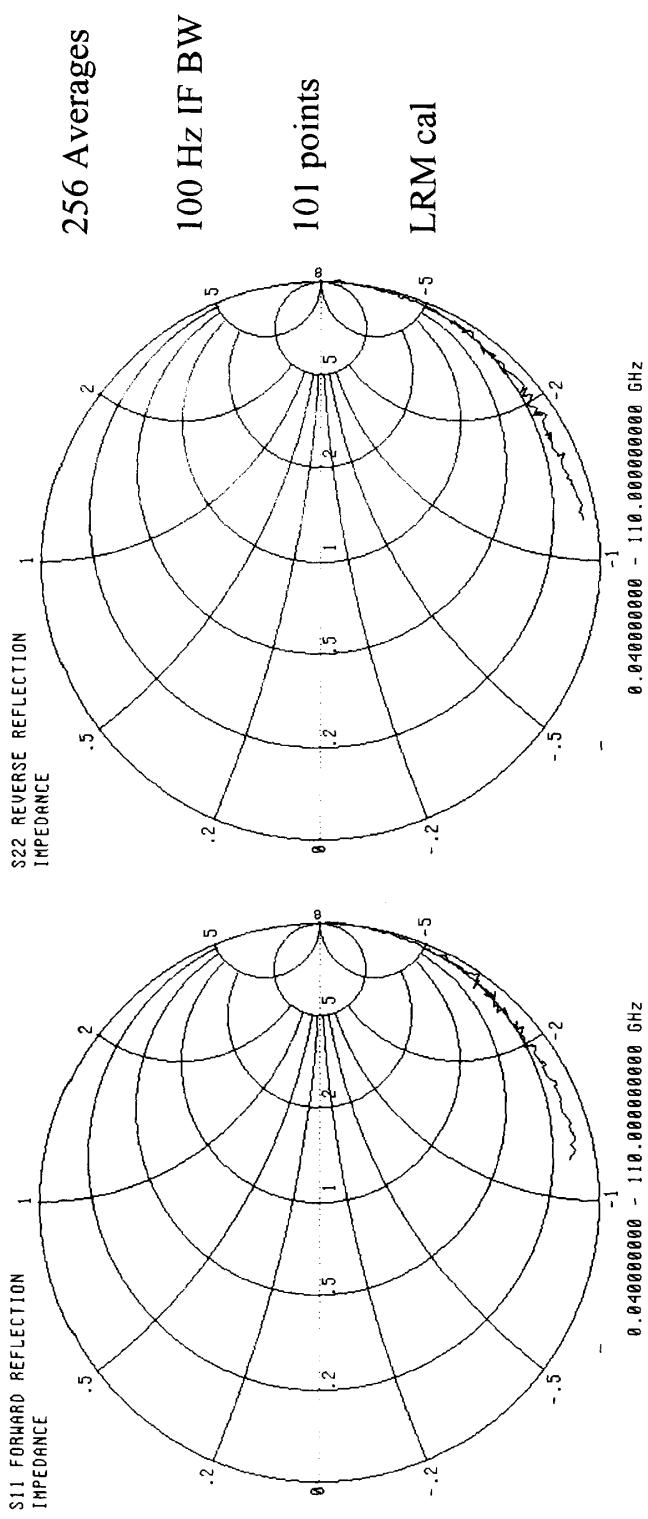
256 Averages

100 Hz IF BW

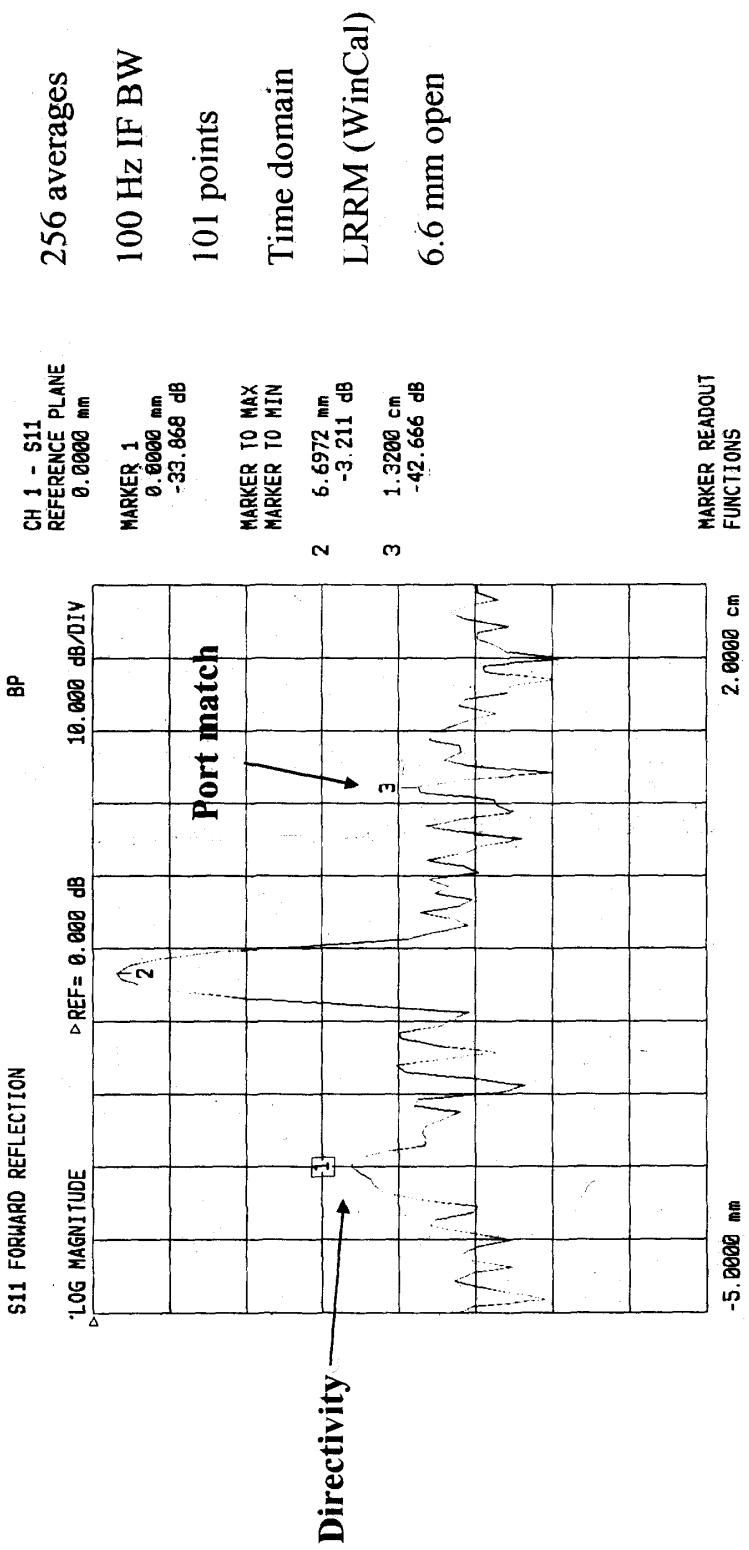
101 points

SOLT cal

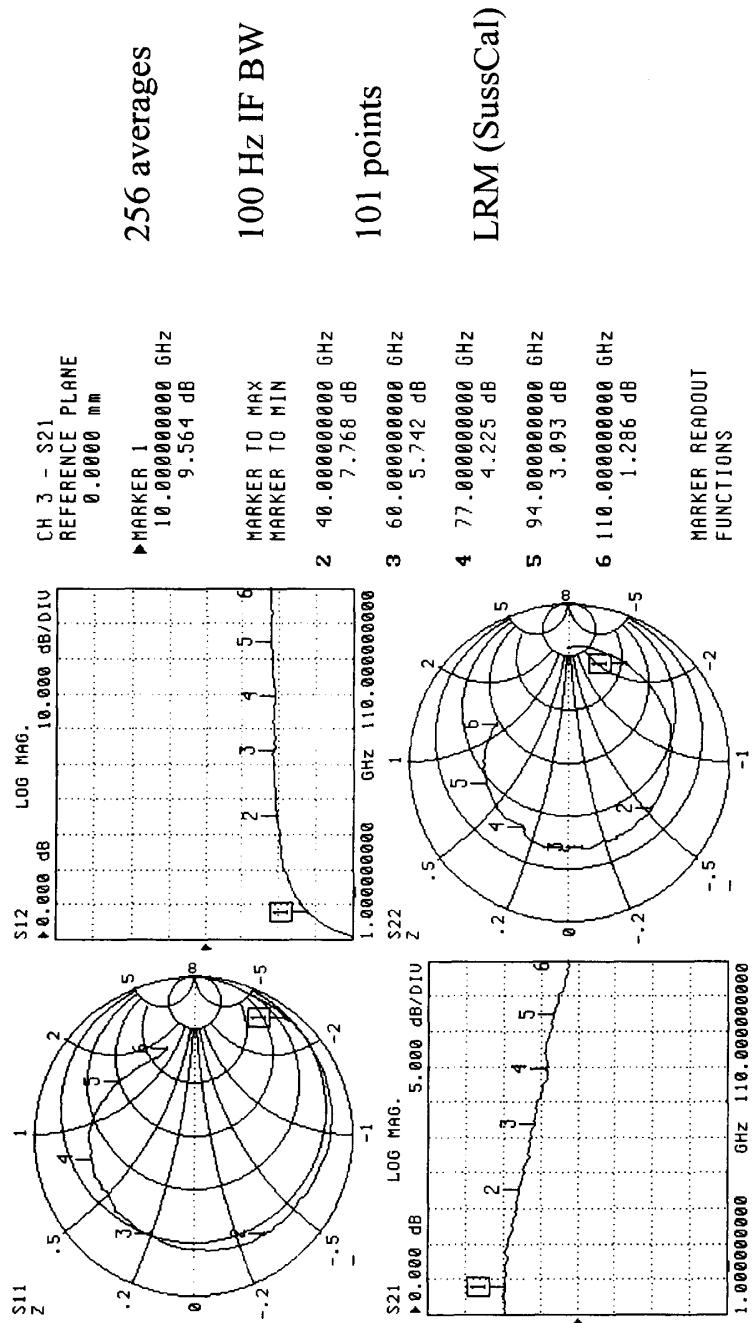
Extended Open (On-Wafer, 200 μm)



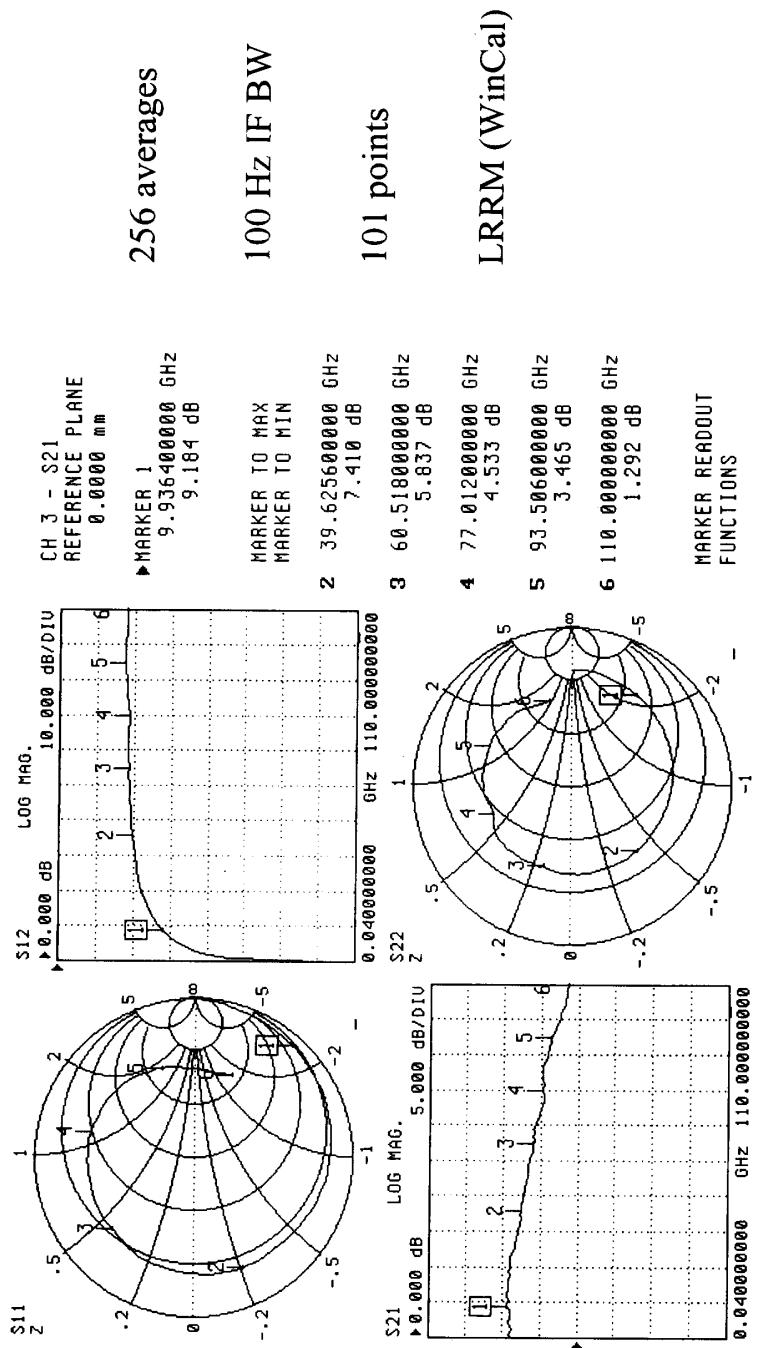
Directivity and Port Match (On-Wafer)



FET (On-Wafer)



FET (On-Wafer)

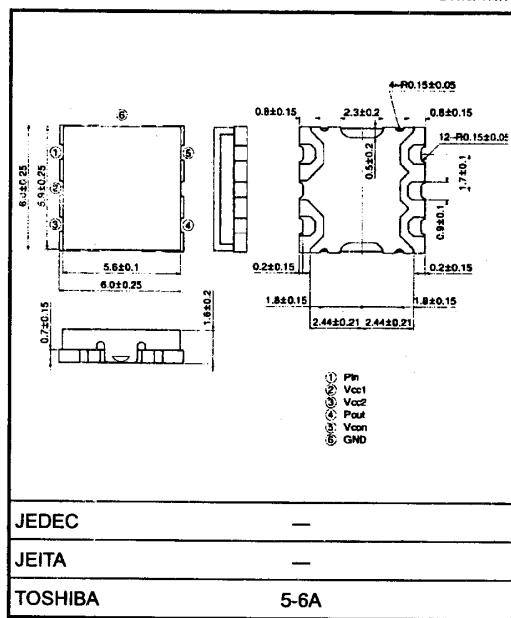


附件: TOSHIBA

RF Power Amplifier Module

S-AU81Power Amplifier Modules for Domestic
cdmaOne

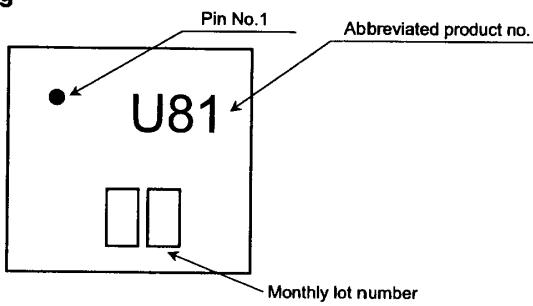
- GaAs HBT Micro PA (on-chip bias circuit and matching circuit)
- Output power: $P_o = 27.0\text{dBmW}$ (min)
- Gain: $G_p = 28.0\text{dB}$ (typ.)
- Total current: I_t (1) = 385 mA (typ.)
(@ $P_{out} = 27.0\text{dBmW}$)
- Low-voltage operation: Operation at $V_{CC} = 1.5\text{V}$ is possible
 I_t (2) = 97 mA (typ.) (@ $P_{out} = 14\text{dBmW}$, $V_{CC} = 1.5\text{V}$)
- This device features an output control pin which can be switched between low-power and high-power settings.
 $I_t = 90\text{mA}$ (typ.) (@ $P_{out} = 14\text{dBmW}$, $V_{CC} = 2.70\text{V}$)



Weight: 0.0 g (typ.)

Maximum Ratings ($T_a = 25^\circ\text{C}$)

Characteristics	Symbol	Rating	Unit
Supply voltage 1	V_{CC1}	5	V
Supply voltage 2	V_{CC2}	5	V
Control voltage	V_{con}	4	V
Collector current	I_{CC}	1	A
Power dissipation	P_D (Note 1)	2	W
Operating temperature	T_{op}	-20~+60	°C
Storage temperature range	T_{stg}	-30~+125	°C

Note 1: $T_a = 25^\circ\text{C}$ **Marking**

Electrical Characteristics ($T_c = 25^\circ\text{C}$)

Characteristics	Symbol	Test Condition		Min	Typ.	Max	Unit
Power gain (1)	G_p (1)	$V_{CC1}, V_{CC2} = 3.6 \text{ V}$, $V_{con} = 2.85 \text{ V}$ (Note 2), $P_o = 27 \text{ dBmW}$ $f = 887\text{--}925 \text{ MHz}$, $P_{in} = \text{adjust}$, $Z_G = Z_L = 50 \Omega$	25.0	28.0	—	dB	
Control current	I_{con}		—	3	5	—	mA
Total current (1)	I_t (1)		—	385	—	—	mA
Adjacent-channel power ratio (1)	ACPR1 (1)	$V_{CC1}, V_{CC2} = 3.6 \text{ V}$, $V_{con} = 2.85 \text{ V}$ (Note 2), $P_o = 27 \text{ dBmW}$, $f = 887\text{--}925 \text{ MHz}$, $Z_G = Z_L = 50 \Omega$ (Note 3)	900 kHz	—	-50	-45	dB
	ACPR2 (2)	1.98 MHz	—	-60	-56	dB	
Power gain (2)	G_p (2)	$V_{CC1}, V_{CC2} = 1.5 \text{ V}$, $V_{con} = 2.85 \text{ V}$ (Note 2), $P_o = 14 \text{ dBmW}$, $f = 887\text{--}925 \text{ MHz}$, $P_{in} = \text{adjust}$, $Z_G = Z_L = 50 \Omega$	21.0	24.0	—	dB	
Total current (2)	I_t (2)		—	97	—	—	mA
Adjacent-channel power ratio (2)	ACPR1 (2)	$V_{CC1}, V_{CC2} = 1.5 \text{ V}$, $V_{con} = 2.85 \text{ V}$ (Note 2), $P_o = 14 \text{ dBmW}$, $f = 887\text{--}925 \text{ MHz}$, $Z_G = Z_L = 50 \Omega$ (Note 3)	900 kHz	—	-50	-45	dB
	ACPR2 (2)	1.98 MHz	—	-60	-56	dB	
Power gain (3)	G_p (3)	$V_{CC1}, V_{CC2} = 3.6 \text{ V}$, $V_{con} = 2.85 \text{ V}$ (Note 2), $P_o = 27 \text{ dBmW}$, $f = 887\text{--}925 \text{ MHz}$, $P_{in} = \text{adjust}$, $Z_G = Z_L = 50 \Omega$ (Note 3), $T_c = -20\text{--}+60^\circ\text{C}$	24.0	27.0	—	—	dB
Adjacent-channel power ratio (3)	ACPR1 (3)	$V_{CC1}, V_{CC2} = 3.6 \text{ V}$, $V_{con} = 2.85 \text{ V}$ (Note 2), $P_o = 27 \text{ dBmW}$, $f = 887\text{--}925 \text{ MHz}$, $Z_G = Z_L = 50 \Omega$, $T_c = -20\text{--}+60^\circ\text{C}$ (Note 3)	900 kHz	—	-48	-43	dB
	ACPR2 (3)	1.98 MHz	—	-58	-55	dB	
VSWRin	VSWRin	$V_{CC1}, V_{CC2} = 3.6 \text{ V}$, $V_{con} = 2.85 \text{ V}$ (Note 3), $P_o = 27 \text{ dBmW}$, $f = 887\text{--}925 \text{ MHz}$, $P_{in} = \text{adjust}$, $Z_G = Z_L = 50 \Omega$	—	2	3	—	
Harmonics	2fo	HRM (1)	—	—	-30	dB	
	3fo	HRM (2)	—	—	-45	dB	
Stability	SPR	$V_{CC1}, V_{CC2} = 1.5 \text{ V}$, 2.5 V , 3.6 V , 4.2 V , $V_{con} = 2.85 \text{ V}$ (Note 3), $P_o \leq 27 \text{ dBmW}$, $f = 887\text{--}925 \text{ MHz}$, $P_{in} = \text{adjust}$, $Z_G = 50 \Omega$, VSWR LOAD = 3:1 all phase	—	—	-60	dB	
Receiving band noise	NRB	$V_{CC1}, V_{CC2} = 3.6 \text{ V}$, $V_{con} = 2.85 \text{ V}$ (Note 2), $P_o \leq 27 \text{ dBmW}$, $f = 887\text{--}925 \text{ MHz}$, $P_{in} = \text{adjust}$, $Z_G = Z_L = 50 \Omega$	—	-135	—	dBmW/ Hz	
Load mismatch	—	$V_{CC1}, V_{CC2} = 1.5 \text{ V}$ ~ 4.2 V , $V_{con} = 2.85 \text{ V}$ (Note 2), $P_o \leq 27 \text{ dBmW}$, $f = 887\text{--}925 \text{ MHz}$, $P_{in} = \text{adjust}$, $Z_G = 50 \Omega$, VSWR LOAD = 3:1 all phase	No degradation			—	

Caution: This RF power amplifier is the electrostatic sensitive device. Please handle with caution.

Note 2: $V_{con} = 2.85 \text{ V}$ is set to obtain $I_{idle} \approx 75 \text{ mA}$ when $V_{CC1}, V_{CC2} = 3.6 \text{ V}$

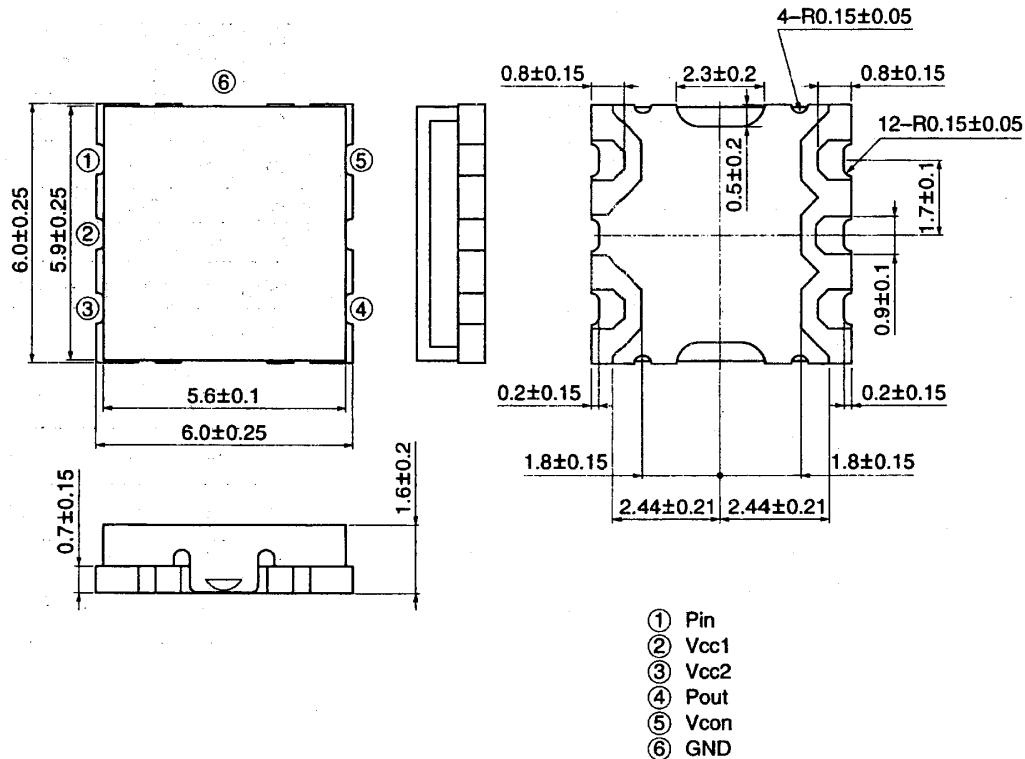
Note 3: ACPR

- a) P_c (1.23 MHz) is average power measured for 1.23 MHz bandwidth with CDMA signal.
- b) P (30 kHz) is average power measured for 30 kHz bandwidth with 900 kHz/1.98 MHz offset.
- c) ACPR1 (or ACPR2) = P (30 kHz) - P_c (1.23 MHz) dB

Note 4: These electrical characteristics are measured using Toshiba recommended test board.

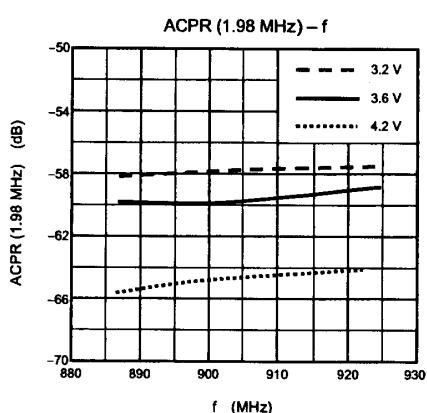
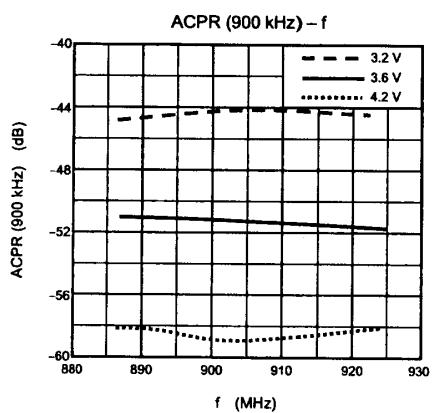
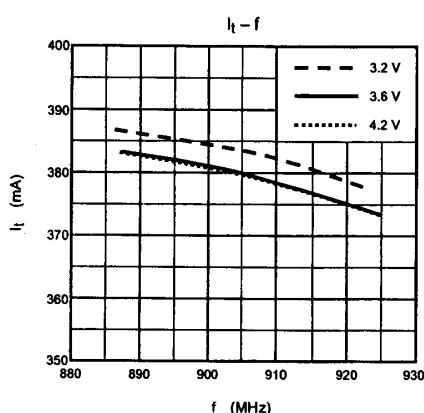
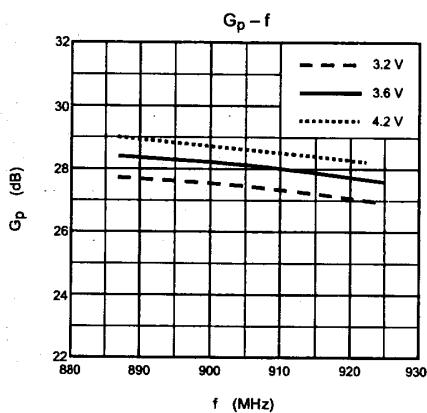
Package Dimensions

unit : mm

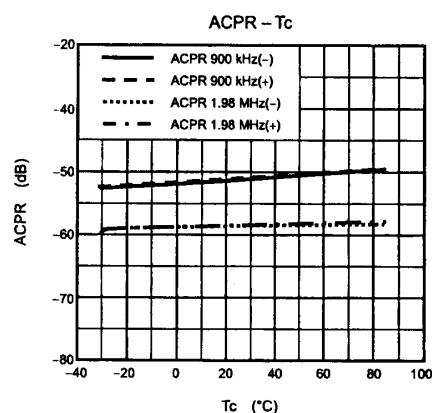
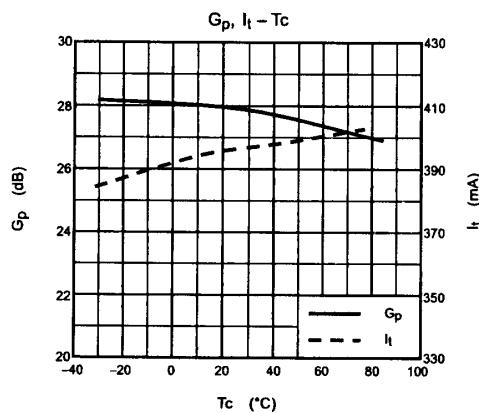


Typical Characteristic Curves

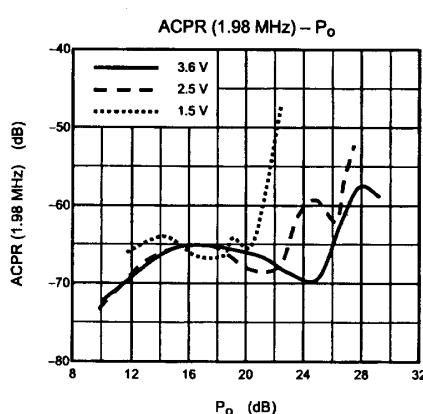
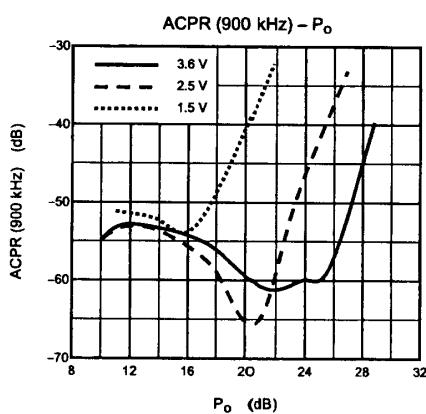
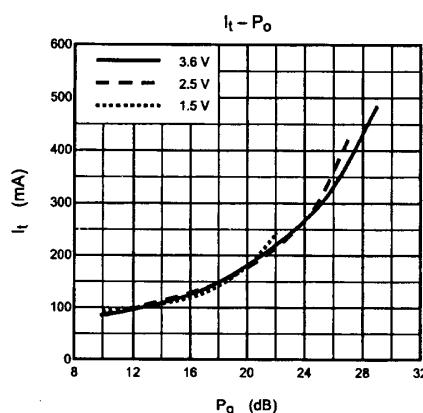
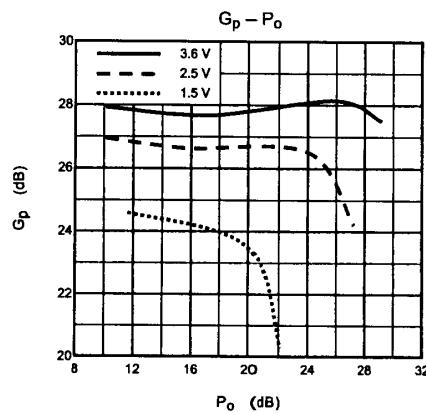
(1) Frequency Characteristics

 $P_o = 27\text{dBmW}$, $V_{con} = 2.85\text{ V}$, $V_{CC1}, V_{CC2} = 3.6\text{ V}$ 

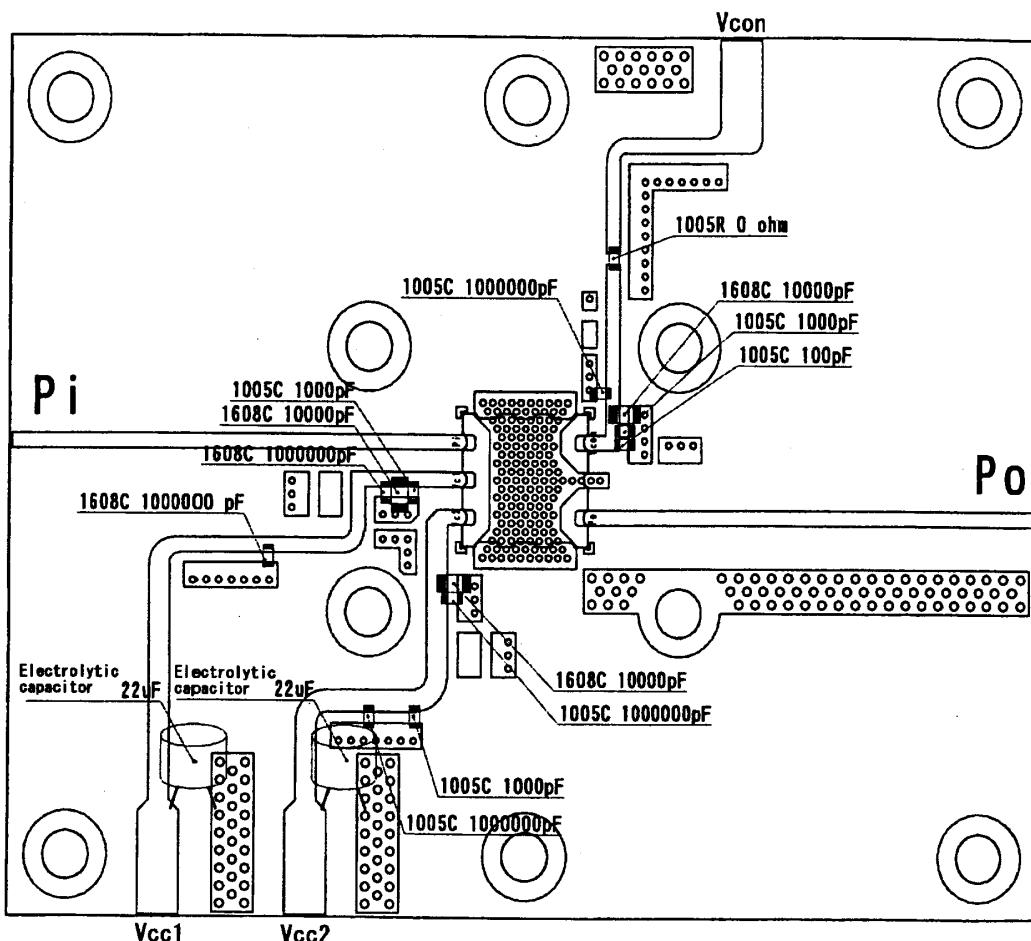
(2) Temperature Characteristics

 $P_o = 27\text{dBmW}$, $V_{con} = 2.85\text{ V}$, $f = 906\text{ MHz}$, $VCC1, VCC2 = 3.6\text{ V}$ 

(3) Power Supply Voltage

VCC Characteristics ($f = 906$ MHz, $V_{con} = 2.85$ V)

Note: These are only typical curves and devices are not necessarily guaranteed at these curves.

Test Board

Note for biasing procedure: Please follow this sequence when you measure a device bias sequence.

- a) VCC1, VCC2 On 0 V to Supply Voltage
- b) Vcon On adjust idle current
- c) RF on

RESTRICTIONS ON PRODUCT USE

000707EAA

- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property.
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- The information contained herein is subject to change without notice.

附件：TDK

RF Components

Band Pass Filters Shielded

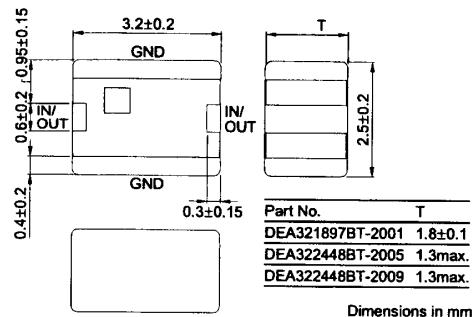
DEA-B Series

FEATURES

- Compact, low profile, and light weight.
- Low insertion loss, high attenuation.
- Shielded type.

SHAPES AND DIMENSIONS

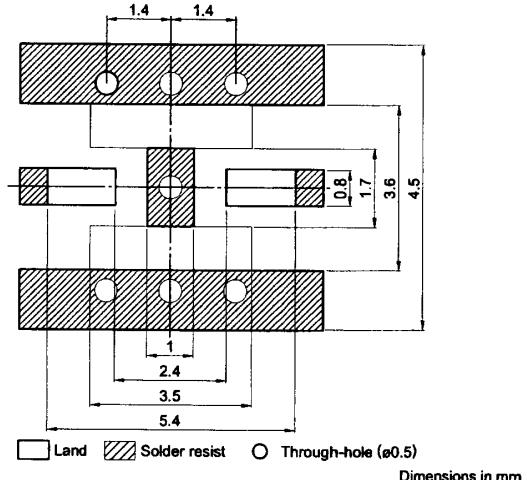
DEA321897BT-2001/DEA322448BT-2005/DEA322448BT-2009



TEMPERATURE RANGES

Operating	-40 to +85°C
Storage	-40 to +85°C

RECOMMENDED PC BOARD PATTERN



APPLICATIONS/TYPICAL ELECTRICAL CHARACTERISTICS

Part No.	Applications	Center frequency f ₀ (MHz)	Bandpass width (MHz)	Insertion loss (dB)max.	Attenuation (dB)min.
DEA321897BT-2001	DCS/PCS	1897	185	2.5	30[at 2f ₀]
DEA322448BT-2005	Bluetooth	2448	97	2.8	30[at 2f ₀]
DEA322448BT-2009	Bluetooth	2448	97	2.2	30[at 2f ₀]

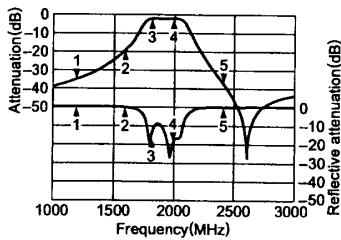
* Company and product names mentioned are registered trademarks.

TYPICAL ELECTRICAL CHARACTERISTICS

DCS/PCS

DEA321897BT-2001

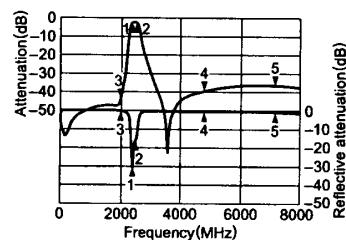
- 1: 1190.0MHz, -35.260dB 4: 1990.0MHz, -2.0348dB
2: 1590.0MHz, -19.240dB 5: 2410.0MHz, -38.205dB
3: 1805.0MHz, -1.9384dB



Bluetooth

DEA322448BT-2005

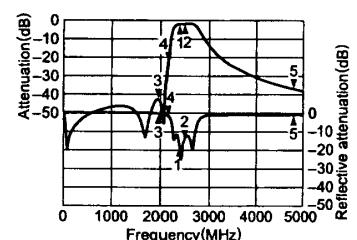
- 1: 2400.0MHz, -2.2746dB 4: 4800.0MHz, -39.798dB
2: 2497.0MHz, -2.1410dB 5: 7200.0MHz, -36.603dB
3: 1990.0MHz, -43.860dB



Bluetooth

DEA322448BT-2009

- 1: 2400.0MHz, -1.5937dB 4: 2170.0MHz, -23.052dB
2: 2497.0MHz, -1.3768dB 5: 4800.0MHz, -36.765dB
3: 1990.0MHz, -42.383dB



⚠ Specifications which provide more details for the proper and safe use of the described product are available upon request.
All specifications are subject to change without notice.

TDK.

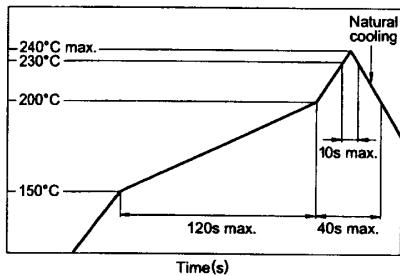
RF Components

Band Pass Filters

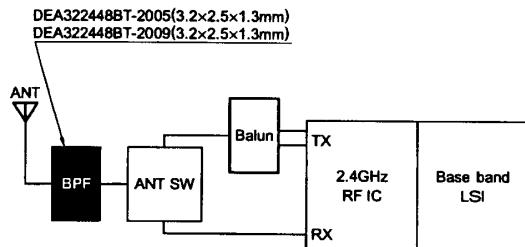
Shielded

DEA-B Series

RECOMMENDED REFLOW SOLDERING CONDITIONS



APPLICATION EXAMPLE CONSTRUCTION OF BLUETOOTH



RF Components

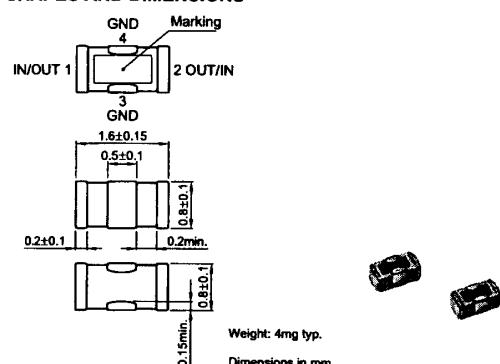
Low Pass Filters Shielded

DEA-L Series

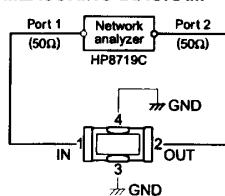
FEATURES

- Smallest-in-the-industry-class compact, thin, and lightweight chip low pass filter manufactured in ceramic sheet multilayering process ($L1.6 \times W0.8 \times T0.8\text{mm}/4\text{mg}$).
- Wide range of characteristics including low loss type (corresponding to 3rd level) to high attenuation type (corresponding to 5th level) achieved according to circuit in use.
- Provided with excellent environmental resistance and stable characteristics achieved under use of portable remote terminal in hostile environment.

SHAPES AND DIMENSIONS



MEASURING DIAGRAM



APPLICATIONS

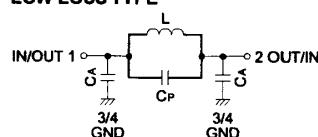
Cellular and digital cordless phones.

TEMPERATURE RANGES

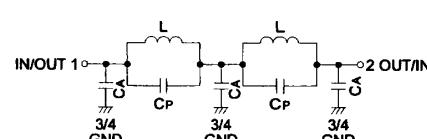
Operating	-25 to +80°C
Storage	-40 to +85°C

EQUIVALENT CIRCUIT

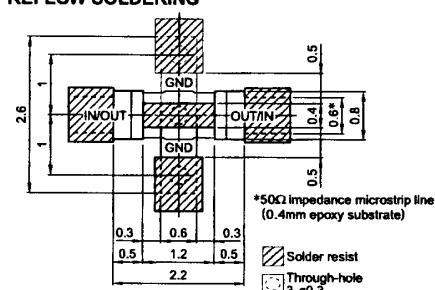
LOW LOSS TYPE



HIGH ATTENUATION TYPE



RECOMMENDED PC BOARD PATTERN REFLOW SOLDERING



APPLICATIONS/TYPICAL ELECTRICAL CHARACTERISTICS

FOR 0.8 to 2.0GHz DIGITAL CELLULAR AND CORDLESS PHONES

Ta=25±5°C

Part No.	Applications	Frequency f0(MHz)	Insertion loss (dB) max.	2fo attenuation (dB)min.*1	3fo attenuation (dB)min.*2
DEA160915LT-1160	GSM	880 to 915	0.5	17	17
DEA160915LT-1156	GSM	880 to 915	0.6	27	23
DEA160915LT-1169	GSM	880 to 915	0.7	30	25
DEA160960LT-1153	PDC800	940 to 960	0.5	20	17
DEA161785LT-1158	DCS1800	1710 to 1785	0.5	27	23
DEA161880LT-1154	DCS1800	1710 to 1880	0.7	27	23
DEA161990LT-1155	PCS1900	1850 to 1990	0.5	27	20
DEA161990LT-1182	PCS1900	1850 to 1990	0.7	30	25
DEA161453LT-1152	PDC1500	1429 to 1453	0.5	20	20
DEA161980LT-1164	IMT-2000	1920 to 1980	0.5	27	20

*1 2fo=Second harmonics out of band rejection

*2 3fo=Third harmonics out of band rejection

⚠ Specifications which provide more details for the proper and safe use of the described product are available upon request.
All specifications are subject to change without notice.

TDK

RF Components

Low Pass Filters Shielded

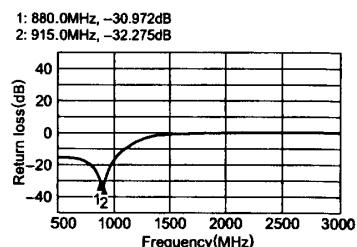
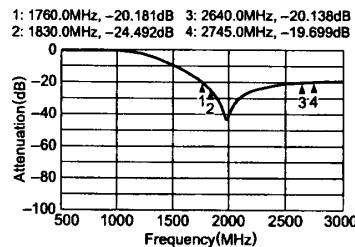
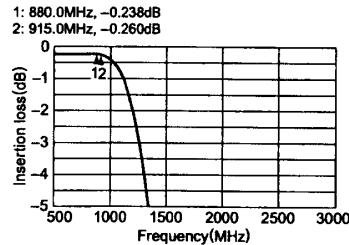
DEA-L Series

TYPICAL ELECTRICAL CHARACTERISTICS

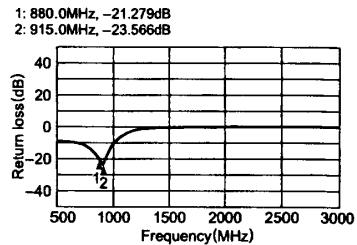
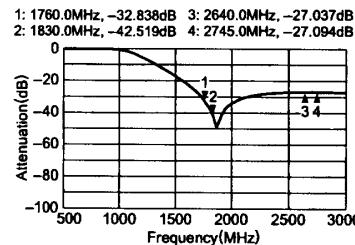
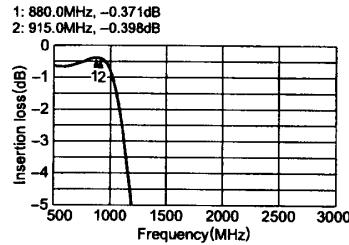
ATTENUATION vs. FREQUENCY CHARACTERISTICS

GSM

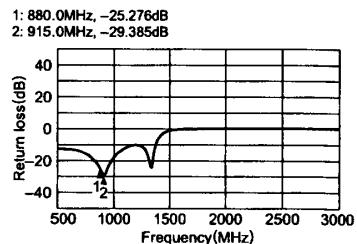
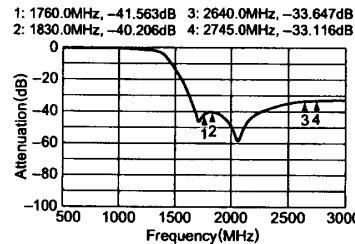
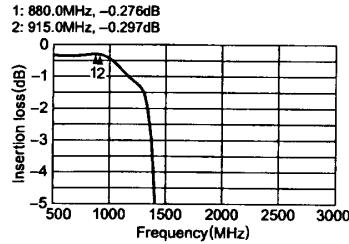
DEA160915LT-1160



DEA160915LT-1156

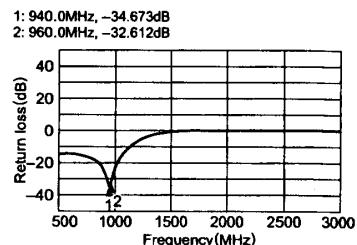
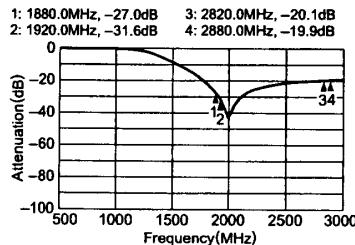
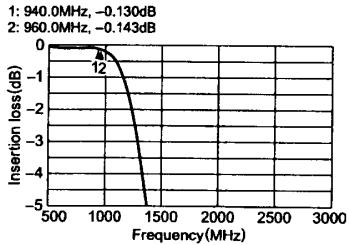


DEA160915LT-1169



PDC800

DEA160960LT-1153



⚠ Specifications which provide more details for the proper and safe use of the described product are available upon request.
All specifications are subject to change without notice.

TDK

RF Components

Low Pass Filters Shielded

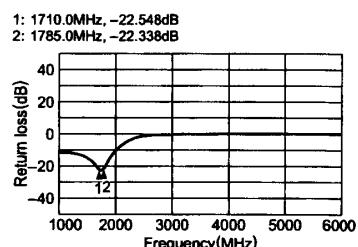
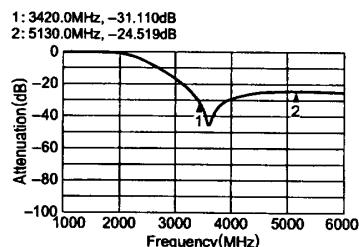
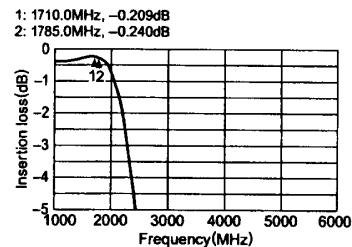
DEA-L Series

TYPICAL ELECTRICAL CHARACTERISTICS

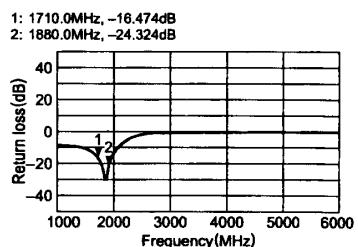
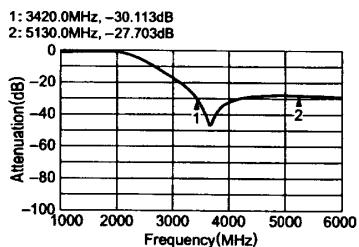
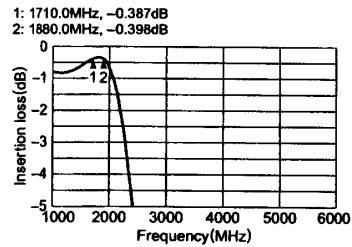
ATTENUATION vs. FREQUENCY CHARACTERISTICS

DCS1800

DEA161785LT-1158

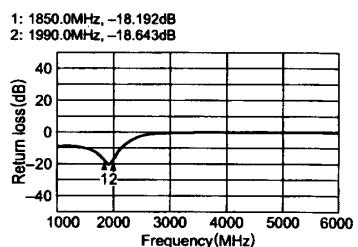
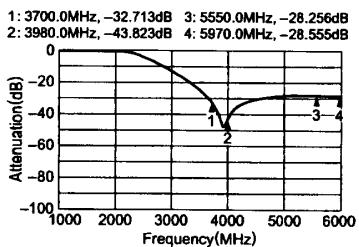
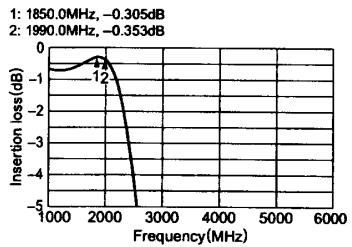


DEA161880LT-1154

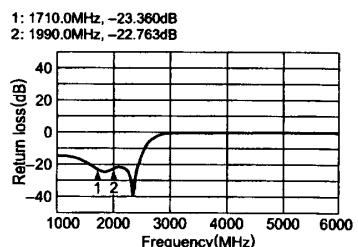
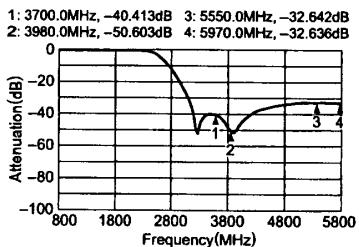
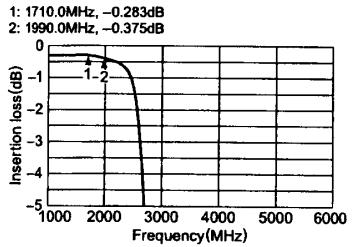


PCS1900

DEA161990LT-1155



DEA161990LT-1182



△ Specifications which provide more details for the proper and safe use of the described product are available upon request.
All specifications are subject to change without notice.

TDK.

RF Components

DEA-L Series

Low Pass Filters Shielded

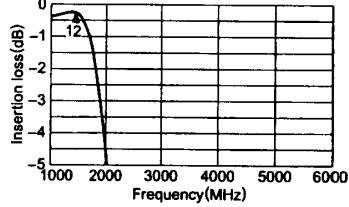
TYPICAL ELECTRICAL CHARACTERISTICS

ATTENUATION vs. FREQUENCY CHARACTERISTICS

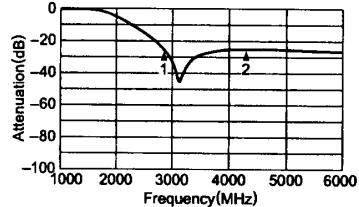
PDC1500

DEA161453LT-1152

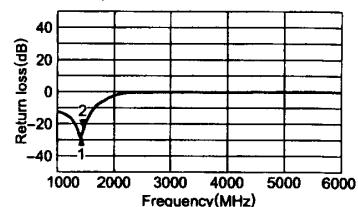
- 1: 1429.0MHz, -0.247dB
2: 1453.0MHz, -0.265dB



- 1: 2658.0MHz, -26.020dB
2: 4287.0MHz, -24.893dB



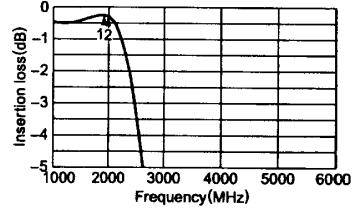
- 1: 1429.0MHz, -28.812dB
2: 1453.0MHz, -25.752dB



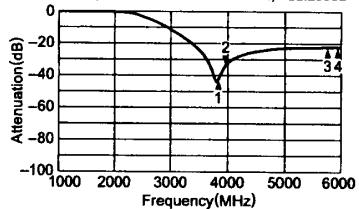
IMT-2000

DEA161980LT-1164

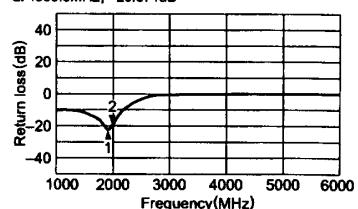
- 1: 1920.0MHz, -0.266dB
2: 1980.0MHz, -0.302dB



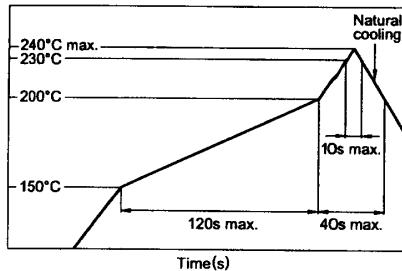
- 1: 3840.0MHz, -43.685dB 3: 5760.0MHz, -22.529dB
2: 3960.0MHz, -34.464dB 4: 5940.0MHz, -22.295dB



- 1: 1920.0MHz, -22.168dB
2: 1980.0MHz, -20.871dB



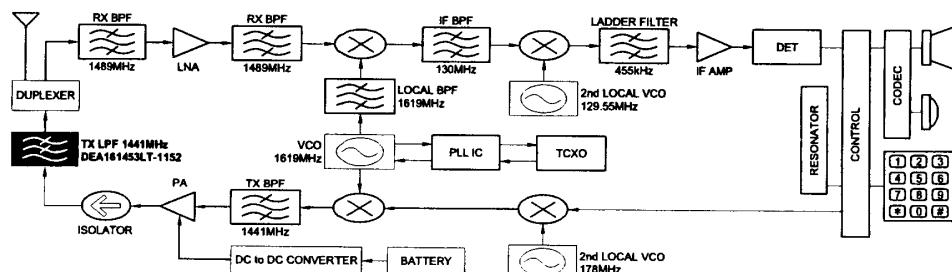
RECOMMENDED REFLOW SOLDERING CONDITIONS



APPLICATION EXAMPLES

DIGITAL CELLULAR

PDC1500



7311 DEA_L
010326

⚠ Specifications which provide more details for the proper and safe use of the described product are available upon request.
All specifications are subject to change without notice.

TDK.

RF Components

Balun Transformers

For Cellular Phone

HHM-10 series

This small SMD type chip balun transformer is formed using a multi-layer process. This miniaturized product(3.2x2.5mm) has roughly 1/2 the volume of previous product with equivalent characteristics.

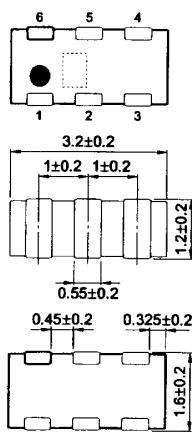
FEATURES

- Miniaturized SMD type(L3.2xW1.6xT1.2mm typ.).
- Low insertion loss(0.8dB max.).

APPLICATIONS

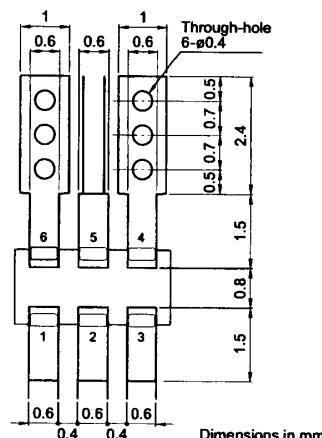
Impedance matching, balanced to unbalanced conversion for mobile communication equipment

SHAPES AND DIMENSIONS/RECOMMENDED PC BOARD PATTERN REFLOW

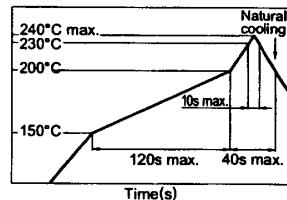


TERMINAL CONNECTIONS					
No.1	GND				
No.2	Unbalanced port				
No.3	GND				
No.4	Balanced port				
No.5	GND(N.C.)				
No.6	Balanced port				

Weight: 25mg typ.
Dimensions in mm



RECOMMENDED REFLOW SOLDERING CONDITIONS



APPLICATIONS/ELECTRICAL CHARACTERISTICS(Typical)

Part No.	Type	Application	Frequency (MHz)	Impedance (Ω)		Return loss (dB)min.	Phase imbalance at balanced port (degree)	Amplitude imbalance at balanced port (dB)max.	Insertion loss (dB)	$T_a=25^\circ C$
				Unbalanced	Balanced					
HHM1101		EGSM/TX	880 to 915	50	100	10	180±5°	2	0.8	
HHM1102		EGSM/RX	925 to 960	50	150	10	180±5°	2	0.8	
HHM1104	LC Transformer	EGSM/RX	925 to 960	50	50	10	180±5°	1	0.8	
HHM1110		EGSM/TX	880 to 915	50	200	10	180±5°	2	0.8	
HHM1111		EGSM/RX	925 to 960	50	200	10	180±5°	2	0.8	
HHM1009		DCS-PCS	1600 to 1800	50	50	10	180±10°	2	0.8	
HHM1010		DCS-PCS	1700 to 1900	50	50	10	180±10°	2	0.8	
HHM1011		DCS-PCS	1800 to 2000	50	50	10	180±10°	2	0.8	
HHM1012		DCS/RX	1805 to 1880	50	50	10	180±5°	1	0.5	
HHM1015		EGSM-DCS/LO	1200 to 1600	50	50	10	180±10°	2	1	
HHM1016		EGSM/TX-RX	880 to 960	50	200	10	180±5°	1	0.8	
HHM1017		DCS-PCS/TX-RX	1710 to 1990	50	200	10	180±5°	1	0.8	
HHM1018		EGSM/LO	1126 to 1206	50	200	10	180±10°	2	0.8	

△ Specifications which provide more details for the proper and safe use of the described product are available upon request.
All specifications are subject to change without notice.

TDK.

RF Components

Balun Transformers
For Cellular Phone

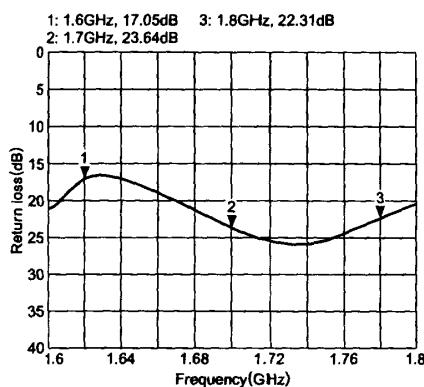
HHM-10 series

TYPICAL ELECTRICAL CHARACTERISTICS

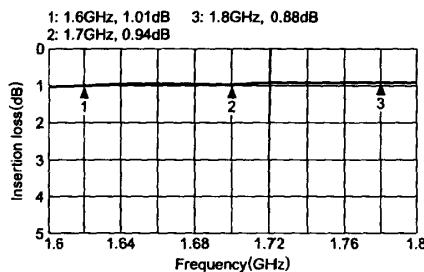
FREQUENCY CHARACTERISTICS

HHM1009

RETURN LOSS

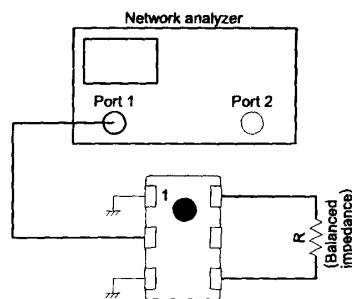


INSERTION LOSS(BACK TO BACK MEASUREMENT)



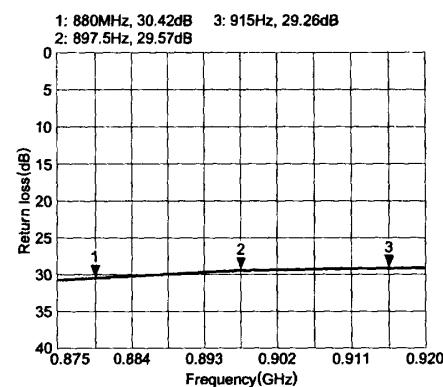
TEST CIRCUIT

RETURN LOSS

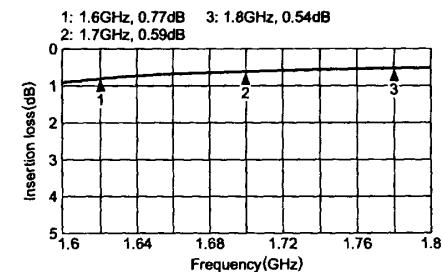


HHM1101

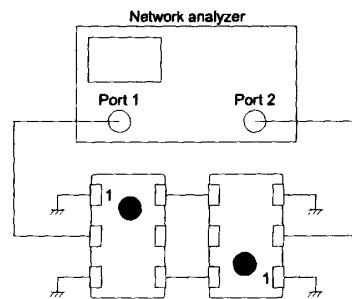
RETURN LOSS



INSERTION LOSS(BACK TO BACK MEASUREMENT)



INSERTION LOSS



附件：KEISO

"WE WANT TO MEASURE FLOW..."
 "WE WANT TO MEASURE LEVEL!"
 "WE NEED SOME SUITABLE
 MEASUREMENT SYSTEMS..."

**OK,
 WE WILL
 TAKE CARE
 OF
 EVERYTHING.**

THE TOTAL SENSOR SUPPLIER,

**TOKYO KEISO
 CO., LTD.**



FLOW MEASUREMENT AND CONTROL INSTRUMENTS

Metal Tube Rotameters	1
Micro flowmeters	2
Glass Tube Rotameters	
Plastic Made flowmeters	
Direct Indication type flowmeters	
Steam flowmeters	
Slurry flowmeters	
Sanitary flowmeters	
Purgemeters	3
Purgesets	
Orifice type flowmeters	
Thermal Mass flowmeters/Controllers	4
Thermal flowmeters	
Thermal Liquid Meters	5
Magnetic flowmeters	
Coriolis Mass flowmeters	6
Ultrasonic flowmeters	
V Cone flowmeters	
Vortex flowmeters	
Mag-Wheel flowmeters	7
Flowmeters for air conditioning application	
Flow Set Valves	
Flowmonitors	
Flowmonitors	8
Flow switches	
Sight glasses	
Brine Monitor	
Opto-Wheel flowmeters	
Open channel flowmeters	
Air Conditioner flowmeters	



LEVEL MEASUREMENT AND CONTROL INSTRUMENTS

Spring balanced tank gauges	10
Servo operated tank gauges	
Tank gauge transmitters	
Analog outputs	
Digital outputs	
Supporting Instruments for Tank Gauging System	
Receiving instruments for Tank Gauging System	11
Optical Fibre Tank Gauging System	
Level switches	12
Metal Tube level gauges	
Gauge glasses	
Displacement type level transmitters	13
Float type level transmitters	
Ultrasonic level gauges	
Microwave level gauges	
Air purging type level meters	
Capacitance type level switches/level meters	14
MICROCELL level system	
Marine use Cargo Monitoring System	15



OTHER INSTRUMENTS

Pressure transmitters	16
IR Universal Totalizers	
Batch Delivery System "Auto-Boy"	
Conductivity meters	
Engine Blow-by gas measurement system	17
CNG flow measurement system	
Propeller type velocity meter	
Flowmeter Alarm Unit	
Relay Driver	
Mass Flow Computer	
Totalizer, Recorder for water treatment application	

FLOW MEASUREMENT AND CONTROL INSTRUMENTS

Almost all types of instruments for flow measurement are available from one source.

For FLOW MEASUREMENT AND CONTROL INSTRUMENTS,
the following abbreviations are applicable for identification :

 : Liquids can be measured

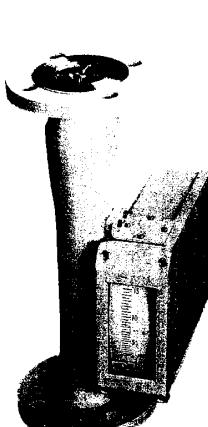
 : Ex-proof available

 : Gases can be measured

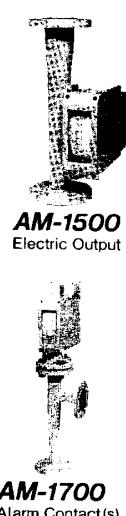
 : Steam can be measured

AM series Compact Flowmeters (Metal Tube Rotameters)

The Best-Seller Metal Tubes, 15mm~150mm
Lining material available.



AM-1400
Local Indication



AM-1500
Electric Output



Exd
Exi



AM-1300
Pneumatic Output



Exd
Exi



AM-1700
Alarm Contact(s)



Exd
Exi



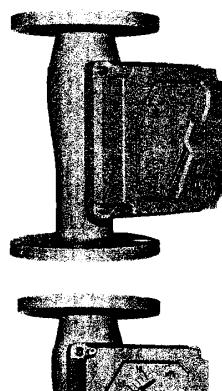
AM-1600
Integration
with Pulse Output



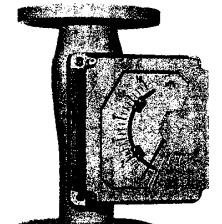
Exd
Exi

MX series 250mm version

Unified installation length of 250mm
for all sizes. Cost-effective metal
tube rotameter. 15mm~100mm size available.



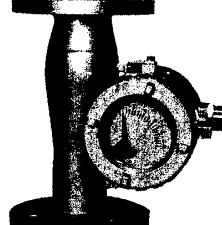
MX-400
Local Indicator



MX-700
Alarm Output

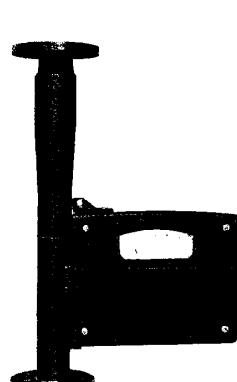


MX-50E
Electric Output

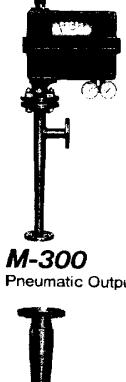


M series Metal Tube Rotameters

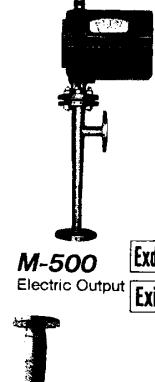
Have been supplied for tough applications of Nuclear, High pressure...



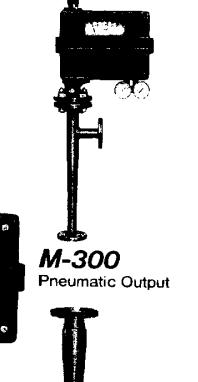
M-400
Local indicator



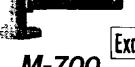
M-300
Pneumatic Output



M-500
Electric Output



M-600
Integration
with Pulse Output



M-700
Alarm contact(s)

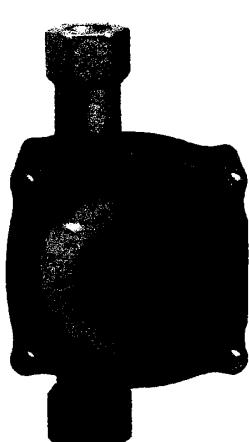


MX-50D
Intelligent, Electric Output
Digital Indication



M-900, MA-900 series Micro Flowmeter

Minimum 0.1~5 l/min, can be measured. Stainless steel and other metallic material i.e. Titanium etc. available. From equipment assembling to general industrial process measurement.

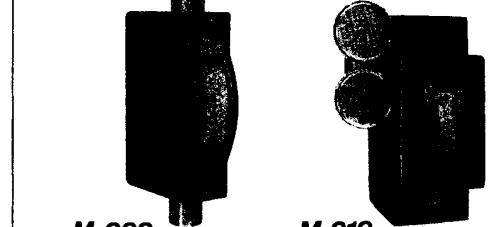


MA-950
With alarm contact



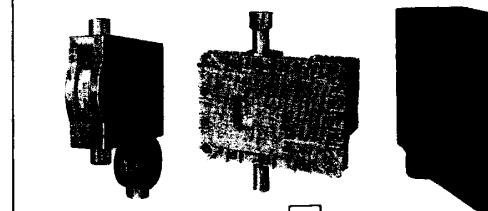
MA-900
Local Indicator

MA-920
Electric output



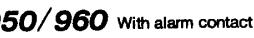
M-900
Local Indicator

M-910
Pneumatic Output



M-920
Electric Output

M-950/960 With alarm contact



R series Glass Tube Rotameters

The Standard of Glass Tube, 10mm~100mm.



R-101



R-101-E



R-101-H



R-105-RK

Direct Indication type Rotameters

Easy handling, Low cost



A-101
Glass tube direct indication



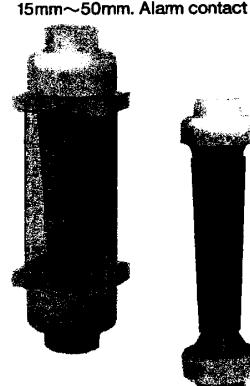
A-102



M-202
Magnet tracking indication



V-201



AC series Plastic Made Rotameters

All connection fittings of TS socket, Rc thread and flanges are available. Easy dismounting from line by Union thread construction.
Best cost-performance and quick delivery.
All-Teflon construction type, AC-T, newly added.
15mm~50mm. Alarm contact available.

Rotameters for Steam Measurement



M-403-FD
Local Indicator



M-524-D
Electric Output



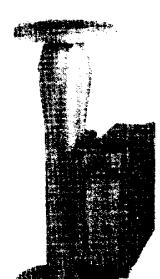
M-316-FD
Pneumatic Output



M-693-FD
Totalizer, Pulse Output

Rotameters for Slurry Measurement

Smooth path,
High anti-erosion capability



AS-1400



S-100

S-400

Rotameters for Sanitary Applications

Suitable for Food, Pharmaceuticals



R-101-SR
Glass tube



AM-1000-SR
Various output available

P series Purgemeters

Wide variation. Suitable for assembling onto various devices.

Ex-stock, Low price
Compact and Good
in design

General purpose
(115mm)

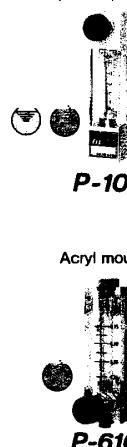
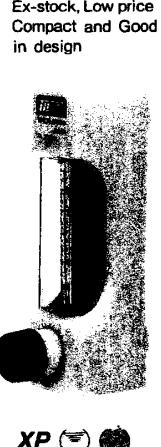
General purpose
(200mm)

Simple design

Stainless steel
construction

Max.20ℓ/min.
(Water)

PVC construction



P-100



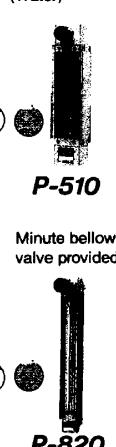
P-200



P-300



P-400

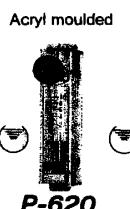


P-510



P-520

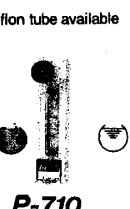
Acryl moulded



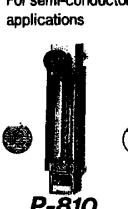
P-610



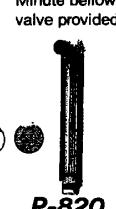
P-620



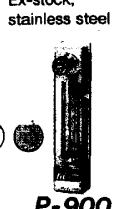
P-710



P-810



P-820



P-900

Teflon tube available
For semi-conductor
applications

Minute bellows
valve provided

Ex-stock,
stainless steel

CLEAN FLOW series ALL-TEFLON Purgemeters

Particle free, No ion production...
Suitable for Pure/Ultra pure water lines in
Semi-Conductor applications.



P-720



P-771

P-772

Purgemeters with Alarm contact and Analog output

For remote instrumentation of Purgemeter process
Reed switch alarms



P-510



PAU Optical Alarm Unit



P-820



IAU Analog Output Unit
DC4~20mA Output



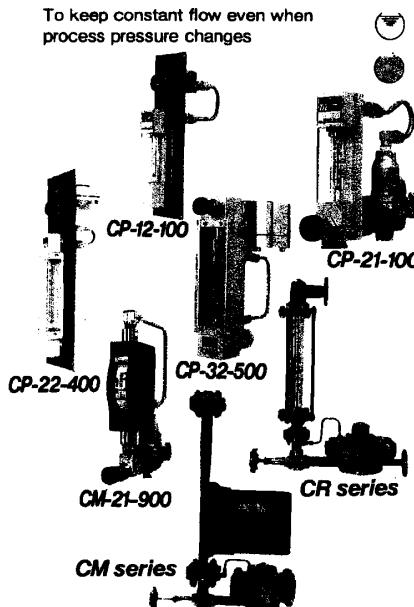
P-810HQ

HQ series High Quality Purgemeters

Electro-polished finish
Low leakage level

CP, CM series Purge Sets

To keep constant flow even when
process pressure changes



O series Orifice Flowmeters

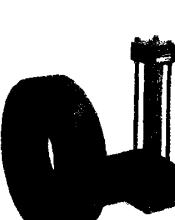
Cost effective flow measurement even for large lines



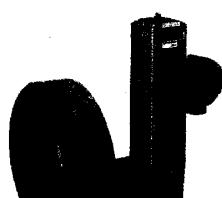
O-180
Screw ended



O-180
Flange ended



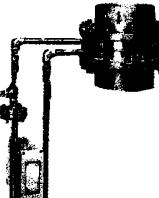
O-180
Wafer construction



O-780
With alarm contact



O-100
Glass tube indicator



O-1400
Metal tube indicator
Output signals available

TF, TC series Thermal Mass Flowmeters, Controllers

For accurate measurement and control of gases

TF-1000/1100 series Mini-Thermal flowmeter

Non by-pass type, Competitive price



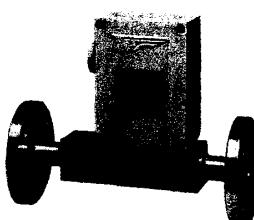
TF-1000P
All plastic moulded

TF-1000S

Stainless steel cast



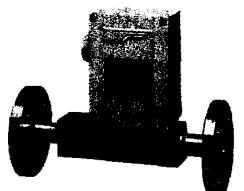
TF-1100
Stainless steel machined



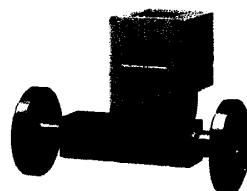
TF-1200
Water tight housing



TF-1300
Low ΔP ,
In-door type



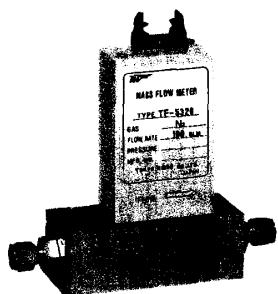
TF-1400
Low ΔP ,
Water tight housing



TF-1500
With indicator,
Water tight housing

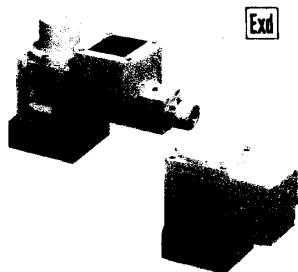
TF-5000/6000 series Thermal Flowmeter

Standard type thermal mass

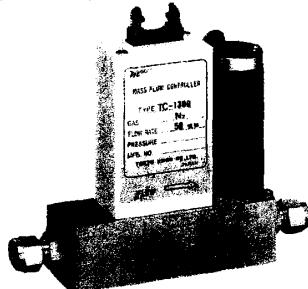


EP-TF-5000/EP-TC-1000

Ex-proof, Thermal Mass + Controller
Covers upto 150kg/cm²G high press.

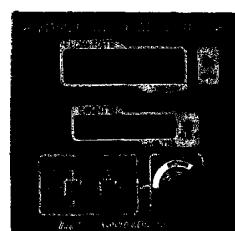


TC-1000/2000 series Thermal Mass Flow Controller



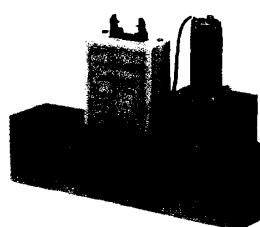
TM-7000 Convertor unit

All necessary functions
in DIN 96x96 compact housing

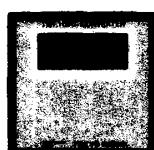


TC-3000 series Mini-Thermal Mass Flow Controller

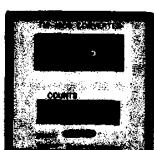
Best cost-effective controller



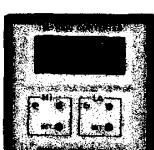
TM-1000 Series, Convertor unit for for Min-Thermal Massflowmeter



TM-1100
Indication



TM-1200
Indication + Totalization



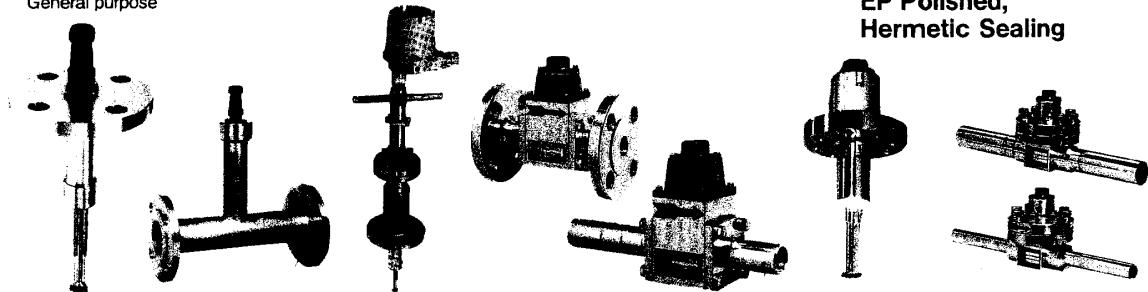
TM-1300
Indication + Alarm



TM-1400
Converter Unit

TH series Thermal Flowmeters

General purpose



TH-1100
Insertion type

TH-1200
Flange ended

TH-1400
Variable
insertion type

TH-1500
Mini-Thermal
upto 50mm

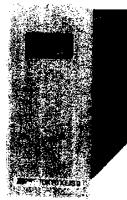
TH-1600
Built-in
straightener type

TH-1100HQ
Insertion type

TH-1500HQ
In-line type

High Quality Version
EP Polished,
Hermetic Sealing

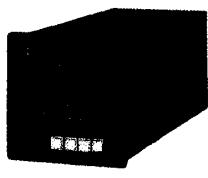
Convertors



TR-1000
Standard,
Panel mount



TR-5000
Standard,
Field mount



TR-7000
High functional,
Panel mount



TR-9000
High functional,
Field mount

High/Low temp. version



TH-3200/3300
Covers -190°C~550°C



Ex-proof version
For hydrogen atmosphere



TH-2200



TH-2400



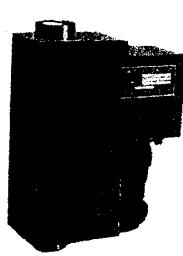
TR-2000

TL series Thermal liquid flowmeters

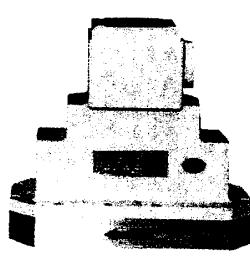
Small flow of 5cc/min. measured



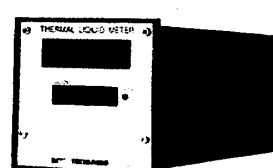
TL-2100
In door use detector



TL-2200
Water tight detector



EP-TL-3000
Ex-proof detector



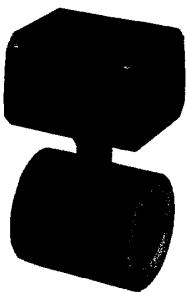
TN series convertor

ALTOFLUX Magnetic Inductive Flowmeters*

Wide-selection. This is one of the features of ALTOFLUX



Compact version (Non-Ex)



IFM1010K ECOFLUX

Economical & Ecology
10~150mm, PFA liner + Hastelloy C
electrode



IFM1080K

Polysulfon tube
Best cost performance
15~80mm



IFM4080K

Standard version
PFA and others
10~600mm



IFM5080K

New ceramic
version
2.5~100mm

Compact version (Ex)



K280AS-Ex
Ceramic version
2.5~100mm



K480AS-Ex
Standard version
PFA and others
10~300mm

Separate version (Non-Ex)



IFS4000F
Standard version
PFA and others
10~3000mm



IFS5000F
New ceramic
2.5~100mm



X2000
Ceramic
150, 200 and 250mm



SC100AS
Microprocessor
based converter,
Full functions

Separate version (Ex)



EX-1000
Ceramic version
2.5~100mm

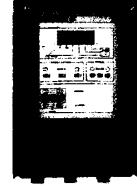
Separate version (Slurry use)



IFS2005F
Ceramic tube
150, 200 and 250mm



IFS4005F
Various lining
50~1200mm



SC150
Converter for
Slurry applications

CORIMASS Coriolis force Mass Flowmeters*



Highest accuracy in the world of $\pm 0.2\%$.
Direct mass measurement.
Density and temperature are also measured.

CORIMASS G series

Single tube, straight through.
The Epoch-Making Coriolis Mass flowmeter



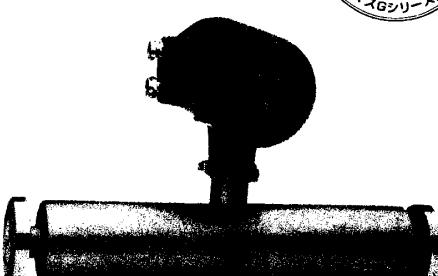
MF 2200P
detector
Max. 1500kg/min.



MF2200-1.5E
detector
Max. 1.5kg/min.



MFC2000
converter

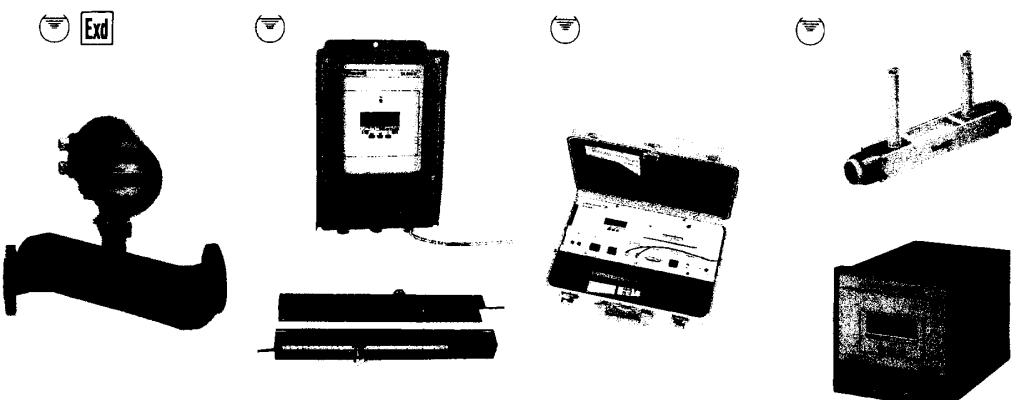


MFM4085K
Single tube, Compact type

* : For limited sales area. Consult factory for details.

ALTOSONIC Ultrasonic Flowmeters*

Non contact, Non movement Flow measurement



UL 500K

In-line, Double beam
Opening new age
25~3000mm

UL 600N

Clamp-on type.
Best Seller Ultrasonic
now up-graded.

UL 600P

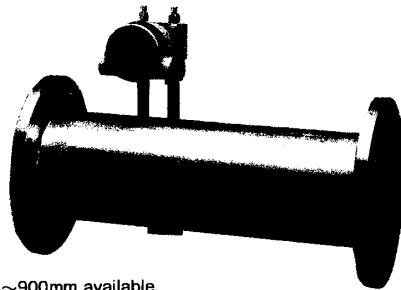
Portable type
Anytime, anywhere

UCUF

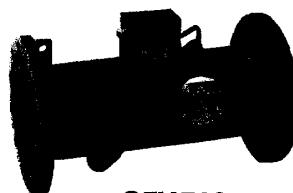
Ultra Clean Ultrasonic Flowmeter
Complete PFA construction
Suitable for Pure/Ultrapure
water application in semiconductor plants

V Cone flowmeter

The total new concept of flow measurement by ΔP theory.
Eliminates all the weak-points likely to Orifice and Vortex flowmeters
Transmitter mounted type, VD series, newly added in product line for
easy field installation.



15mm~900mm available.
Liquids, gases and steam can be measured.



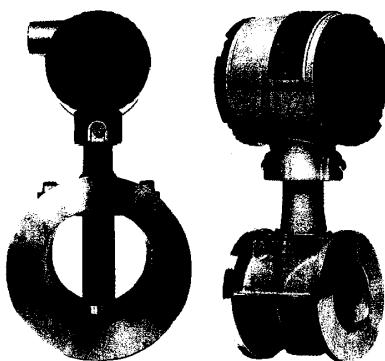
GFM 700

For gases,
In-line type

VF series Vortex Flowmeters



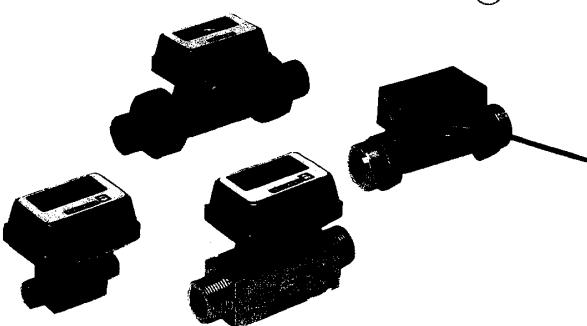
Best cost performance



15mm~100mm, Compact, wafer design

KARUMAN ACE Vortex Flowmeter

Compact flowmeter for liquids. Battery driven and 2 wire, DC4~
20mA output versions are ready. Perfect Non-metallic
construction suitable for Pure/Ultra pure water lines, chemical
injection process in semiconductor production process.

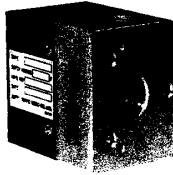


10, 15, 20 and 25mm size available.

W series Mag-wheel Flowmeters

W-300 Mini-Wheel Flowmeters

Compact design for built-in use



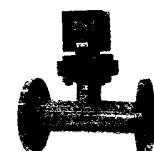
Model	Function
W-31	Open collector pulse
W-32	DC0~5V
W-33	DC0~5V+Alarm contact
W-34	Alarm contact
W-35	DC4~20mA
W-36	DC0~10V
W-37	DC0~5V
W-38	DC1~5V

W-400, W-500 Mag-wheel flowmeter

Medium size of 15~200mm



W-421



W-551



W-491

Model	Function
W-421 W-521	2 wire, DC 4~20mA output
W-451 W-551	Local flow rate indication without power supply.
W-452 W-552	Remote flow rate indication without power supply. (Upto 10m distance)
W-453 W-553	Unscaled pulse output. Used in combination with IR series Universal Totalizers for indication, totalization, alarm etc.
W-491 W-591	Battery driven, alternative indication of flow rate and total volume.
W-492 W-592	Remote version of above (upto 2 m distance)

CF series Flowmeters for Air Conditioning Application



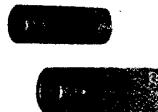
CF-1200
Quick FLOW
(Fixed type)



CF-2300
OneTouch Flow
(Indicator detectable)

CX series Flow Set Valve

To maintain flow rate of liquids and gases even supply/load pressure dranges.



CX-1000
For liquids,
Fixed setting
15mm~40mm



CX-1500
For gases,
Fixed setting
15mm~150mm



CX-2000
For liquids,
adjustable setting
15mm~100mm

FA-5000 FLOW MONITOR

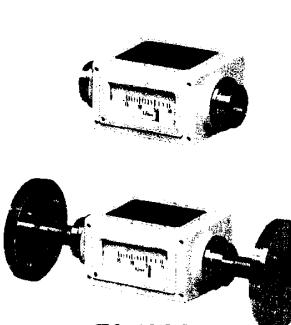


Most simple and cost-effective flowmeter for water lines.
Min. 1~10 l/min., Max. 10~50 l/min.
Rc 3/4 thread conn., for any flow direction.



FLOWMONITOR

Flow indication with alarm contact. Suitable for monitoring of cooling water supply line/devices etc. Any flow direction acceptable.



FA-1000
Stainless steel made.
Max. 100 l/min.



FA-2000
Compact with
Plastic body.
Max. 30 l/min.

Flow Switches

For flow monitoring



F-740
No indication, contact only



K-700
Flapper detection,
Magnet coupling indication



R-700
Glass tube type
upto 100mm

K series Sight Glasses

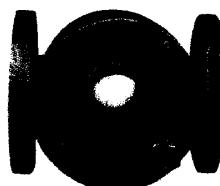
Watch the Flow!



K-200
Flapper detection
Magnet coupling indication



K-400
Flapper direct indication



K-500
Direct observation type
Glass lining material available

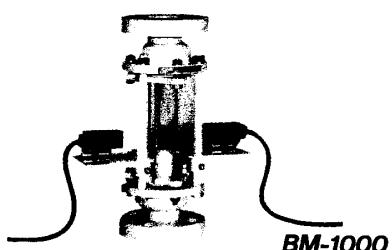


K-600
Straight glass tube direct
indication

BRINE MONITOR



Simultaneous monitoring of flow and concentration of brine fed to Electrolysis reactor



BM-1000

WX series Opto-Wheel Flowmeters

Flow measurement under strong magnetic field by optical sensing



WX-2000



EP-WX-2000

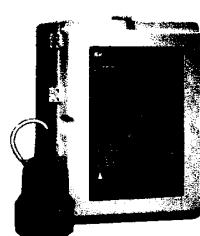
Open Channel Flowmeters



To measure water flow through Wairs, partial flumes etc. Very suitable for water supply and water treatment applications.



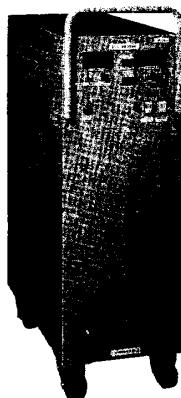
FD-2
Float type



SONOFLOW
Ultrasonic type

AF series Air Conditioner Flowmeter

For testing and evaluation of air conditioners

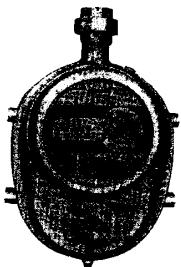


LEVEL MEASUREMENT AND CONTROL INSTRUMENTS

From large Crude oil tanks to small vessels and underground pits, we have various types of level measurement and detecting instruments.

Spring Balanced Tank Gauges

Low pressure
Counter indication



High pressure,
Dial indication



FT-1000
Standard, Float-Tape type



FP-1000
Pipe sealed type

Servo Operated Tank Gauges

Tank side type



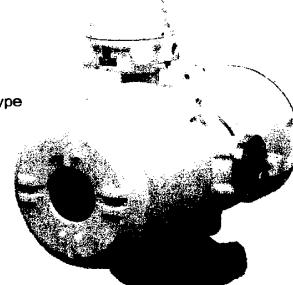
Tank Top type

The best-seller servo gauge
with world best accuracy.

FT-2000 Tape type



FW-2000
All-wire
Heavy duty type

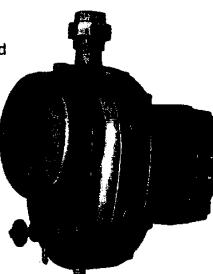


FW-9000
Super Intelligent
Tank Gauge

Transmitters for Tank Gauges

Analog output versions

TR-100 Alarm transmitter
Max. 4 point micro switch contact provided
Ex-proof ready



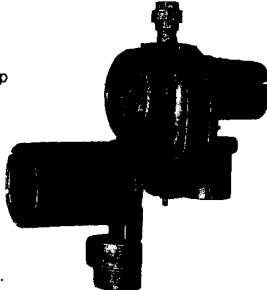
AT-101W Pneumatic transmitter
0.2~1.0kg/cm² pneumatic output

TR-200 Electric transmitter
DC4~20mA output
Alarm contact(s) additionally available
Ex-proof ready

Attachable onto FT-1000, FP-1000, FT-2000 and FW-2000 type
tank gauges for remote indication.

Digital output versions

DB-M type
2 Wire for
Power supply including level and temp
Data in serial BCD



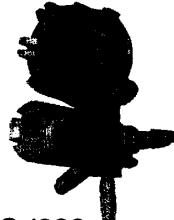
DM type
Best seller, non-contact
A/D convertor for level data

DM-III type
Intelligent, 2 way-2 wire system
Max. 8 point contacts 2 way transfer
possible in addition to level and temp.
Data transmission

Supporting Instruments for Tank Gauging System



DIR-100E
Ex-proof tank side
Indicator used together
with tank top tank gauges



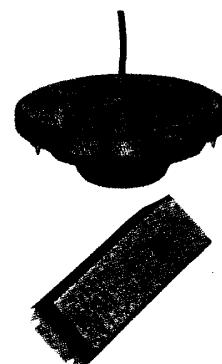
FDC-1000
Field device controller
2 way contact transfer upto 8 points
and field analog data transfer
to control room are possible
by one unit.
Suitable for Motor valve control
through bus line of tank gauges



TS
Spot type

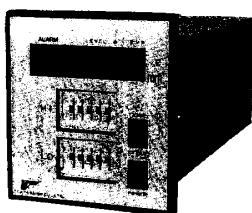


ATM/ATS
Average type
Temperature sensors

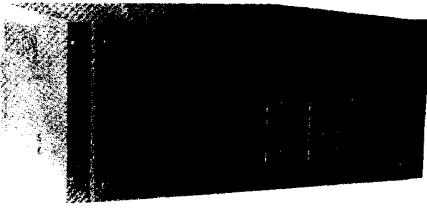


OD-6000S
Oil leak detector

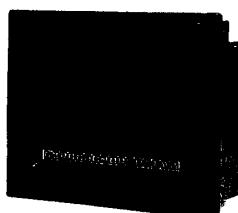
Receiving Indicators for Tank Gauging System



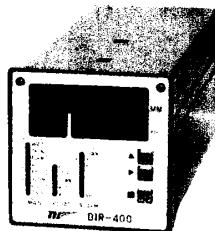
DIR-200
One tank receiver for one way data transmission system
Parallel data output for HOST CPU communication can be provided



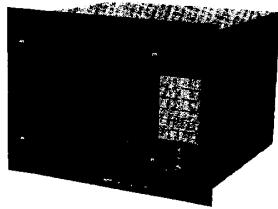
NMR
Selection type indicator,
Max. 63 tank capacity



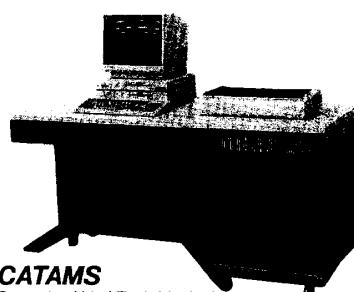
NMR-III
Panel computer based indicator
Easy to install onto instrument panel



DIR-400
Compatible for all Tokyo Keiso's digital transmitters
2 way communication for remote control of field tank gauge possible



NMR-II
Personal computer integrated for volume calculation and other sophisticated functions
Plasma illuminating indication

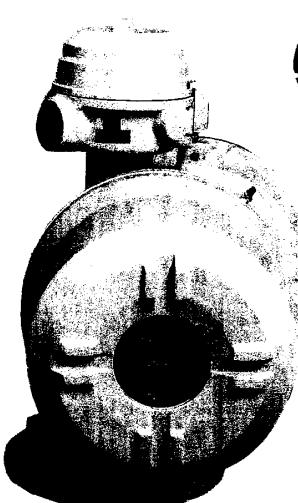


CATAMS
Computer Aided Tank Monitoring System
Full function incl. data printing

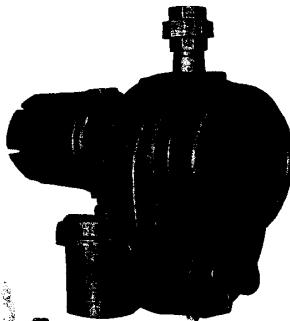
SILENT INSTRUMENTS

Optical Fiber Tank Gauging System

Data transmission is conducted through optical fibre cable to eliminate the effect of external noise such as thunder storms.
Different signal formats of FFI*¹ compatible, CNT*² compatible and Tokyo Keiso originals are ready for clients' choice.



O-FW-9000
Optical signal output version of Super Intelligent Servo Gauges.



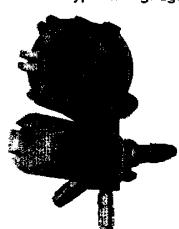
O-DM-III
Optical tank data transmitter to install tank side type tank gauges



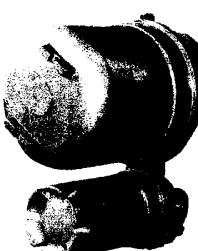
O-DB-M
FFI compatible



O-ATM
Temp. signal is transmitted by optical signal



O-FDC-1000
Field Device Controller
Two way max. 8 point contact transfer in Optical signal.
Suitable for valve control.



DNM
CNT compatible



O-AT
2 way contact data transmission by optical signal

*1 : Trade mark of Fuji Electric Co.

*2 : Optical Tank Gauging system jointly developed by Chiyoda Instrumentation Co., Japan Gear Ind. Co. and Tokyo Keiso

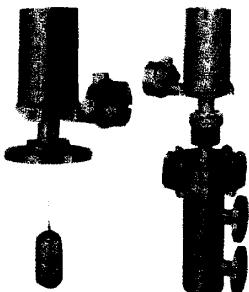
LEVEL SWITCHES



FS-100
Spring
balanced displacer type
ExdI/CT 6 which covers
Hydrogen atmosphere
available.



FP-4000
Multi point
detection for pump
control by one unit

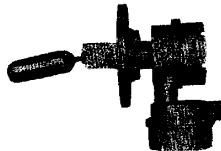


FR-6000
Most well accepted Float type.
ExdI/CT 6 which covers
Hydrogen atmosphere available.

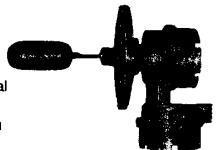
FB-5000
Magnetic coupling,
Reed switch contact,
2" flange mount



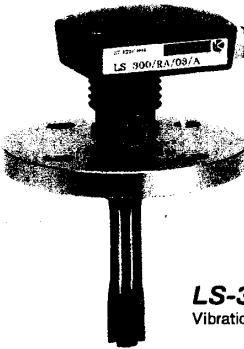
FB-7000
Magnetic coupling,
Micro switch contact,
3" flange mount



FB-9000
Bellows type mechanical
action.
Suitable for slurries with
ferrous particles



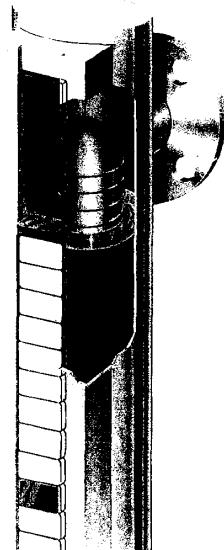
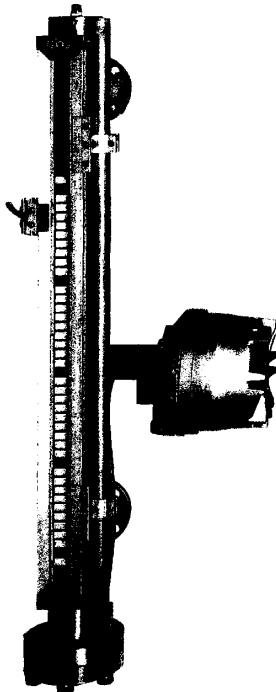
LS-200
All Teflon
Capacitance type



LS-300
Vibration Type

FM series Metal Tube Level Gauges

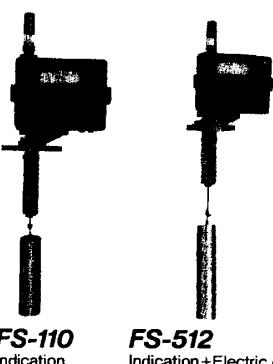
Multi-function by one unit. Cost-saving.
Eliminates common problems of existing glass tube gauges.
Alarm contacts and/or analog output additionally available.



Max. 430 °C and 30MPa(300kg/cm²)possible.
PVC, Teflon, FRP and other special
material available in addition to
standard stainless steel version.

Displacement type level transmitters

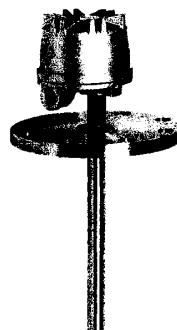
Spring balanced type



FST-3000

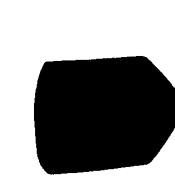
Intelligent type.
Operation parameters, i.e. Sp. Gr., Range, Zero adjustment can be done by pressing Ex-proof built-in key board during operation in hazardous area. The totally new idea of Displacer type level transmitter.

FP-7100 Float Type Level Transmitter

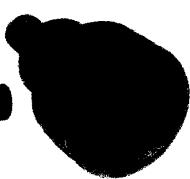


SONOLOGIC Ultrasonic Level meters

Non-contact level measurement of powders, solids and liquids.



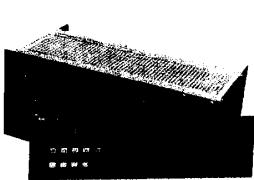
General purpose sensor
Max. 60m range



Anti-corrosive sensor
PvF housing for anti-corrosivity



5000
Standard indicator



MVS
Multi-Vessel System



High humidity sensor
Teflon face for prevention of condensation



Sanitary sensor
IDF Clamp mount



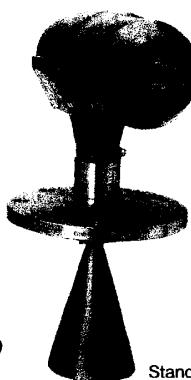
5100
Dual point indicator

Liquid level is output by DC 4~20mA electric signal.
Max. 4810mm.



LEVEL RADAR Micro Wave Level Gauge *

Non-contact level measurement free from change of temp., press. etc.
BM 70 Stick Compact type newly added.



BM 70
pto 30

Standard type



BM 70 Stick
Upto 10m.

Compact type

Liquids, slurry and paste level is measured by perfect non contact by microwave. Suitable for heavy duty applications.

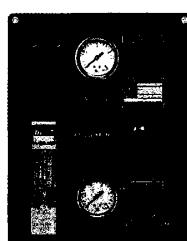
BM 70 Stick can be installed through 25 IDF sanitary clamps.

CP, PGT Pressure type Level Meter

Level measurement by purge pressure.
Density measurement also possible.



PGT
Purge tube

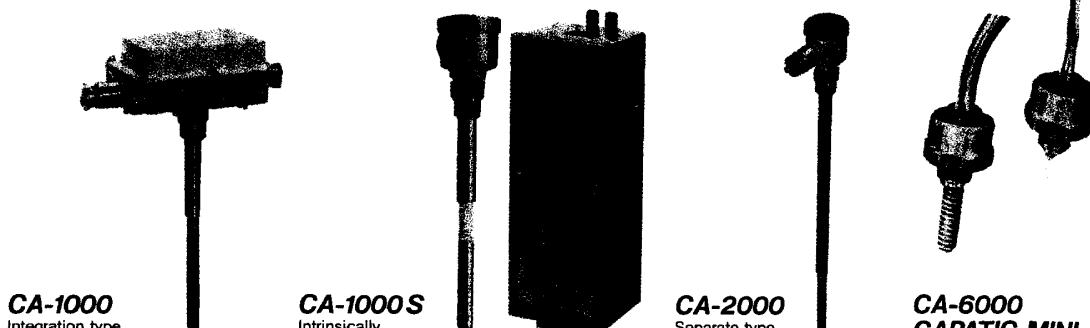


CP
Purge set

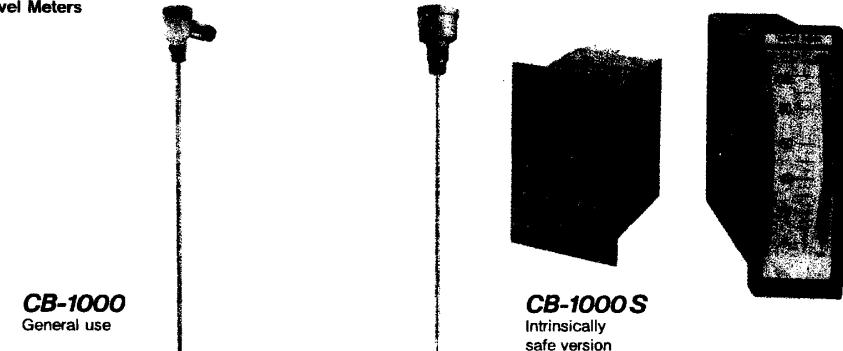
CAPATIC Capacitance type Level Switches, Level Meters

Non movement detection/measurement for powders, solids and liquids

Level Switches



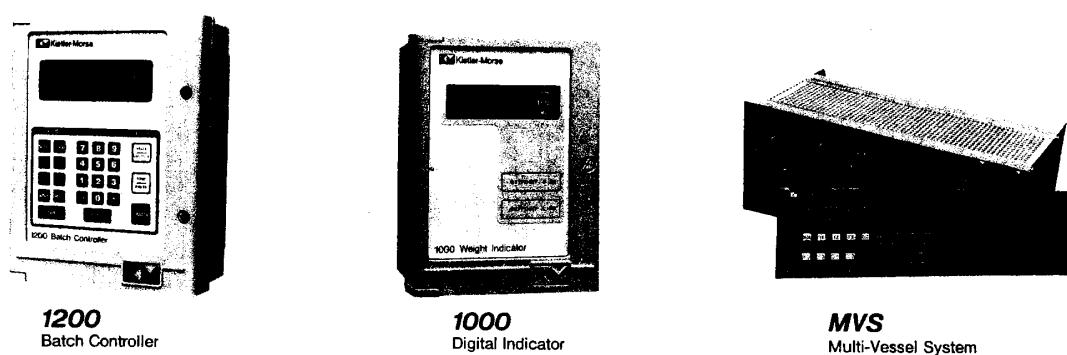
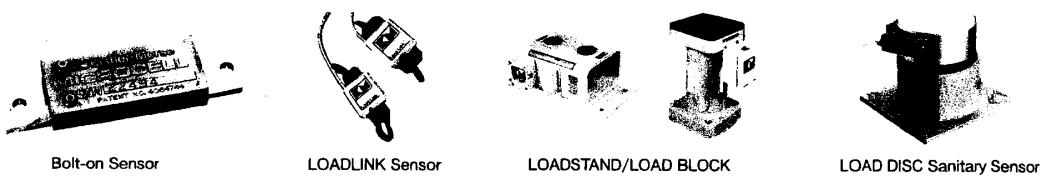
Level Meters



MICROCELL Weighing System

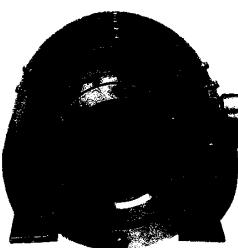
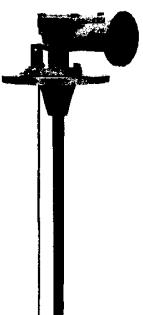
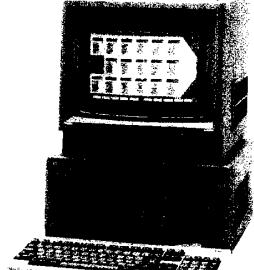
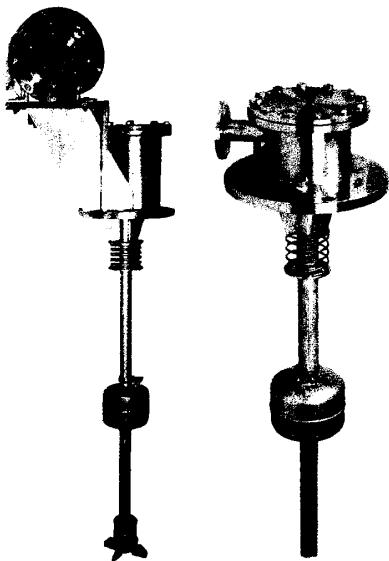
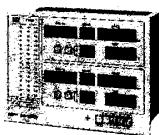
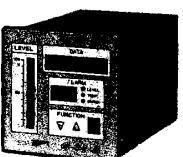
For measurement of contents in silos and hoppers

Semi-conductor strain sensor weighs the contents in silos and hoppers.



Marine Use Cargo Monitoring System

For total monitoring of level and temperature of cargo of oil tankers and product carriers
High level/Over-flow monitoring system also ready.

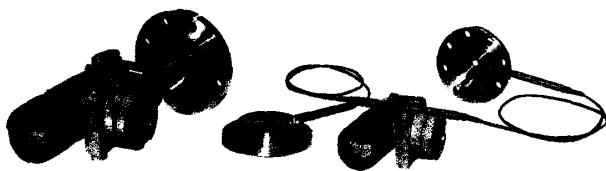
Cargo Level and Temp. Sensors	High Level Alarm Sensors	CCR Equipments	
			
 SPT-3000S Magnet float type Hall element sensing offers durability, stability and high accuracy. Large sized local indicator provided for easy on-deck monitoring. Saves wiring cost by 2 core wiring system.	 SPT-7200S Magnetic float, analog output type	 MIA-LIDEC Resonance type Level switch	 DIR-M1600 16 tanks capacity
 BM 70M Micro-wave type Suitable for sulphur, asphalt and other sticky cargo liquids.	 SAT-1000 Hydro-static type Liquid density simultaneously measured	 DIR-700-DB DIN 96 x 96	

OTHER INSTRUMENTS

We still have more types of Instruments!

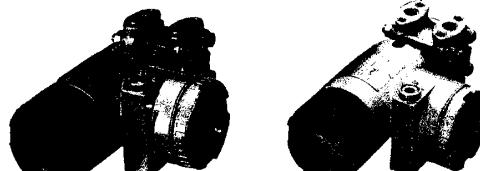
Fcx series Dp Pressure transmitters

For level, flow, pressure... Full line-up to meet all possible requirements, intelligent type also available.
Try once and you will be satisfied.



FHK, FKE
Level transmitter

FHD, FKD
Remote seal type



FHC, FKC
Dp (Flow) transmitter

FHG, FKG
Press. transmitter

FHF
Flow transmitter

IR series Universal Totalizer

Totalization by analog flow signal possible.
Save space, save cost.

Indication, totalization,
2 point alarm,
dual pre-set counter,
loop power supply

Indication, totalization
(alternative),
2 point alarm,
dual pre-set counter,
loop power supply

Indication +
2 point alarm

Indication

Indication +
2 point alarm

Indication



IR-7000
DIN 96×96

IR-4000
DIN 96×48
Best cost performance

IP-3500
Digital scaling
meter-relay

IR-3400
Digital scaling
panel meter
(DC4~20mA input)

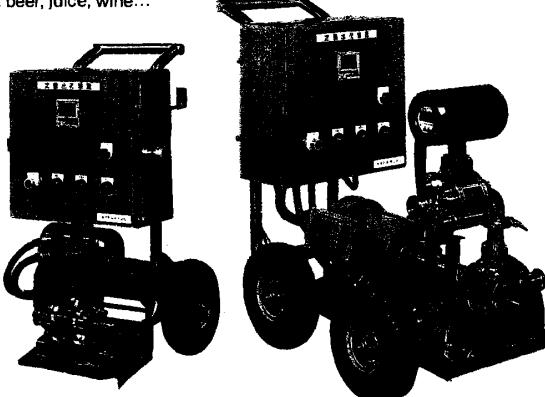
IR-3200
Digital scaling
meter-relay
(Pulse input)

IR-3100
Digital scaling
panel meter
(Pulse input)

BD series Movable Batch Control System "BATCH AUTO-BOY"



Anywhere, anytime, any liquids...
Combination of pump, flowmeter and batch control unit.
For automatic operation in various liquid food industries,
i.e. beer, juice, wine...

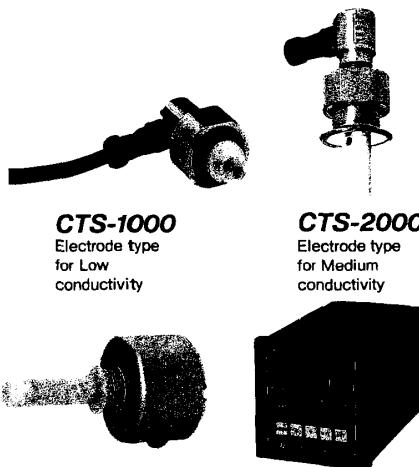


BD-1100
External pump control
version

BD-1200
Pump integrated
version

CT series Conductivity meter

Liquid conductivity and temperature are measured
and simultaneously output.
Full line up including electrode type, magnetic type
and sanitary type.



CTS-1000
Electrode type
for Low
conductivity

CTS-2000
Electrode type
for Medium
conductivity

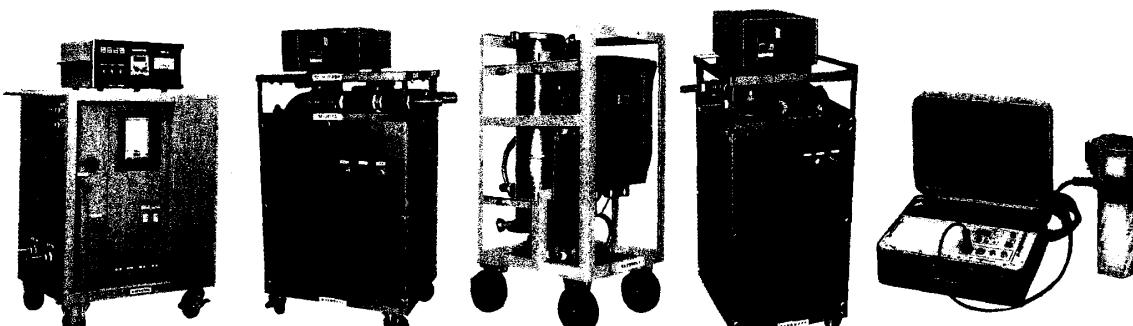
CTS-3000
Magnetic type
for high
conductivity

CTC
Micropressor based
High functional
converter

BF series Engine Blow-By Gas Measurement System

(Direct and high accuracy mass flow measurement by TH Thermal flowmeter)

For evaluation test of cylinders, piston rings, engine oils. Wide range preparation to meet requirements.



BF-1000

Pressure loss compensated
by integrated blower.
Highest accuracy and
versatile function for
continuous operation.

BS-2000

For large sized engines

BF-3000 S

Compact, light and cost
effective, for small and
medium sized engines

BF-4000

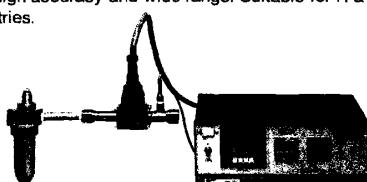
Automatic operation
function provided

BF-5000

Portable driven
by DC 12V battery
On vehicle running test
possible

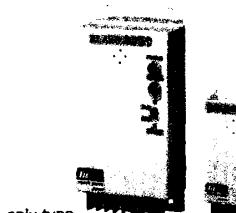
CNG Flow Measurement System

CNG, the new energy source for engines, is measured in mass flow
with high accuracy and wide range. Suitable for R & D in Automobile
industries.



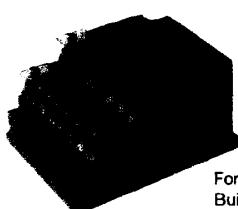
AU-1000 Flowmeter Alarm Unit

Low alarm contact from flowmeter
is connected to drive buzzer for
quick notice of flow cut-off.
Easy installation and wiring.
Battery driven type available.



Battery Driven type

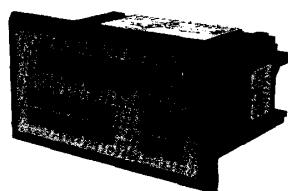
RD-1000 Relay Driver



For amplifying of level switch contacts.
Built-in sequence for pump control provided.

MASS FLOW COMPUTER

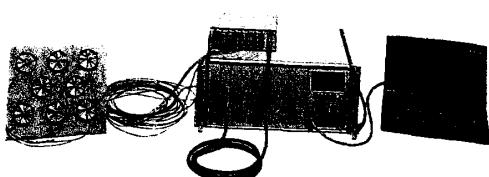
Automatic compensation to obtain mass flow rate and
totalization by inputting flow, press. and temp. signal.



EA-275
MASS FLOW COMPUTER

RF series Propeller Air Velocity Meters

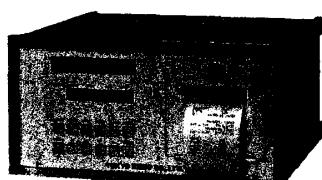
Propeller type velocity meter for detection of air flow.
Suitable for evaluation of air flow distribution profile for
radiators.



TOTALIZER, RECORDER FOR WATER TREATMENT APPLICATION

•For Multi-loop application

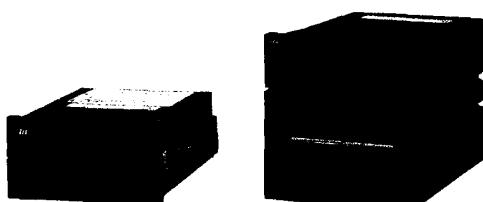
Max. 16 point flow sensor can be connected. Automatic
totalization and programmed interval printing.



FMM series

•For Single-loop application

Counter and printer for one flow sensor.
Totalization and programmed interval printing.



3000 series

SINE WAVE INSTRUMENTS
SINCE 1951

附件：UHT

2.

SPECIFICATION

2.1. Leading Particulars

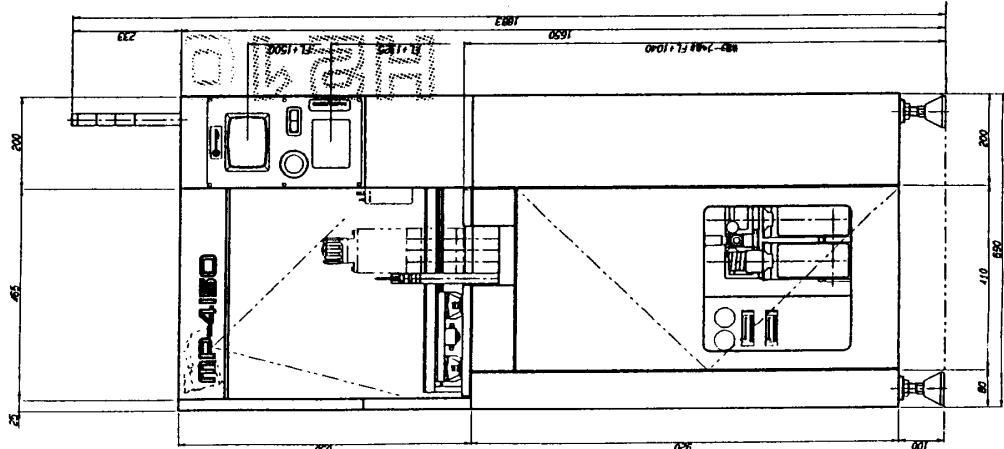
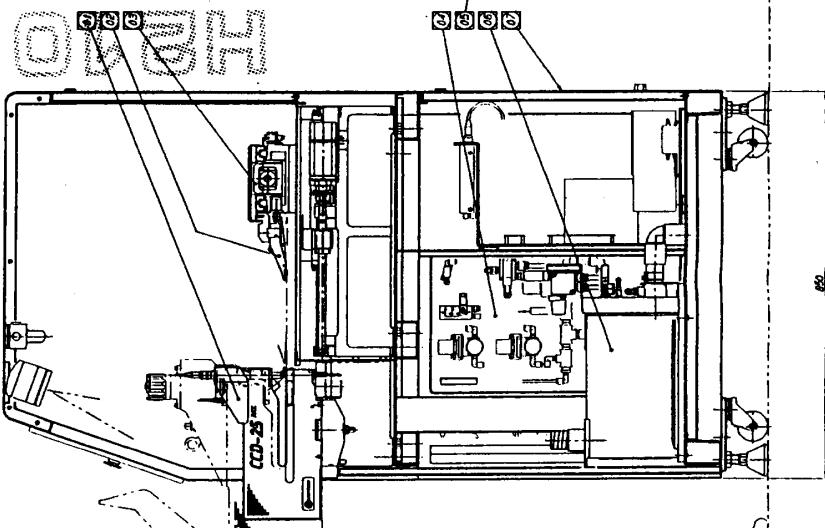
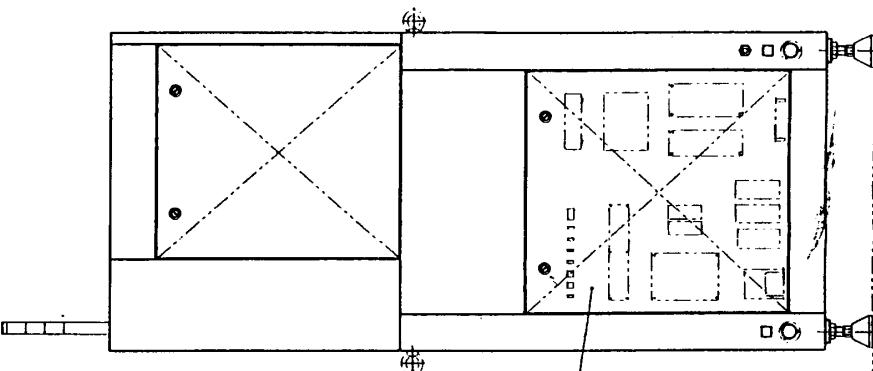
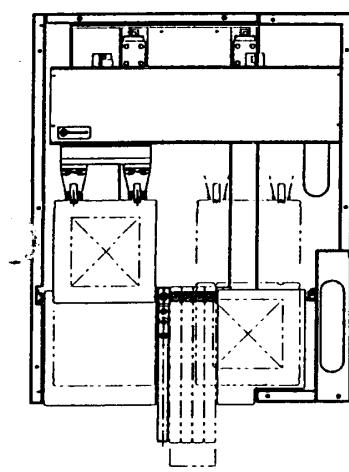
Model: MP-4150

Usage: Punching Green ceramic sheet.

Standard Specification

A) Maximum material size	175 mm × 175 mm
B) Work handling	Work holder
C) Work holder positioning	V/F method
D) Maximum working area	150 mm × 150 mm
E) Punch unit mount	Max 5 set of PU-25
F) Camera unit	use for Punch centering (sight area 1.2mm × 1.4mm)
G) Positioning accuracy	±10micron within the above item A)
H) Number of hits of punch	850 hit/min
I) Axis Stroke	X 330 mm Y 180 mm
J) Minimum setting	X 0.001 mm Y 0.001 mm
K) Quick feed speed	30 m/min
L) Dust collector	2 lined
M) Signal tower	Continuos / intermittent selectable
N) Safety sensor	3 colors Emergency stop by Area sensor (with Restart function)
O) Data string	Machine :Memory card
P) Maximum stored data	8,000 position (1 program)
Q) Machine size	640×1116×1610 mm
R) Machine Weight	300 kg
S) Air consumption	300 normal litter / min
T) Source pressure	6.5 to 8.0 kg/cm ²
U) Electric power source	AC 200V triple phase 0.5KVA
V) controller	machine:UHT ASCA-contoroller
W) Work clamp	Clamped with special fingers
X) Work mounting method	As negotiated separately
Y) Standard dies	0.1 to 5.0 mm dia (circular) 0.2 to 5.0 mm side (square)

ITEM NO.	REF. NO.	NAME
1	691100001	
2	691100002	
3	691100003	
4	691100004	
5	691100005	
6	691100006	
7	691100007	
8	691100008	
9	691100009	
10	691100010	



MANUAL
O.I.A.
NOTE, O.I.A.
69000930
全外觀圖面
MP-4150
MP-4150
69000930
69000930

3.

INSTALLATION AND TRANSPORTATION

3.1. Environmental Conditions

- Attention to environment is necessary for precision instruments
- Temperature
 - When operating: 15 to 25°C
 - When not operating: 5 to 40°C
- Humidity (R.H.): 60% or under
- Temperature change: 0.2°C /min or less
- Vibration: 0.5 G or less
- The machine shall not be exposed to direct sunshine.
- The machine shall not be subjected to local temperature rise by heaters, etc.
- No dust shall exist.
- The floor shall be stable, as leveling is important.

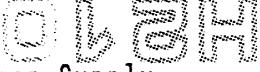


3.2. Installation

- Select a place which satisfies the environmental condition.
- Install on a stable floor.
- Select a location where the fluctuation of electric power and pneumatic power is slight.
- Be sure there is no noise source in the vicinity. (Ex. Crane, high-frequency sealer, electric discharge machine)
- Install with a levelness of 0.05mm/m or less. (measure on the Y-axis)

3.3. Transportation

- Use the attached eye-bolts where locate both side of X-axis when lifting with a crane.
- Place wooden blocks under the machine so that the weight will not be supported by the jacks or casters.
- Separate the Power Source Box from the machine before transporting.
- Be sure to remove the dust collector before transporting.



3.4. Electric Power Supply

- Use electric wires of not less than 2mm² dia. There shall be no voltage drop from other machines.
- The diameter of the grounding wire shall be not less than 1.6mm dia.
- Use the stabilized electric power source device if the supplied power may be unstable or noise may enter.
- Use an earth leakage breaker as a circuit breaker.

- Notification to UHT is required before using other than standard electric power sources. When used without prior notice, the user must bear all repair costs which may be required.

3.5. Specification for electric

- The electric power source shall be single phase, AC 200V ±10% 50Hz / 60Hz 0.5KVA.

3.6. Pneumatic Power Supply

- Use a compressor of 5 HP or more.
- Use an air hose with an inside diameter of not less than 9 mm. The length of the hose shall be 5 m or less. In an event the length exceeds 5 m, use the inside diameter of not less than 11 mm, to minimize pressure drop.
- Be sure to use the air drier (standard equipment) specified by UHT. Do not use the drier in common with other machines.
- Adjust the pneumatic power source to provide the pressure of 6.5 kg/cm² or more. If the pneumatic power source is under 6.5 kg/cm², use the booster (optional equipment). UHT does not bear any responsibility for any trouble which may occur by pressure drop.
- Install the filter, mist separator, etc. before the drier, if dirt, carbon, water, oil, etc. may enter the pneumatic power system.
- For malfunctions which may occur by the use of improper pneumatic power source, the user must bear all repair costs even within the guarantee period.

3.7. Specification for Air

Maximum air consumption : 300 normal liter/min

Pressure range of power source : 6.5 to 8 kg/cm²

4.

PRECAUTIONS

4. 1. Safety

(UHT bears no responsibility for any accident which may occur by carelessness)

- The following are the minimum requirement for safe operations. Be sure to observe them. Specially important precautions are indicated by the label applied on the machine body.
- Do not put any part of your body or a tool, etc. into the work area of the machine, as the machine moves very rapidly. Especially important, do not put your hand or a tool on the table while the machine is operating.
- When the machine is operating, turn off the electric power and make sure it is safe before putting your hand into the work area of the machine.
- Make sure that the machine has been completely stopped before removing or mounting the work.
- Do not put your hand on the punch-packs while the machine is operating.
- Be sure not to put your hand under the punch.
- Wear clothes suitable to perform the work safely.
- Make sure that the punches have been secured before starting the operation.
- Operate the machine with no work on the table, to verify the program, before starting the automatic operation.
- Do not wear gloves when operating the keyboard, and switches.
- Be sure to install or close the safety cover, body cover, control box door, etc. before starting the operation.
- Be sure not to neglect to clean the machine.
- No person other than the operator shall be allowed to come near the machine which is operating.

4. 1. 1. Emergency Stop

The emergency stop switch is provided on the front of the machine. If this switch is pressed, the electric power is turned off, and the X and Y-axis stop movement. When releasing the emergency stop, check safety, release the emergency stop, and place the electric power switch to ON. Then the X-Y robot automatically returns to the home position.

5. TURN ON & TURN OFF ELECTRIC POWER

5.1. Verification and Checking Items before Turn on

- Nothing is placed on table.
- Air pressure is 7kg/cm² or more.
- Arm is not obstructed by other objects, because it returns to home position automatically.

5.2. Turn on Method

- Breaker on the front of machine to ON
- Press the RESET button.
- Place the machine power switch on the front surface of the machine.
- The X-and Y-axes of the machine automatically return to the home position. When returned, the initial menu is displayed on the screen.

NOTE: If the machine electric power is not turned on, examine the electric power source, pneumatic power source, and emergency stop button. If the machine does not return to the home position, even when the electric power is supplied, the overstroke limit switch must be ON. Turn off the machine POWER switch, move the arm (X-, and Y-axes) to the center of the table, and repeat Turn on method again.

5.3. Turn off method

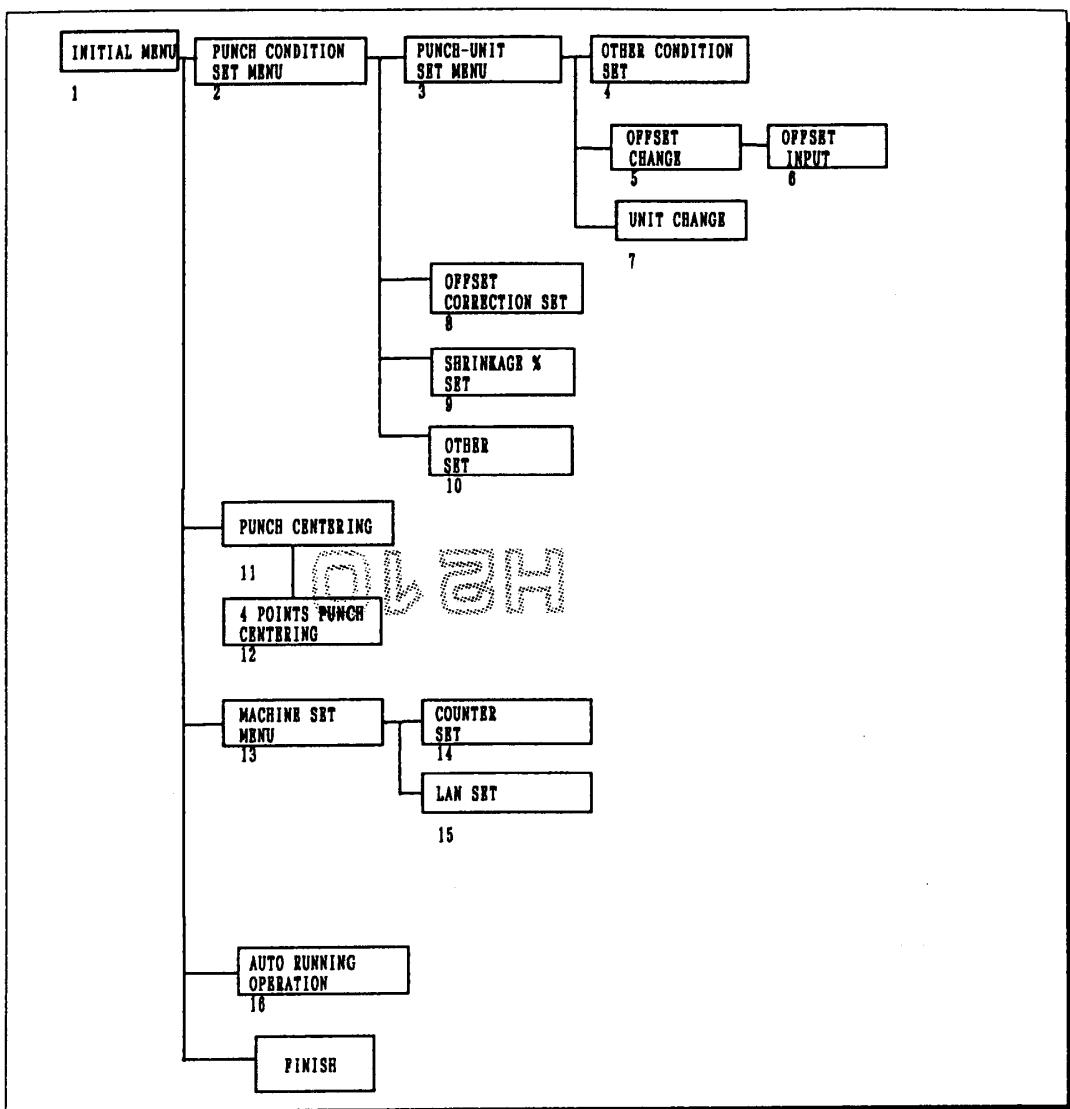
- Place the machine POWER switch on the front surface of the machine to OFF.
- Place the machine breaker on the front of the machine to OFF.

5.4. Verification after Turn on Electric Power

- There is no abnormal indication nor alarm message on the screen.
- Pneumatic source pressure is 7.0 Kg/cm² or more.
- Air drier is operating.
- There is no abnormal sound or noise in servo motor.

6.

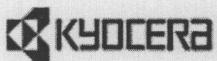
TOUCH PANEL



Operation

- As above ladder logic shows, each menu is subdivided into a few items to be set.
Select item to set on each menu.
- Can select items shown in reverse video. Touch proper item on the panel.
- This manual explains each menu subdivided it into some items. Outline of each function is stated in menu screen and basic operation is stated in operation screen.
- Refer to item No. Marks on above ladder logic.

6.1. Initial menu



SEMICONDUCTOR PARTS

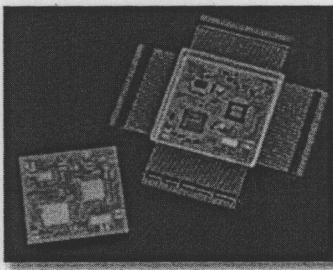
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KAI LTCC DIVISION

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Multilayer air-fired LTCC products for high frequency applications are the cornerstone of the KAI LTCC Division of Kyocera America. Coupling commercially available materials from Ferro

and DuPont with the high frequency simulation, test and design capabilities of Kyocera, unique products for the emerging satellite, wireless and high speed digital markets are developed and implemented in world class cycle times. Close interaction between designers, engineers and key customer contacts ensures solid communication, clear understanding of needs and capabilities and a rapid resolution of customer requirements. The excellent dielectric properties of Ferro and DuPont LTCC systems along with the ability to embed passive and active components enables the design and fabrication of products that are key to meeting the needs of microwave and higher frequency applications. Hermetic packages with brazed metal components are fabricated to support the demanding requirements of these markets.

The KAI LTCC Division Mission is:

To become the preferred supplier of LTCC multilayer ceramic substrates and Pressed Products in the markets we serve by:

- *Maintaining our technology leadership in ceramic material systems through continuous product, process and materials engineering*
- *Providing products and services that meet or exceed our customer's expectations*

附件：KYOCERA



Resistor Tolerance Issues in Producing High Performance LTCC Devices

- Dr. Eric Ness - Senior Material Scientist
- Ed Graddy - New Product Development



RESISTANCE TOLERANCE ISSUES

- DUPONT 951
- BIROXX 2000 SERIES RESISTORS
- ALL GOLD SYSTEM (5734)
- ALL SILVER SYSTEM (6146 & 6148)
- TEST COUPONS FOR DESIGN RULES



PROCESS PARAMETERS

- 3 RESISTOR DECADES
 - 10, 100, & 1K OHM
- TERMINATION OVERLAP
 - GOLD AND SILVER
 - 5 MILS OR 15 MILS
- FIRING FURNACE/PROFILE
 - BELT AND BATCH
- ARRAY OF 30 RESISTOR SIZES
 - 10 X 10 TO 40 X 50 MILS

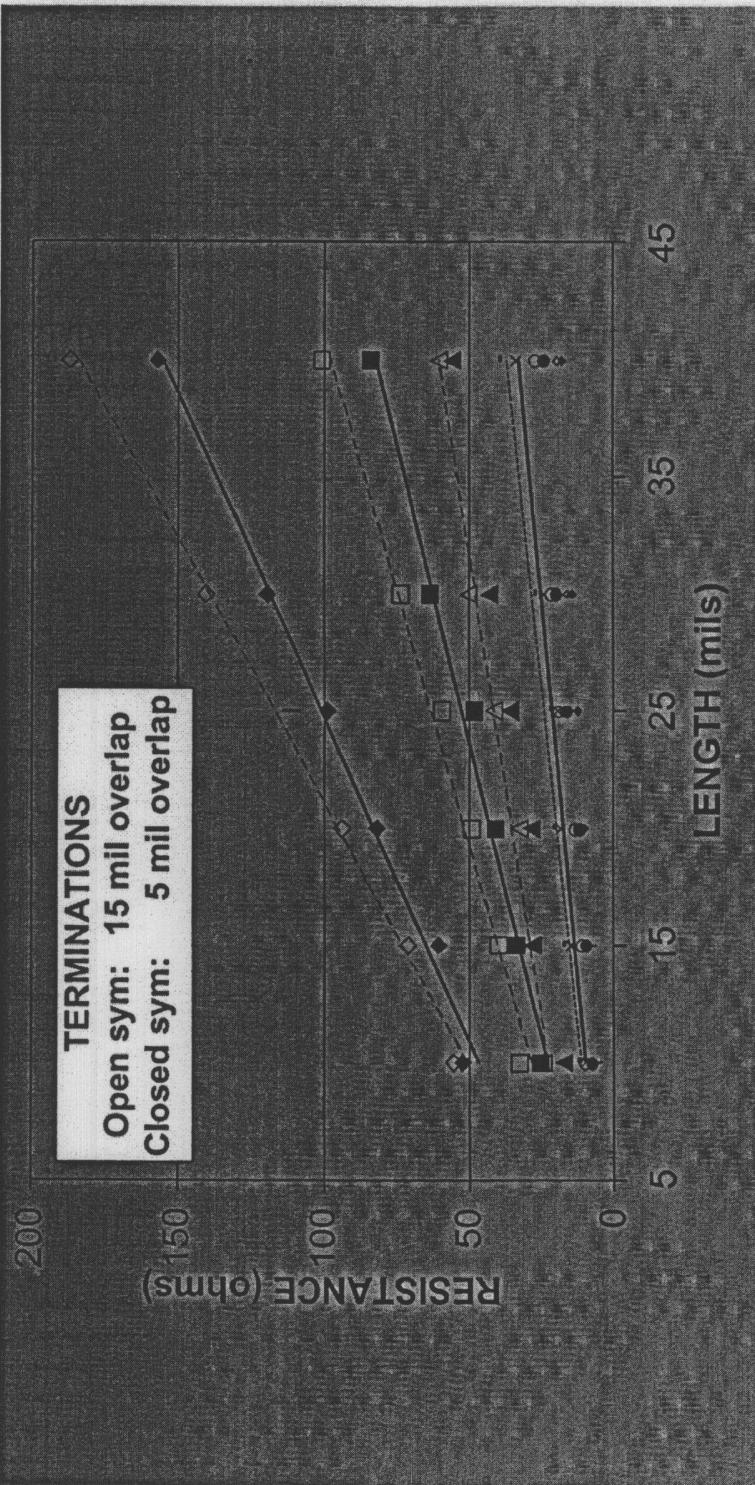


TEST MATRIX

- 2,880 RESISTORS
 - 60 Resistors/test
 - 48 Tests
- GROUP TEST BY WIDTH
 - Narrow length range
 - Model as linear

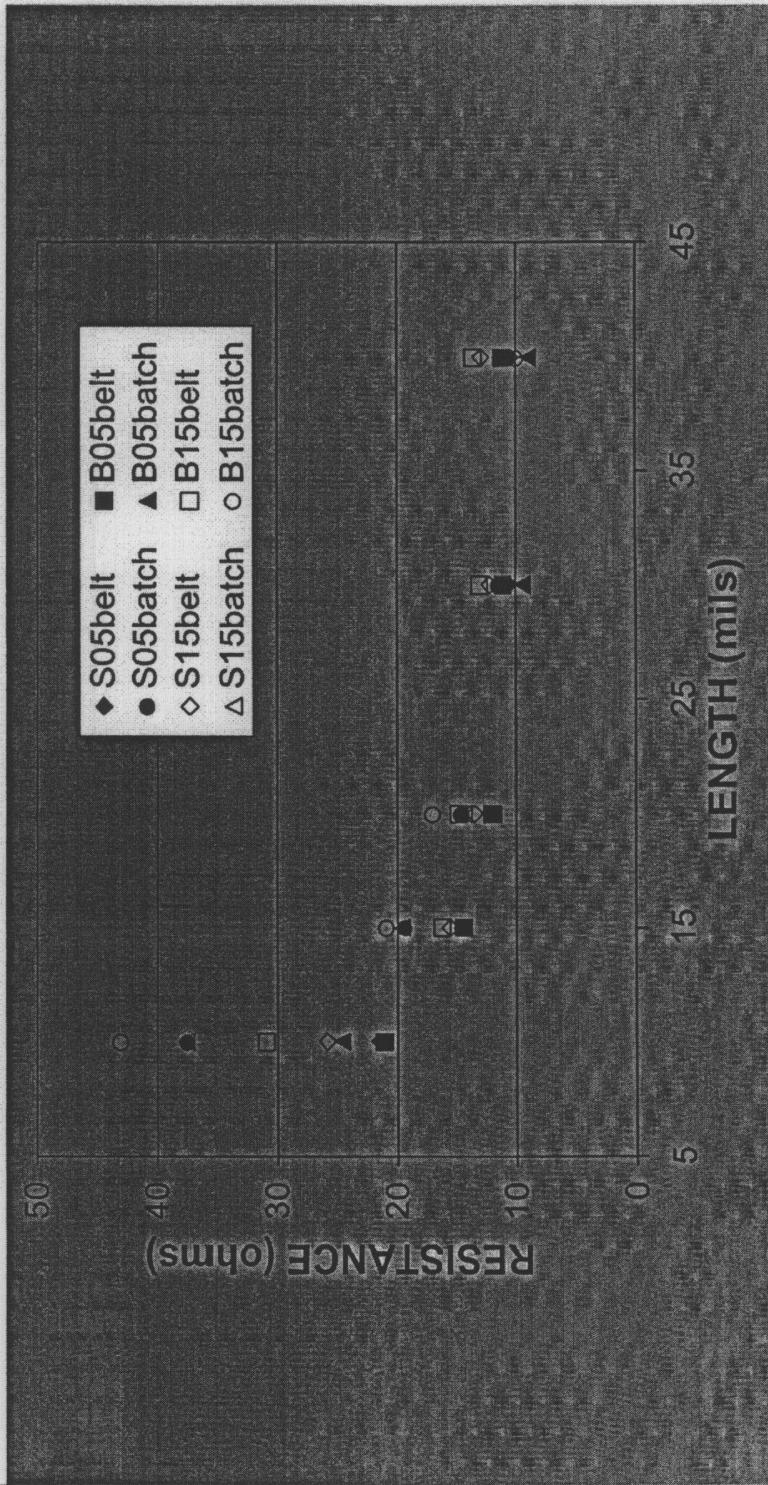


GOLD, 10 OHMS, SURFACE, BELT



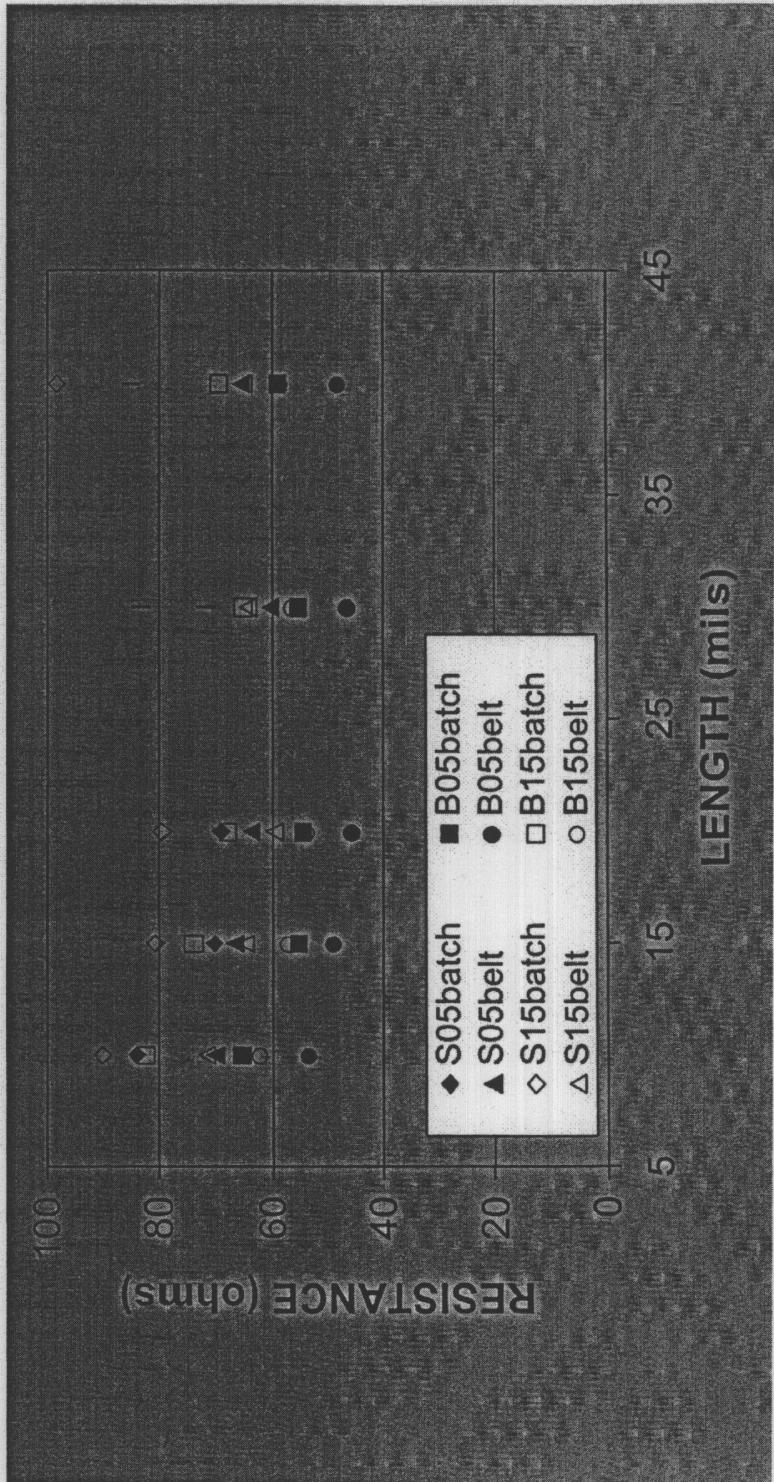


GOLD, 10 OHMS, 1 SQUARE



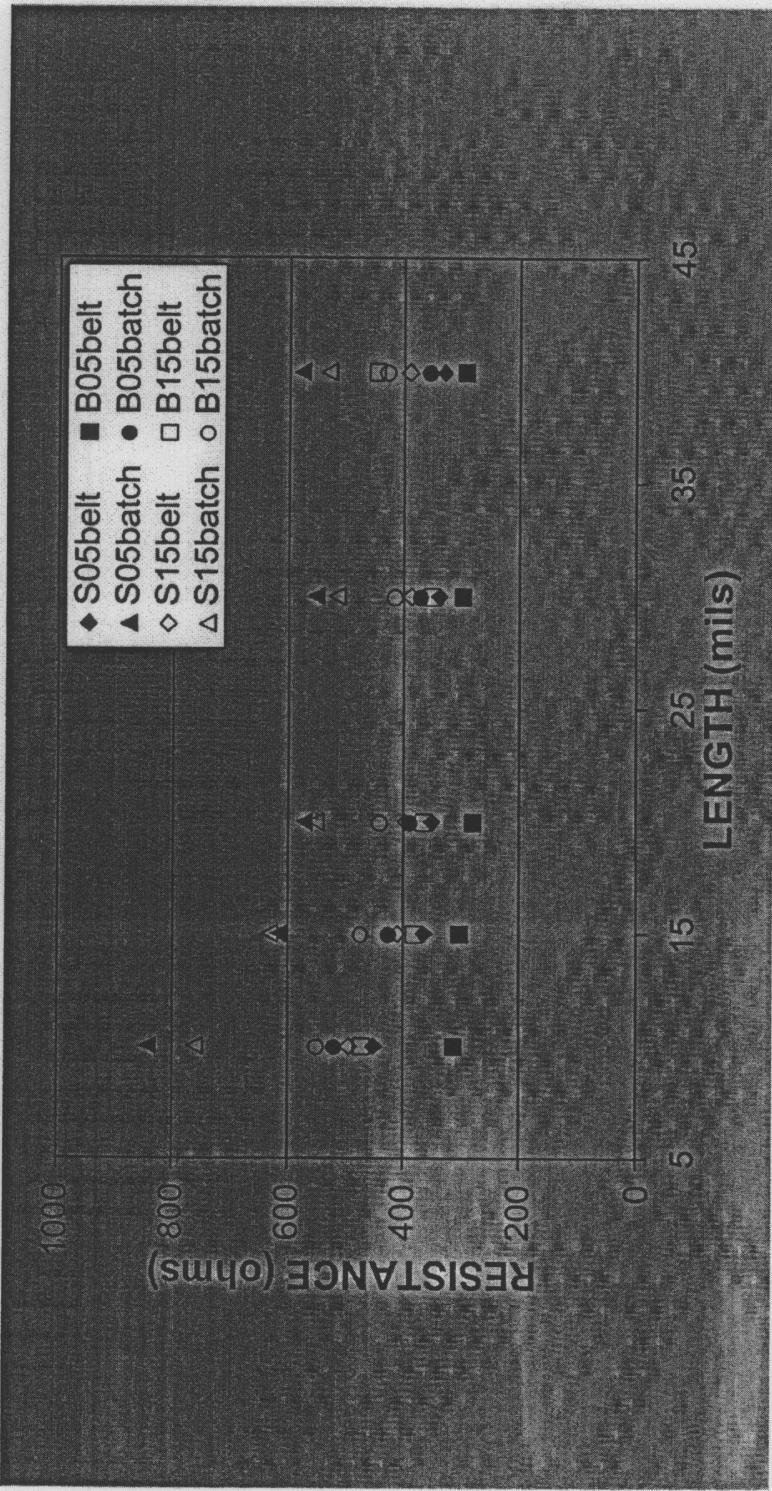


GOLD, 100 OHM, 1 SQUARE





GOLD, 1K OHM, 1 SQUARE



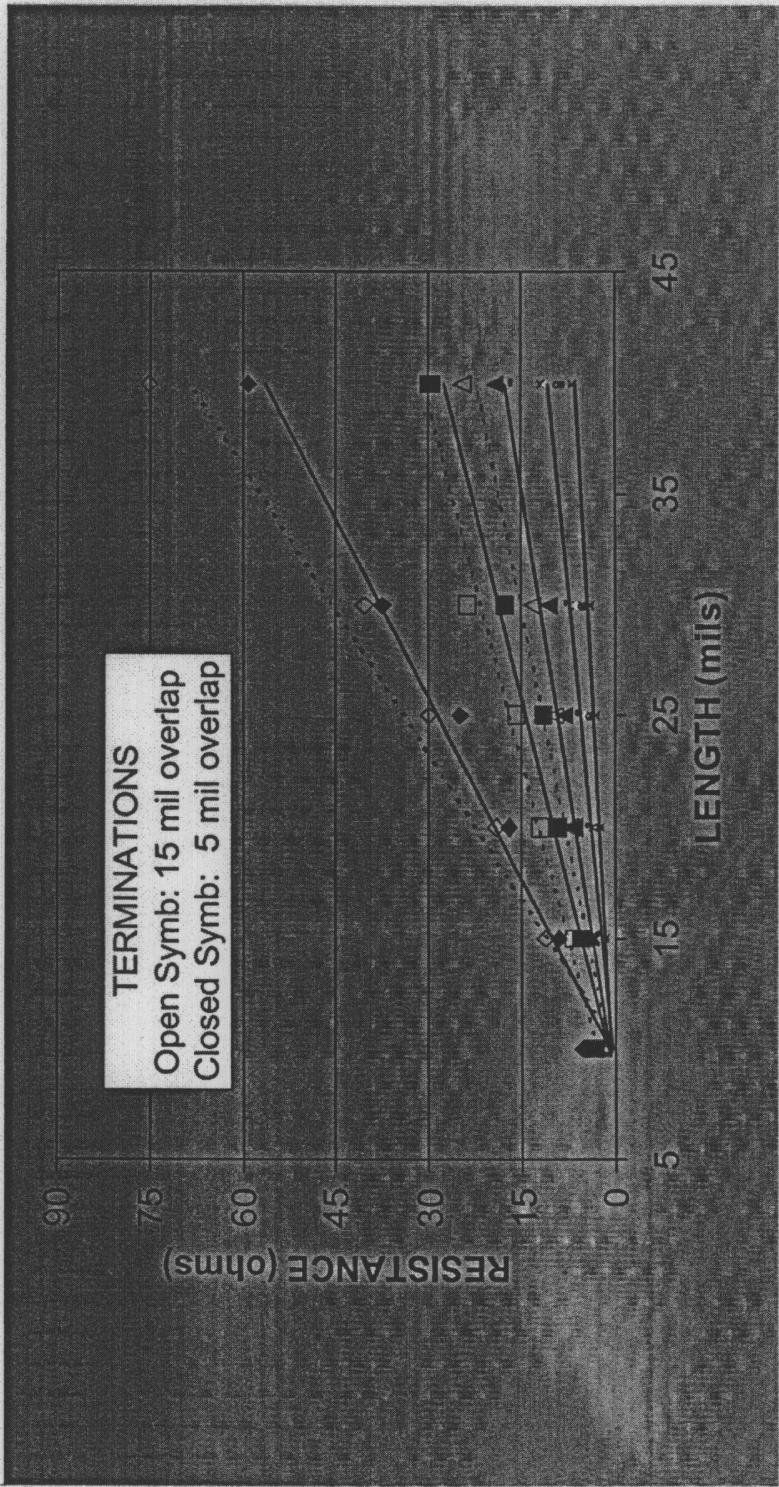


DUPONT 951 GOLD SUMMARY

- RESISTANCE OF 15 mil OVERLAP > 5 mil
 - (except S05batch, 11K ohm)
- RESISTANCE OF BATCH > BELT
 - Specific Firing Profiles
- SIZE EFFECT ON RESISTANCE
 - Small tends to be > than large
 - Glass Boundary Layer?
- LARGE PROCESS VARIATION
 - 25% to 50%



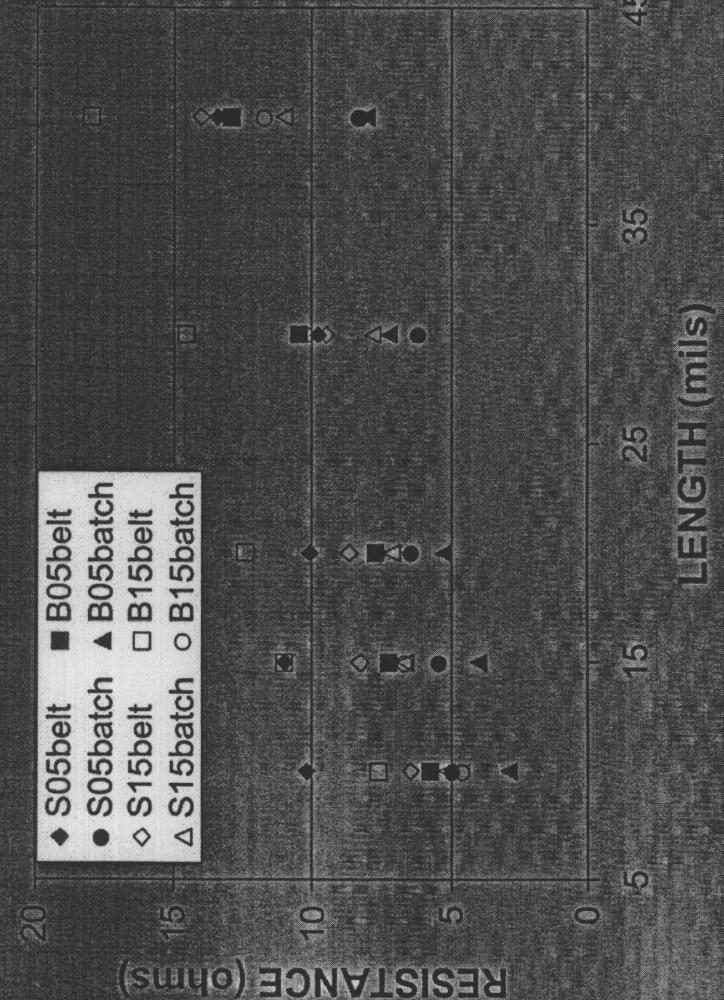
SILVER, 10 OHMS, SURFACE, BATCH





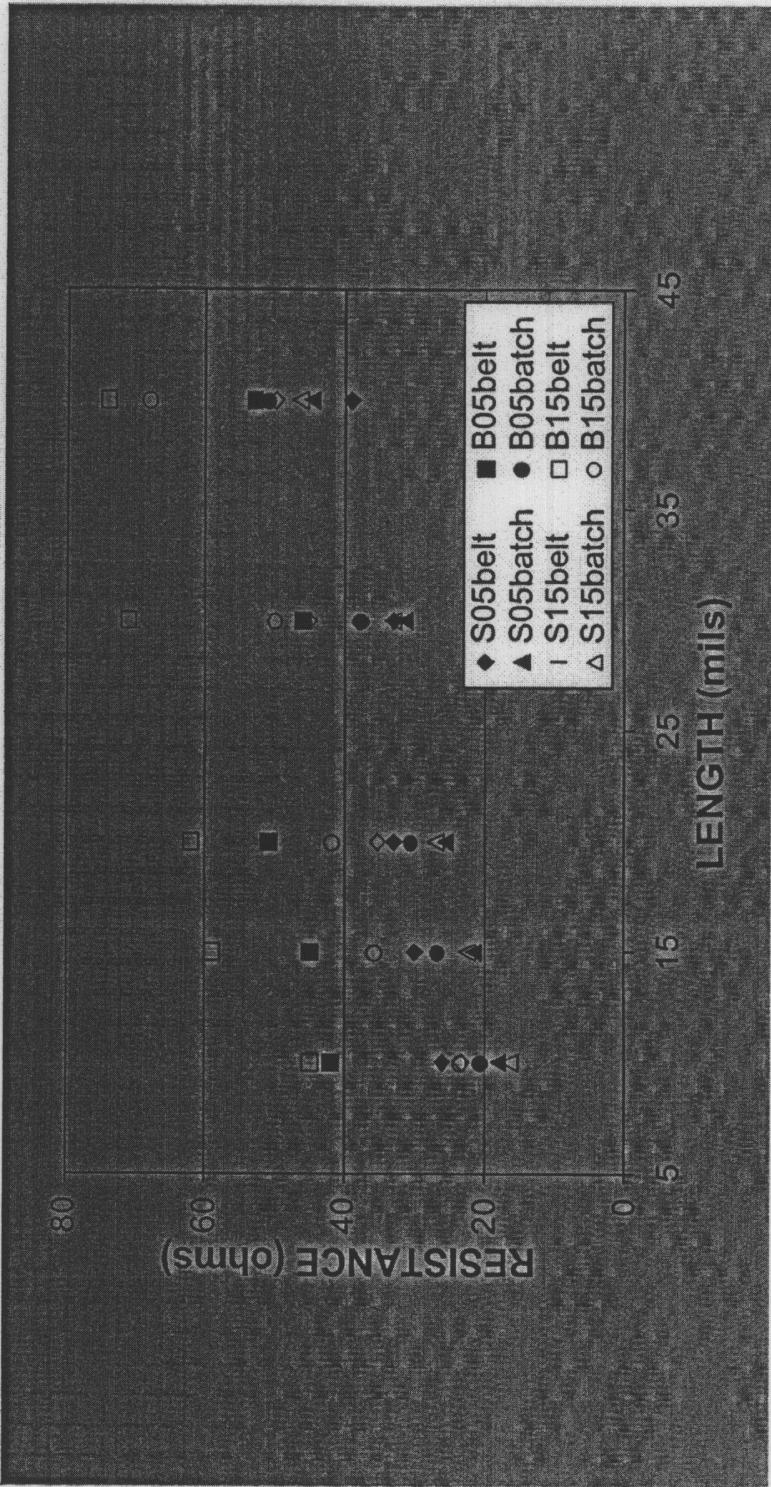
VisPro

SILVER, 10 OHMS, 1 SQUARE



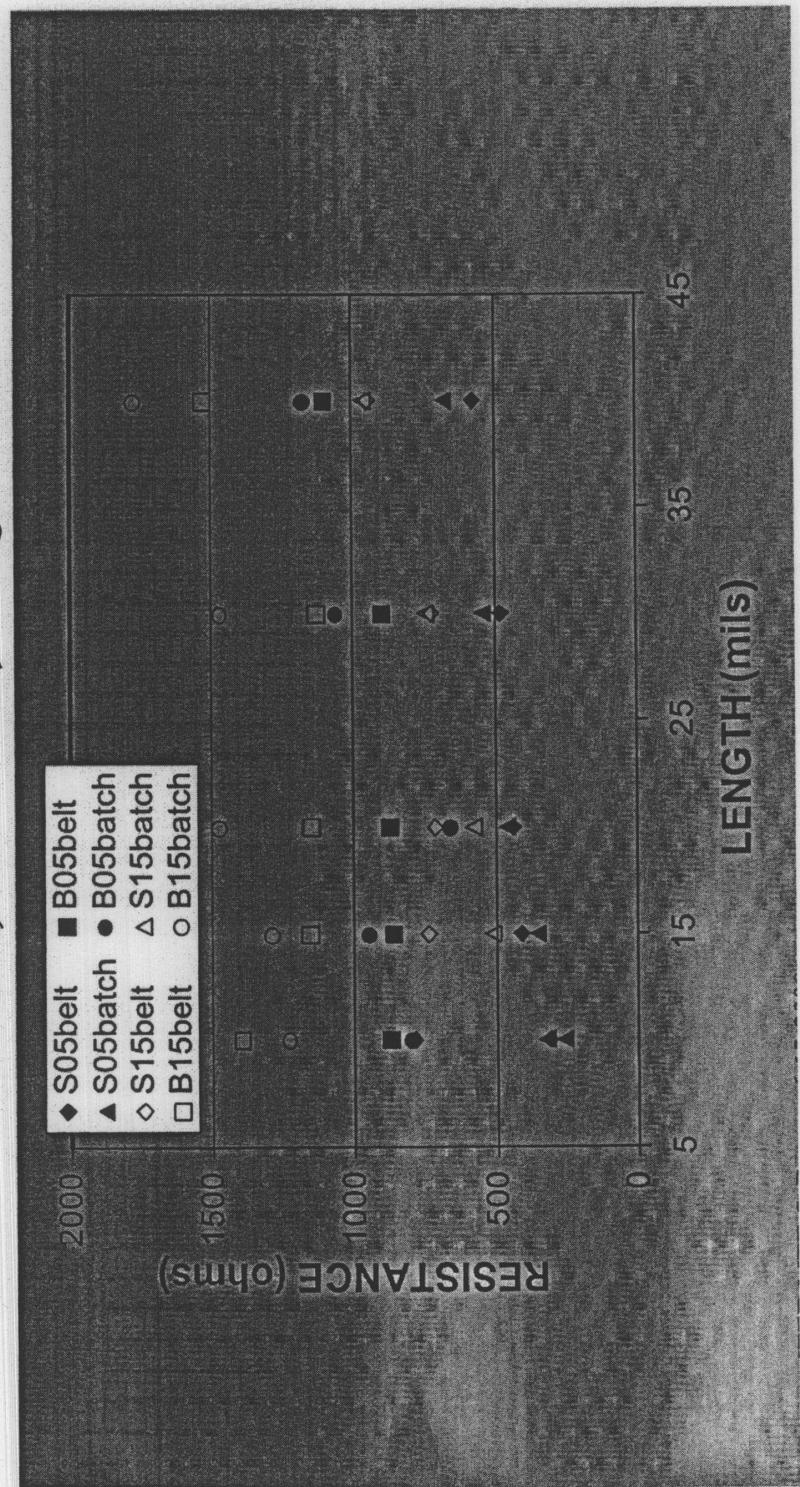


SILVER, 100 OHM, 1 SQUARE





SILVER, 1K OHM, 1 SQUARE





DUPONT 951 SILVER SUMMARY



- RESISTANCE OF BATCH 15 mil OVERLAP > 5 mil
 - Most surface resistors behaved similarly
- SIZE EFFECT ON RESISTANCE
 - 50% change from 10 mil to 40 mil
 - Too large to be explained by printing
 - Silver diffusion in resistor?
- LARGE PROCESS VARIATION
 - 40% to 50%



CONCLUSIONS

- Co-fired resistor behavior in LTCC bodies is highly variable but predictable for a given set of resistor and termination material.
- Resistor behavior varies widely depending on the termination material used.
- Detailed examination of material interactions is needed to fully understand the differences between Au and Ag systems.
- Improvements in resistor systems are needed to attain the demands of the industry.



附件：Panasonic



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News Release 2001/2/28

[Next Page ▶](#)**FOR IMMEDIATE RELEASE****Media Contacts:** Akira Kadota, International Publicity, Tokyo

Tel: 03-3578-1237 Fax: 03-3437-2776

Yoshihiro Kitadeya, International Publicity, Osaka

Tel: 06-6908-0447 Fax: 06-6908-5817

Matsushita (Panasonic) Introduces Advanced Onboard Terminal for ETC Systems

-- Slim, compact modular approach combines a variety of advanced technologies --

New Products

TOKYO, Japan -- Matsushita Communication Industrial Co., Ltd. (MCI), a principal subsidiary of Matsushita Electric Industrial Co., Ltd. (NYSE: MC), best known for its Panasonic brand electronics and communications products, today announced the introduction of a new vehicle-mounted terminal for use with Electronic Toll Collection (ETC) systems. The innovative CY-ET100D, one of the lightest and thinnest such ETC terminals in the industry, will go on sale March 12, in preparation for the new ETC service set to go into operation at the end of March. The suggested retail price for the main unit is set at 42,800 yen.

MCI has already established itself as one of the leading manufacturers in the ETC field, developing and deploying road-installed ETC systems at tollgates throughout Japan. The company is also actively engaged in creating Intelligent Transportation Systems (ITS) -- from onboard terminals to system-wide infrastructure itself -- by utilizing the company's own advanced audiovisual and communications technologies. A specially designed one-chip system LSI with a dedicated monolithic microwave IC (MMIC) ensures reliable communication in a slim package. Moreover, the terminal can be used for both ETC systems and ITS, a successor of car navigation systems, whose markets for both personal and business use continue to rapidly expand. This new terminal is designed to connect with car navigation systems developed by MCI (applicable models only), offering the ability to display a wide array of system information, such as the 100 most recent paid and unpaid tolls or an enlarged map of ETC gates at an approaching tollgate.

Designing the antenna and main system of the terminal as separate units has created one of the smallest terminals of its kind in the industry. Both the compact antenna and the slim main unit can be set up almost anywhere, as long as enough room is provided for easy card insertion and removal. Even when installed on the dashboard, the antenna will not hinder driver visibility, and the heat resistance built into both units will ensure long lasting service.

This new onboard ETC terminal was designed and developed specifically with safety, versatility, and ease-of-use in mind. An advanced voice guidance system enables drivers to confirm information solely by ear. Because the driver's eyes never have to leave the road, a safer driving environment is ensured for everyone. With the ability to operate at either 12V or 24V, the terminal can be installed in a wide range of vehicles -- from passenger cars to trucks -- without any conversions necessary. Moreover, the terminal's quick and simple 3-button operation -- for volume control, voice guidance replay, and card eject -- guarantees a terminal that is not only easy to learn but also easy to use.

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Main Specifications (CY-ET100D)

Weight/Dimensions

	Weight (g)	Height x Width x Depth (mm)
Main unit	170	15 x 70 x 135
Antenna unit	215 (including cables)	12 x 60 x 40

Electrical Characteristics

Operating voltage	10.8 - 26.4 VDC
Power consumption	Max. 0.7 A or less (at 13.2 V)
Radio frequencies for transmission	5835 MHz and 5845 MHz
Radio frequencies for reception	5795 MHz and 5805 MHz
Modulation method	ASK modulation
Modulation transfer rate	1024 kbps
Frequency interval between transmission and reception	40 MHz
Aerial power	10 mW

Operation/Voice/Display Characteristics

Number of keys	3 keys: Volume control key, Voice replay key, Card eject key
Voice	ADPCM standardized voice guidance and alarm sounds
ETC card	Terminal contact-type ISO card
ETC card holder	Complete model contains an eject button as well as a lock function for protecting card data.
Display	Two-color indicator: Standby: Green, Error: Red
External I/F	For connecting with MCI's car navigation system (applicable models only)

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GN01096B

GaAs IC (with built-in ferroelectric)

For low noise amplifier of cellular phone

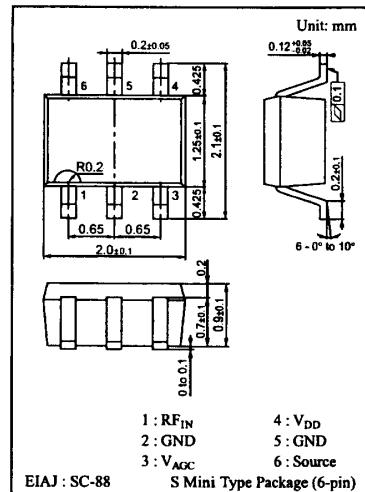
Other communication equipment

■ Features

- Super miniature S-Mini 6-pin package (2125 size)
- Receiver amplifier : Low distortion with built-in gain control function

■ Absolute Maximum Ratings $T_a=25\text{ }^\circ\text{C}$

Parameter	Symbol	Ratings	Unit
Power supply voltage	V_{DD}	8	V
Circuit current	I_{DD}	20	mA
Gate control voltage	V_{AGC}	0 to 4	V
Max input power	P_{IN}	-5	dBm
Allowable power dissipation	P_D	150	mW
Operating ambient temperature	T_{opt}	-30 to +90	$^\circ\text{C}$
Storage temperature	T_{stg}	-40 to +120	$^\circ\text{C}$



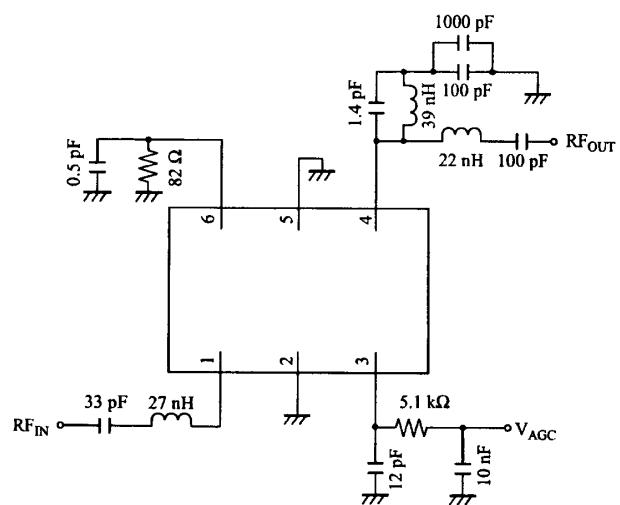
Marking Symbol : KW

■ Electrical Characteristics $V_{DD}=2.9\text{ V}$, $P_{IN}=-25\text{ dBm}$, $T_a=25\text{ }^\circ\text{C}\pm 3\text{ }^\circ\text{C}$

Parameter	Symbol	Conditions	min	typ	max	Unit
Circuit current *1	I_{DD}	$V_{AGC}=1.5\text{ V}$, $f=850\text{ MHz}$		6.5	10	mA
Power gain 1 *1	PG1	$V_{AGC}=1.5\text{ V}$, $f=850\text{ MHz}$	12.5	15.0	17.5	dB
Power gain 2 *1	PG2	$V_{AGC}=0.1\text{ V}$, $f=850\text{ MHz}$	-10.0	-6.5	-3.0	dB
Noise figure 1 *1, 2	NF1	$V_{AGC}=1.5\text{ V}$, $f=832\text{ MHz}$ $f=850\text{ MHz}$, $f=870\text{ MHz}$		1.4	2.0	dB
Noise figure 2 *1, 2	NF2	$V_{AGC}=0.1\text{ V}$, $f=832\text{ MHz}$ $f=850\text{ MHz}$, $f=870\text{ MHz}$		17	22	dB
Dynamic range *1	DR	$V_{AGC}=1.5\text{ V}$ to 0.1 V , $f=850\text{ MHz}$	18	22	27	dB
Input return loss *1, 2	S11	$V_{AGC}=1.5\text{ V}$, $f=850\text{ MHz}$		-10	-6	dB
Output return loss *1, 2	S22	$V_{AGC}=1.5\text{ V}$, $f=850\text{ MHz}$		-10	-6	dB
Third input intercept point *1, 2	IIP3	$V_{AGC}=1.5\text{ V}$, $f=850\text{ MHz}/850.9\text{ MHz}$	4.0	5.8		dBm
Third output intercept point *1, 2	OIP3	$V_{AGC}=1.5\text{ V}$, $f=850\text{ MHz}/850.9\text{ MHz}$	16.5	21.0		dBm

Note) *1 : Refer to measurement circuit.

*2 : Design-guaranteed items.

■ Measurement Circuit

2SK3023 (Tentative)

Silicon N-Channel Power F-MOS FET

■ Features

- Avalanche energy capacity guaranteed
- High-speed switching
- Low ON-resistance
- No secondary breakdown
- Low-voltage drive
- High electrostatic breakdown voltage

■ Applications

- Contactless relay
- Driving circuit for a solenoid
- Driving circuit for a motor
- Control equipment
- Switching power supply

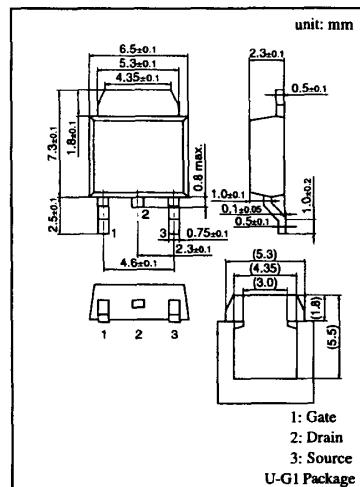
■ Absolute Maximum Ratings ($T_C = 25^\circ\text{C}$)

Parameter	Symbol	Ratings	Unit
Drain to Source breakdown voltage	V_{DSS}	60	V
Gate to Source voltage	V_{GSS}	± 20	V
Drain current	DC	I_D	A
	Pulse	I_{DP}	A
Avalanche energy capacity	EAS*	5	mJ
Allowable power dissipation	$T_C = 25^\circ\text{C}$	10	W
	$T_a = 25^\circ\text{C}$	1	
Channel temperature	T_{ch}	150	$^\circ\text{C}$
Storage temperature	T_{sig}	-55 to +150	$^\circ\text{C}$

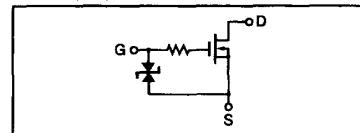
* $L = 0.1\text{mH}, I_L = 10\text{A}, 1 \text{ pulse}$

■ Electrical Characteristics ($T_C = 25^\circ\text{C}$)

Parameter	Symbol	Conditions	min	typ	max	Unit
Drain to Source cut-off current	I_{DSS}	$V_{DS} = 50\text{V}, V_{GS} = 0$			10	μA
Gate to Source leakage current	I_{GSS}	$V_{GS} = \pm 20\text{V}, V_{DS} = 0$			± 10	μA
Drain to Source breakdown voltage	V_{DSS}	$I_D = 1\text{mA}, V_{GS} = 0$	60			V
Gate threshold voltage	V_{th}	$V_{DS} = 10\text{V}, I_D = 1\text{mA}$	1		2.5	V
Drain to Source ON-resistance	$R_{DS(on)1}$	$V_{GS} = 10\text{V}, I_D = 5\text{A}$		50	80	$\text{m}\Omega$
	$R_{DS(on)2}$	$V_{GS} = 4\text{V}, I_D = 5\text{A}$		70	110	$\text{m}\Omega$
Forward transfer admittance	$ Y_{fs} $	$V_{DS} = 10\text{V}, I_D = 5\text{A}$	3	5		S
Diode forward voltage	V_{DSF}	$I_{DR} = 10\text{A}, V_{GS} = 0$			-1.4	V
Input capacitance (Common Source)	C_{iss}			300		pF
Output capacitance (Common Source)	C_{oss}	$V_{DS} = 10\text{V}, V_{GS} = 0, f = 1\text{MHz}$		165		pF
Reverse transfer capacitance (Common Source)	C_{rss}			65		pF
Turn-on time (delay time)	$t_{d(on)}$			15		ns
Rise time	t_r	$V_{DD} = 30\text{V}, I_D = 5\text{A}$		70		ns
Fall time	t_f	$V_{GS} = 10\text{V}, R_L = 6\Omega$		290		ns
Turn-off time (delay time)	$t_{d(off)}$			860		ns
Thermal resistance between channel and case	$R_{th(ch-c)}$				12.5	$^\circ\text{C/W}$
Thermal resistance between channel and atmosphere	$R_{th(ch-a)}$				125	$^\circ\text{C/W}$



Internal Connection



2SK3043

Silicon N-Channel Power F-MOS FET

■ Features

- Avalanche energy capacity guaranteed: EAS > 100mJ
- $V_{GSS} = \pm 30V$ guaranteed
- High-speed switching: $t_f = 35ns$
- No secondary breakdown

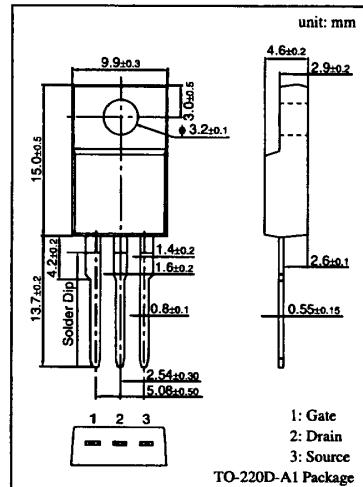
■ Applications

- Contactless relay
- Driving circuit for a solenoid
- Driving circuit for a motor
- Control equipment
- Switching power supply

■ Absolute Maximum Ratings ($T_C = 25^\circ C$)

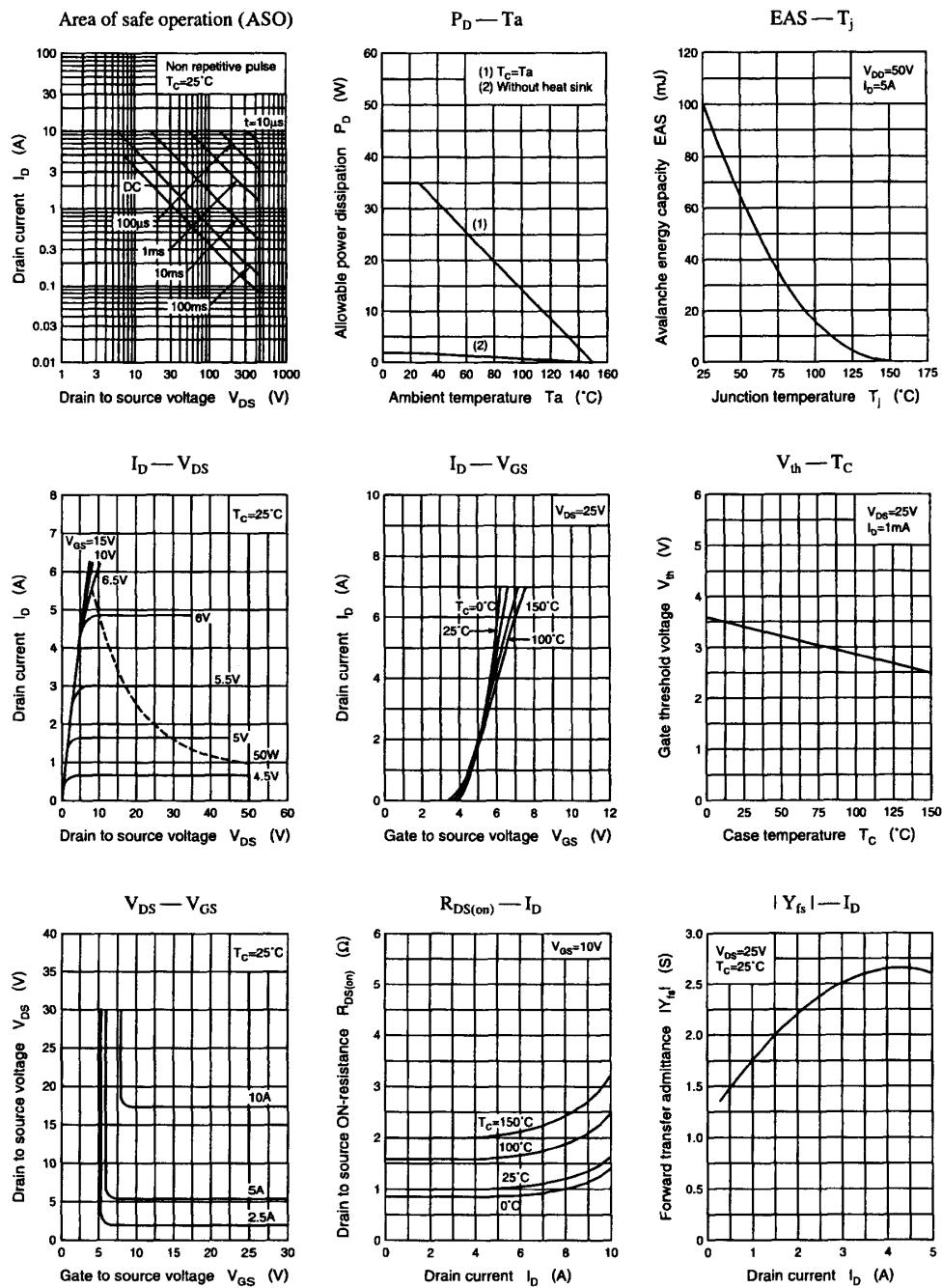
Parameter	Symbol	Ratings	Unit
Drain to Source breakdown voltage	V_{DSS}	450	V
Gate to Source voltage	V_{GSS}	± 30	V
Drain current	DC I_D	± 5	A
	Pulse I_{DP}	± 10	A
Avalanche energy capacity	EAS*	100	mJ
Allowable power dissipation	$T_C = 25^\circ C$	35	
	$T_a = 25^\circ C$	2	W
Channel temperature	T_{ch}	150	$^\circ C$
Storage temperature	T_{sg}	-55 to +150	$^\circ C$

* $L = 8mH$, $I_L = 5A$, $V_{DD} = 50V$, 1 pulse



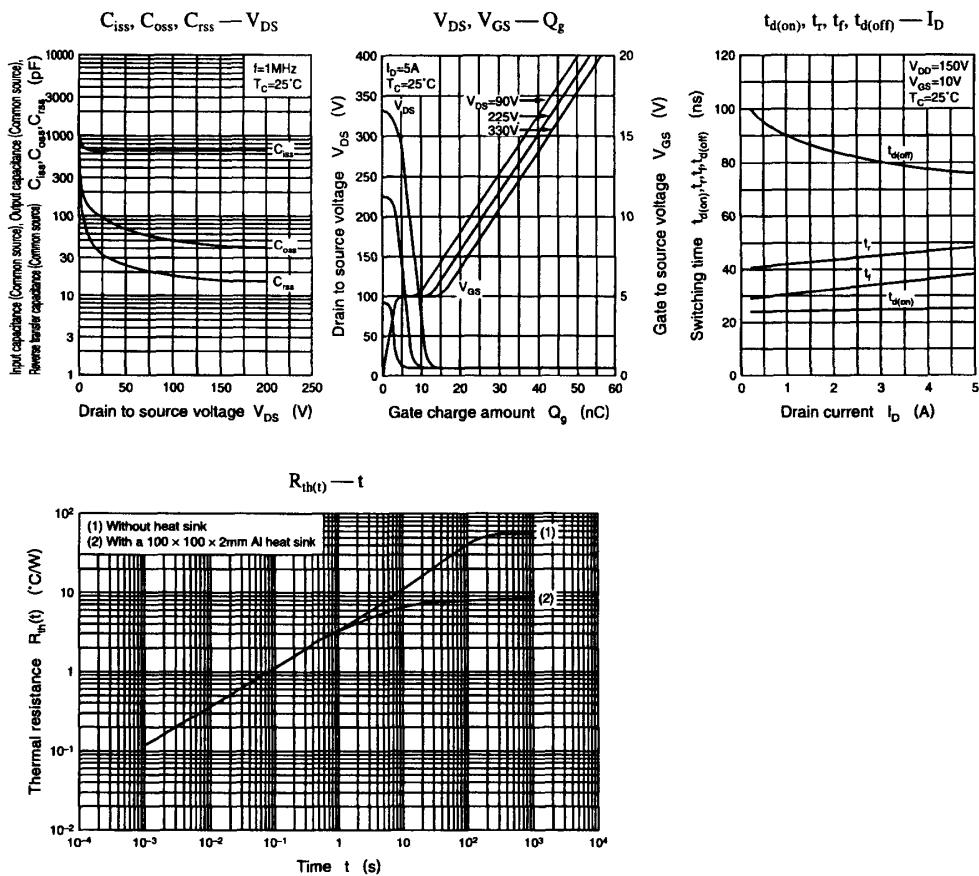
■ Electrical Characteristics ($T_C = 25^\circ C$)

Parameter	Symbol	Conditions	min	typ	max	Unit
Drain to Source cut-off current	I_{DSS}	$V_{DS} = 360V$, $V_{GS} = 0$			0.1	mA
Gate to Source leakage current	I_{GSS}	$V_{GS} = \pm 30V$, $V_{DS} = 0$			± 1	μA
Drain to Source breakdown voltage	V_{DSS}	$I_D = 1mA$, $V_{GS} = 0$	450			V
Gate threshold voltage	V_{th}	$V_{DS} = 25V$, $I_D = 1mA$	2		5	V
Drain to Source ON-resistance	$R_{DS(on)}$	$V_{GS} = 10V$, $I_D = 3A$		1	1.3	Ω
Forward transfer admittance	$ Y_{fs} $	$V_{DS} = 25V$, $I_D = 3A$	1.8	2.5		S
Diode forward voltage	V_{DSF}	$I_{DR} = 5A$, $V_{GS} = 0$			-1.2	V
Input capacitance (Common Source)	C_{iss}	$V_{DS} = 20V$, $V_{GS} = 0$, $f = 1MHz$		700		pF
Output capacitance (Common Source)	C_{oss}			100		pF
Reverse transfer capacitance (Common Source)	C_{rss}			40		pF
Turn-on time (delay time)	$t_{d(on)}$	$V_{GS} = 10V$, $I_D = 3A$ $V_{DD} = 150V$, $R_L = 50\Omega$		25		ns
Rise time	t_r			45		ns
Turn-off time (delay time)	$t_{d(off)}$			80		ns
Fall time	t_f			35		ns



Power F-MOS FETs

2SK3043



2SK3192

Silicon N-channel power F-MOSFET

■ Features

- Avalanche energy capacity guaranteed
- High-speed switching
- Low on-resistance
- No secondary breakdown

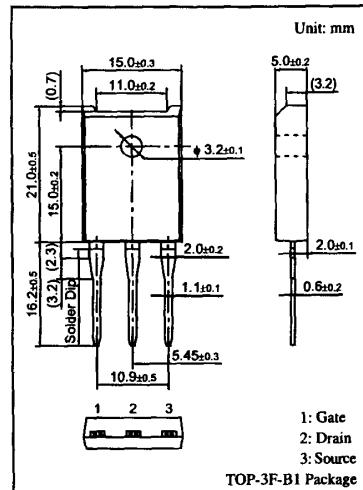
■ Applications

- PDP
- Switching power supply

■ Absolute Maximum Ratings $T_C = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Drain-source breakdown voltage	V_{DSS}	250	V
Gate to source voltage	V_{GSS}	± 30	V
Drain current	DC I_D	± 30	A
	Pulse I_{DP}	± 120	A
Avalanche energy capacity *	EAS	925	mJ
Allowable power dissipation	$T_C = 25^\circ\text{C}$ P_D	100	W
	$T_a = 25^\circ\text{C}$	3	
Channel temperature	T_{ch}	150	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to +150	$^\circ\text{C}$

Note) *: $L = 1.74 \text{ mH}$, $I_L = 30 \text{ A}$, $V_{DD} = 50 \text{ V}$, 1 pulse, $T_a = 25^\circ\text{C}$

**■ Electrical Characteristics $T_C = 25^\circ\text{C} \pm 3^\circ\text{C}$**

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Drain cutoff current	I_{DSS}	$V_{DS} = 200 \text{ V}$, $V_{GS} = 0$			10	μA
Gate-source leakage current	I_{GSS}	$V_{GS} = \pm 30 \text{ V}$, $V_{DS} = 0$			± 1	μA
Drain-source breakdown voltage	V_{DSS}	$I_D = 1 \text{ mA}$, $V_{GS} = 0$	250			V
Gate threshold voltage	V_{th}	$V_{DS} = 10 \text{ V}$, $I_D = 1 \text{ mA}$	2		4	V
Drain-source on resistance	$R_{DS(ON)}$	$V_{GS} = 10 \text{ V}$, $I_D = 15 \text{ A}$		50	68	$\text{m}\Omega$
Forward transfer admittance	$ Y_{fs} $	$V_{DS} = 10 \text{ V}$, $I_D = 15 \text{ A}$	8	15		S
Input capacitance	C_{iss}	$V_{DS} = 10 \text{ V}$, $V_{GS} = 0$, $f = 1 \text{ MHz}$		4200		pF
Output capacitance	C_{oss}			1600		pF
Reverse transfer capacitance	C_{rss}			650		pF
Turn-on delay time	$t_{Q(ON)}$	$V_{DD} = 100 \text{ V}$, $I_D = 15 \text{ A}$ $R_L = 6.7 \Omega$, $V_{GS} = 10 \text{ V}$		45		ns
Rise time	t_r			115		ns
Turn-off deray time	$t_{Q(OFF)}$			330		ns
Fall time	t_f			130		ns

■ Electrical Characteristics (continued) $T_C = 25^\circ\text{C} \pm 3^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Diode forward voltage	V_{DSF}	$I_{DR} = 30 \text{ A}, V_{GS} = 0$			-1.5	V
Reverse recovery time	t_{rr}	$L = 230 \mu\text{H}, V_{DD} = 100 \text{ V}$		260		ns
Reverse recovery charge	Q_{rr}	$I_{DR} = 15 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}$		1.6		μC
Total gate charge	Q_g	$V_{DD} = 100 \text{ V}, I_D = 15 \text{ A}$		95		nC
Gate-source charge	Q_{gs}	$V_{GS} = 10 \text{ V}$		34		nC
Gate-drain charge	Q_{gd}			12		nC
Thermal resistance (channel to case)	$R_{th(ch-c)}$				1.25	$^\circ\text{C}/\text{W}$
Thermal resistance (channel to ambient)	$R_{th(ch-a)}$				41.7	$^\circ\text{C}/\text{W}$

